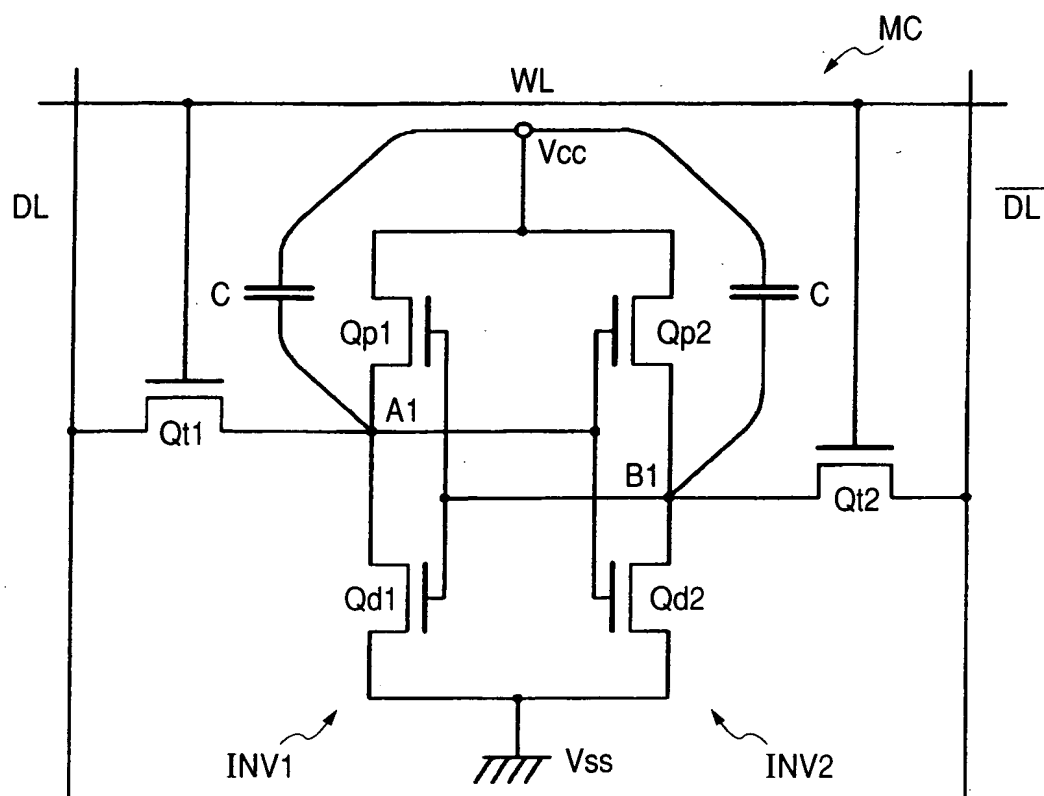
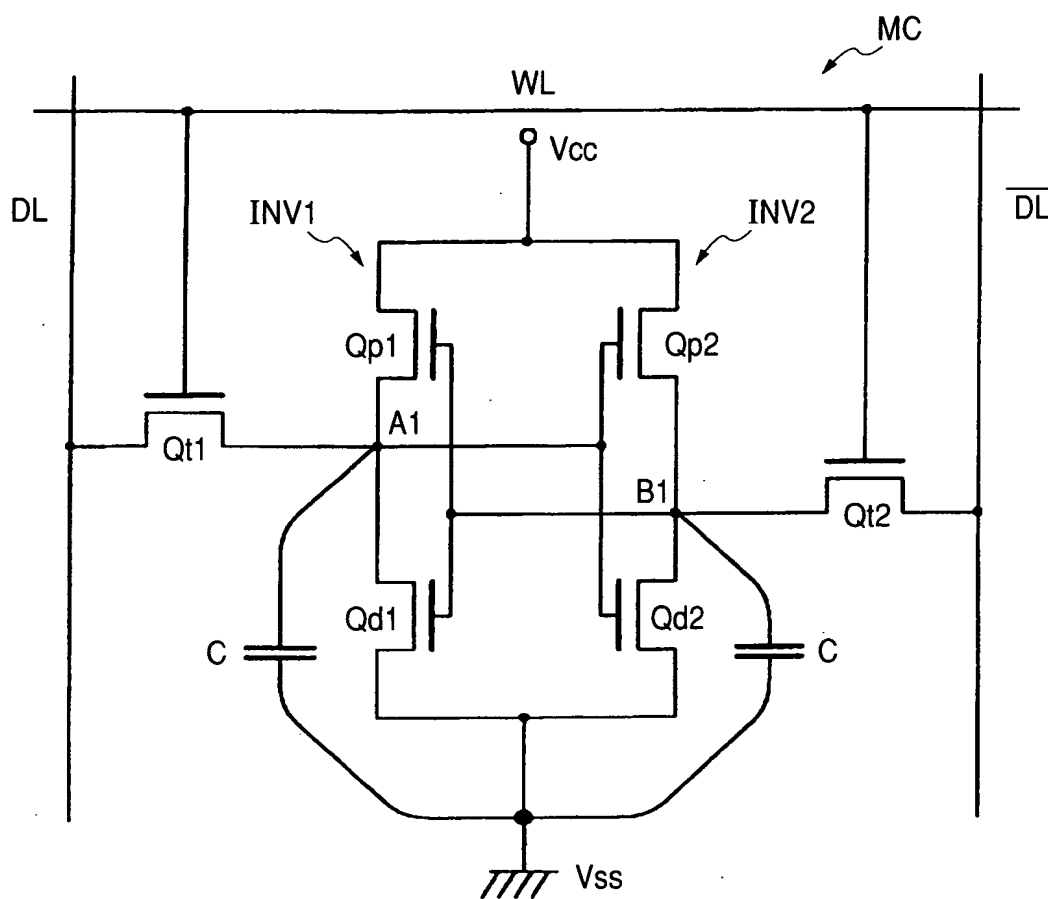


**FIG. 1**



**FIG. 2**



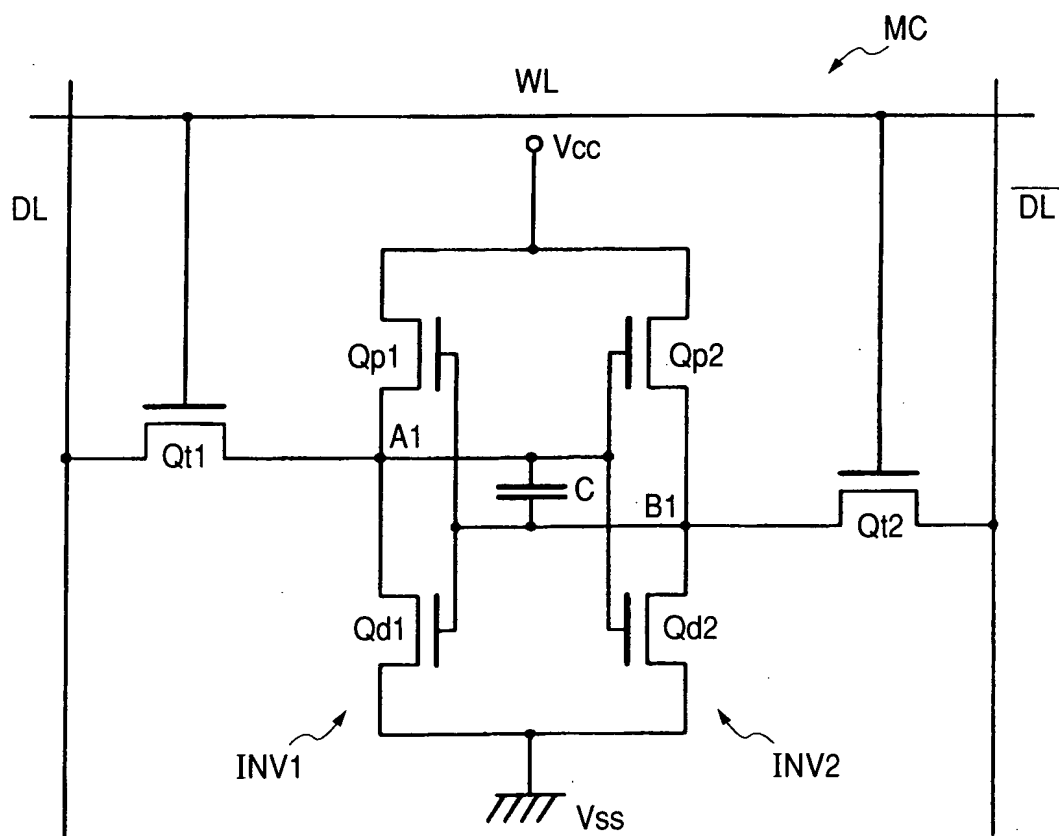
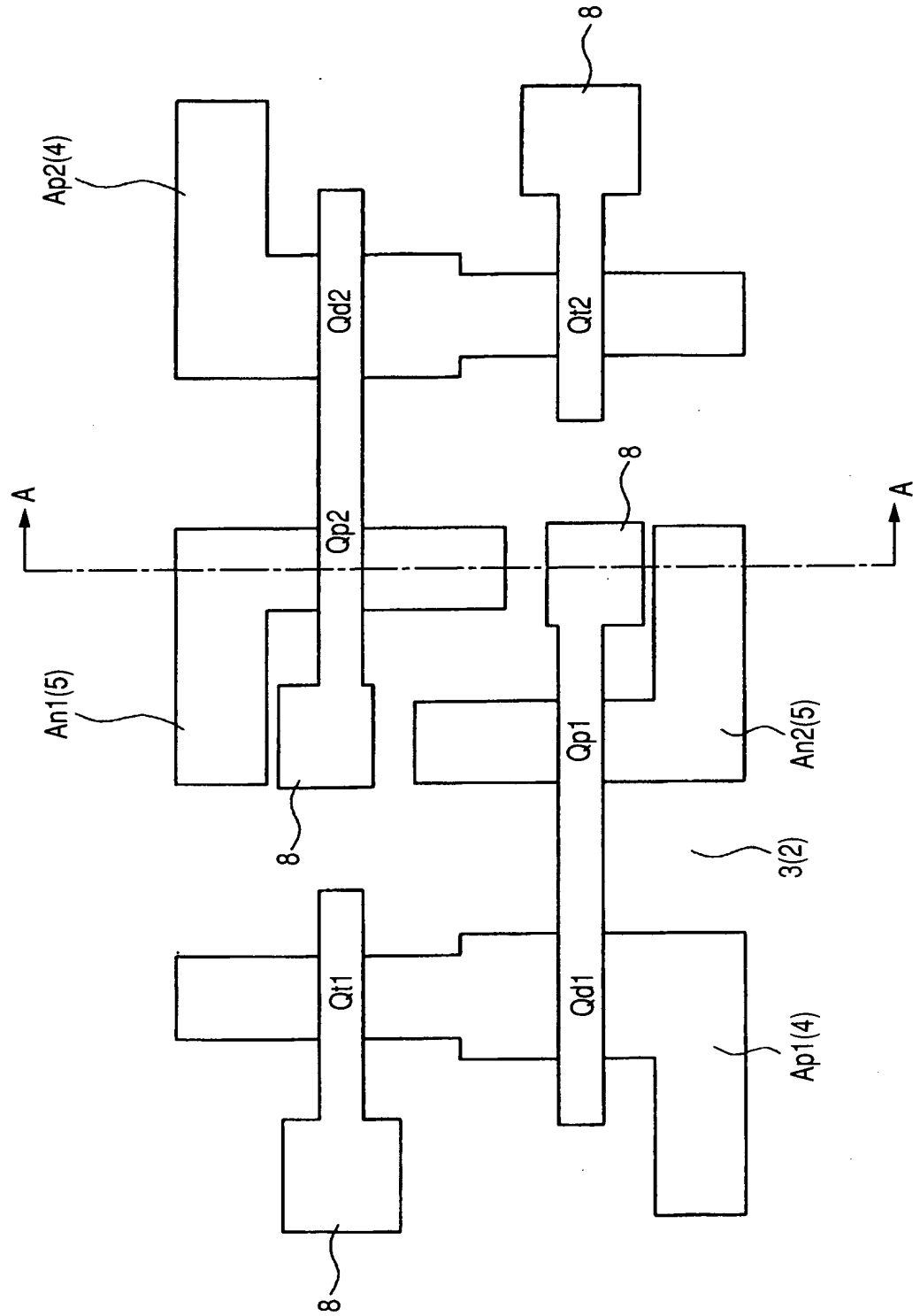
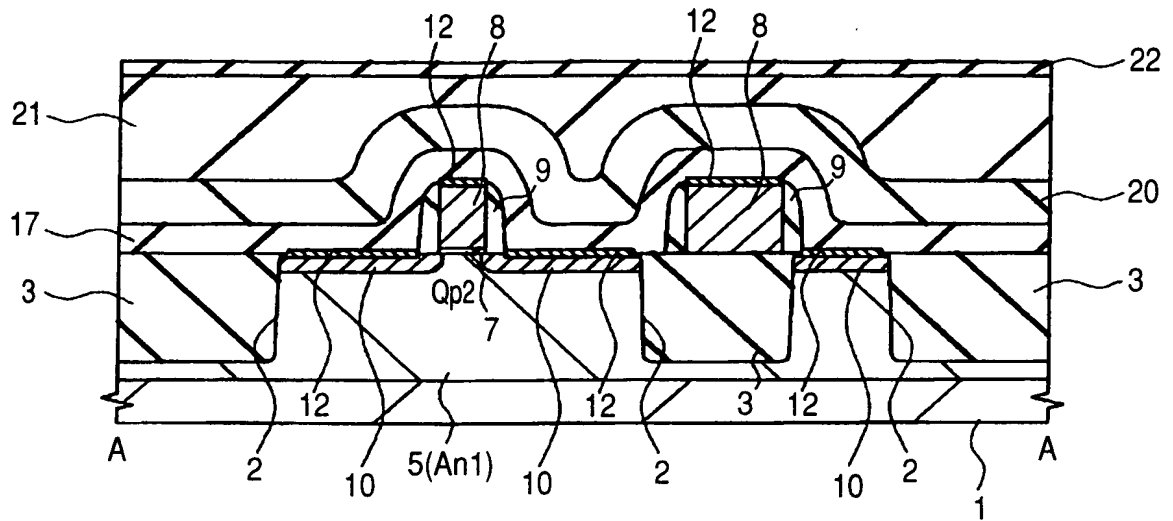


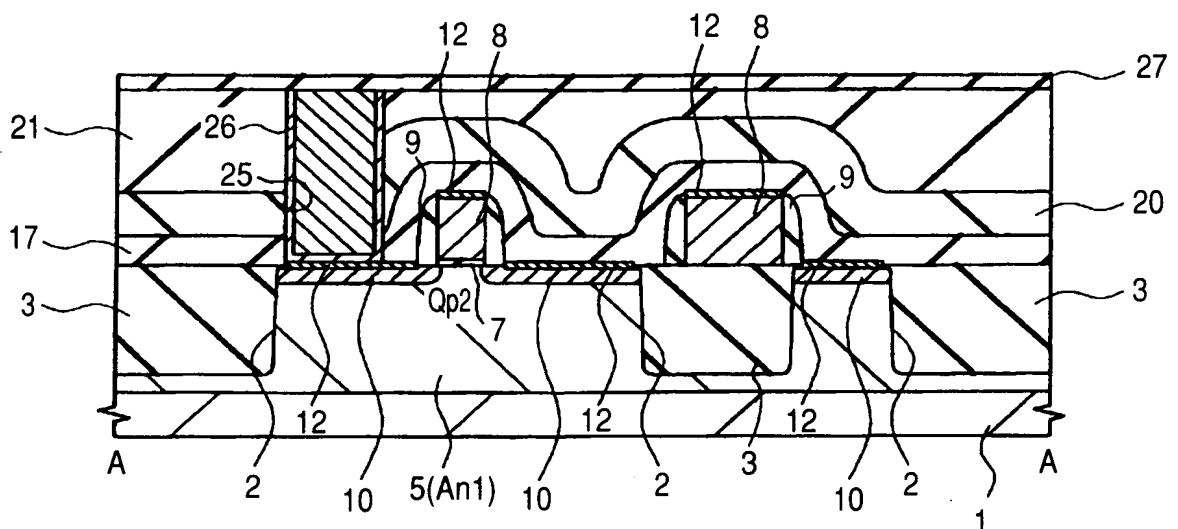
FIG. 4



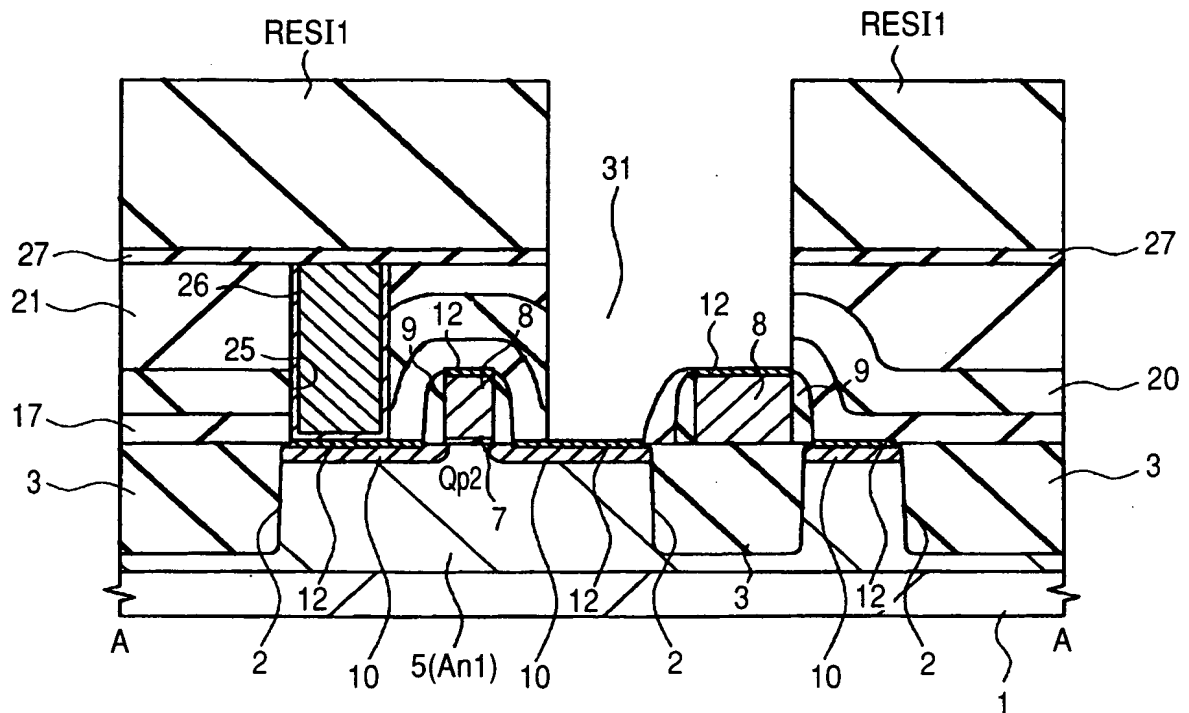
**FIG. 5**



**FIG. 6**



**FIG. 7**



**FIG. 8**

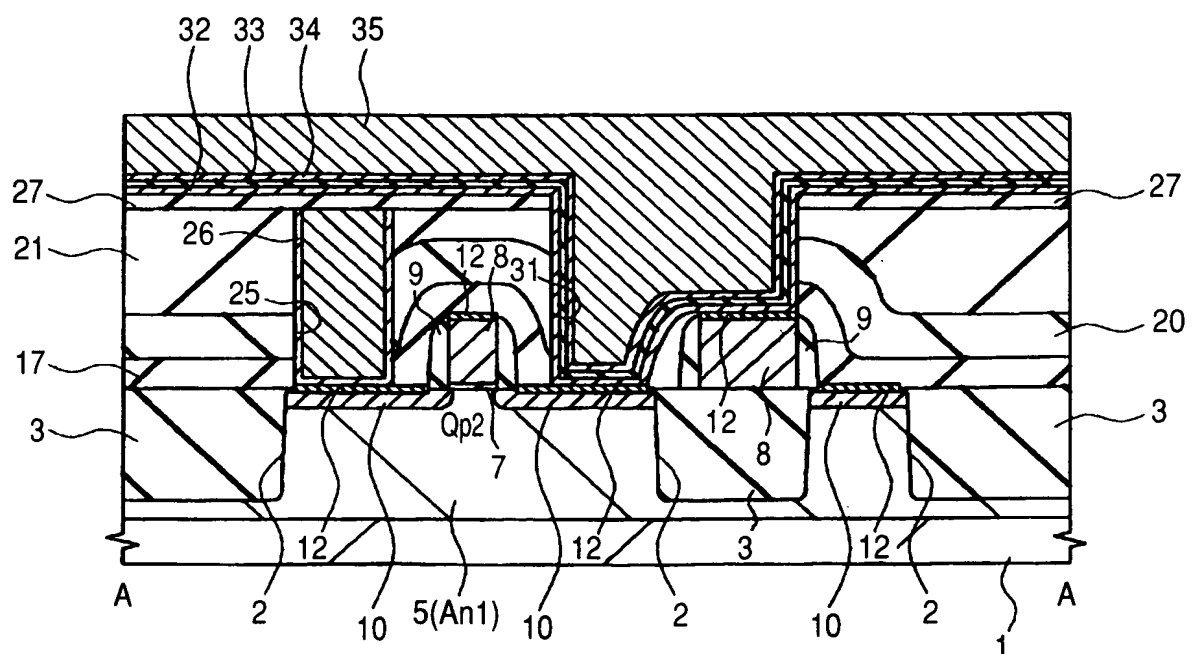
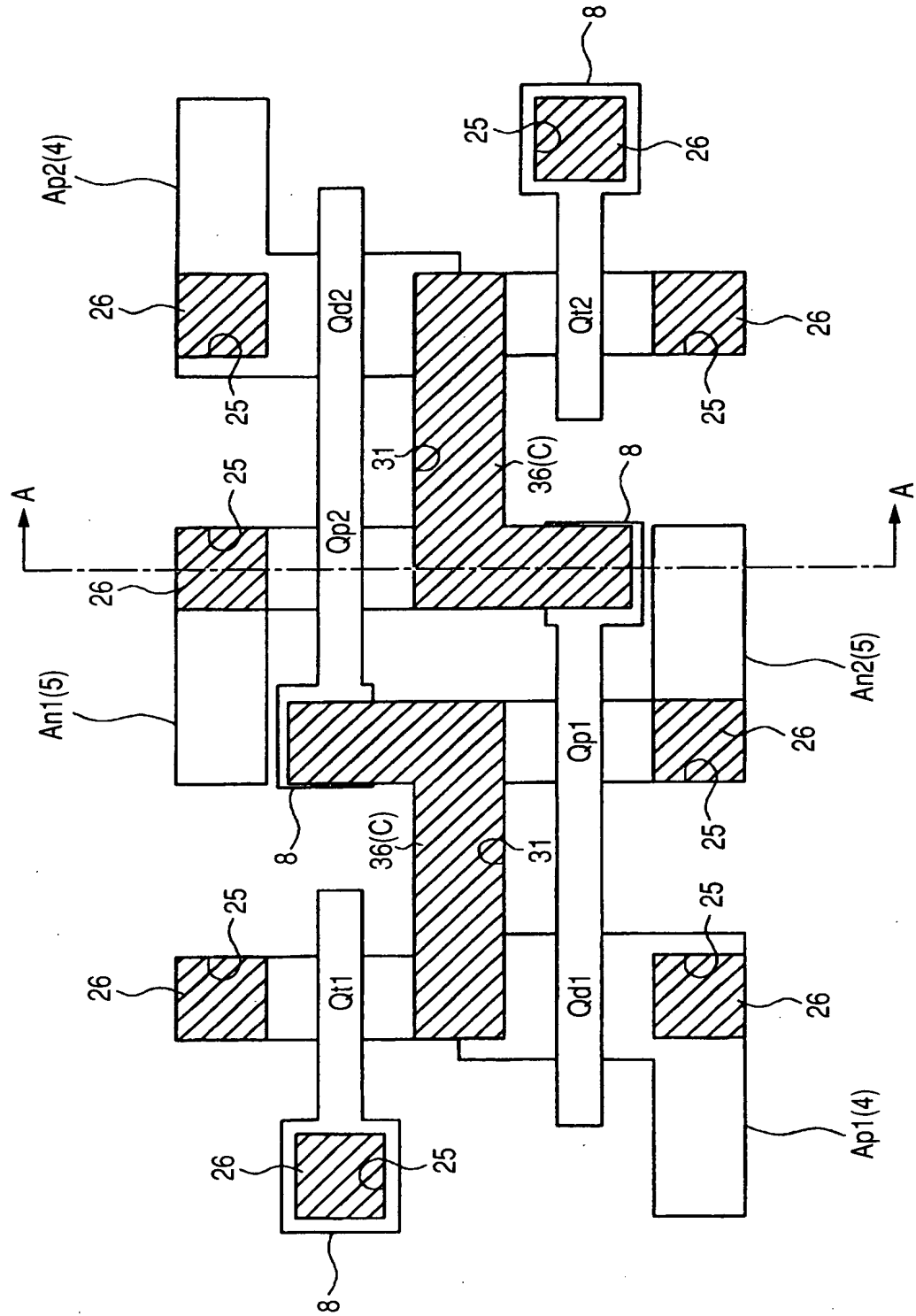


FIG. 9



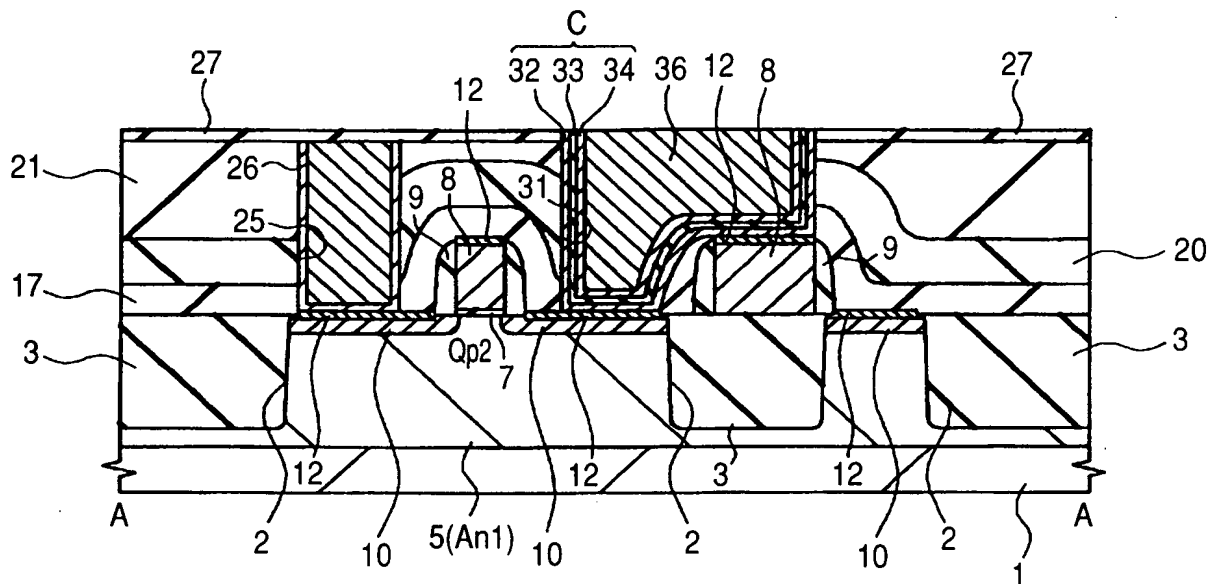
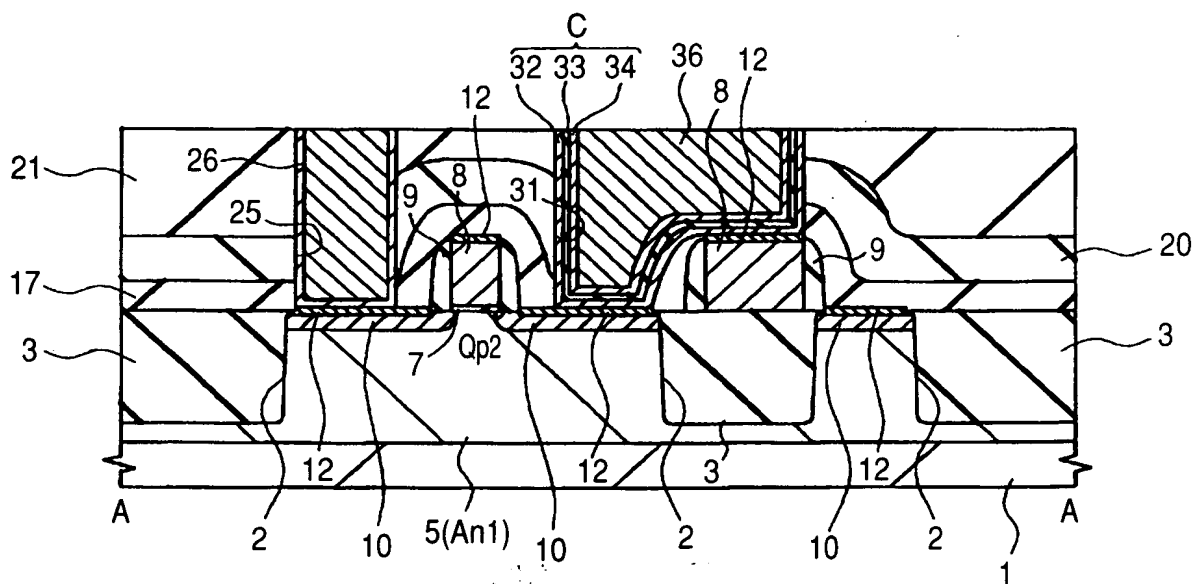
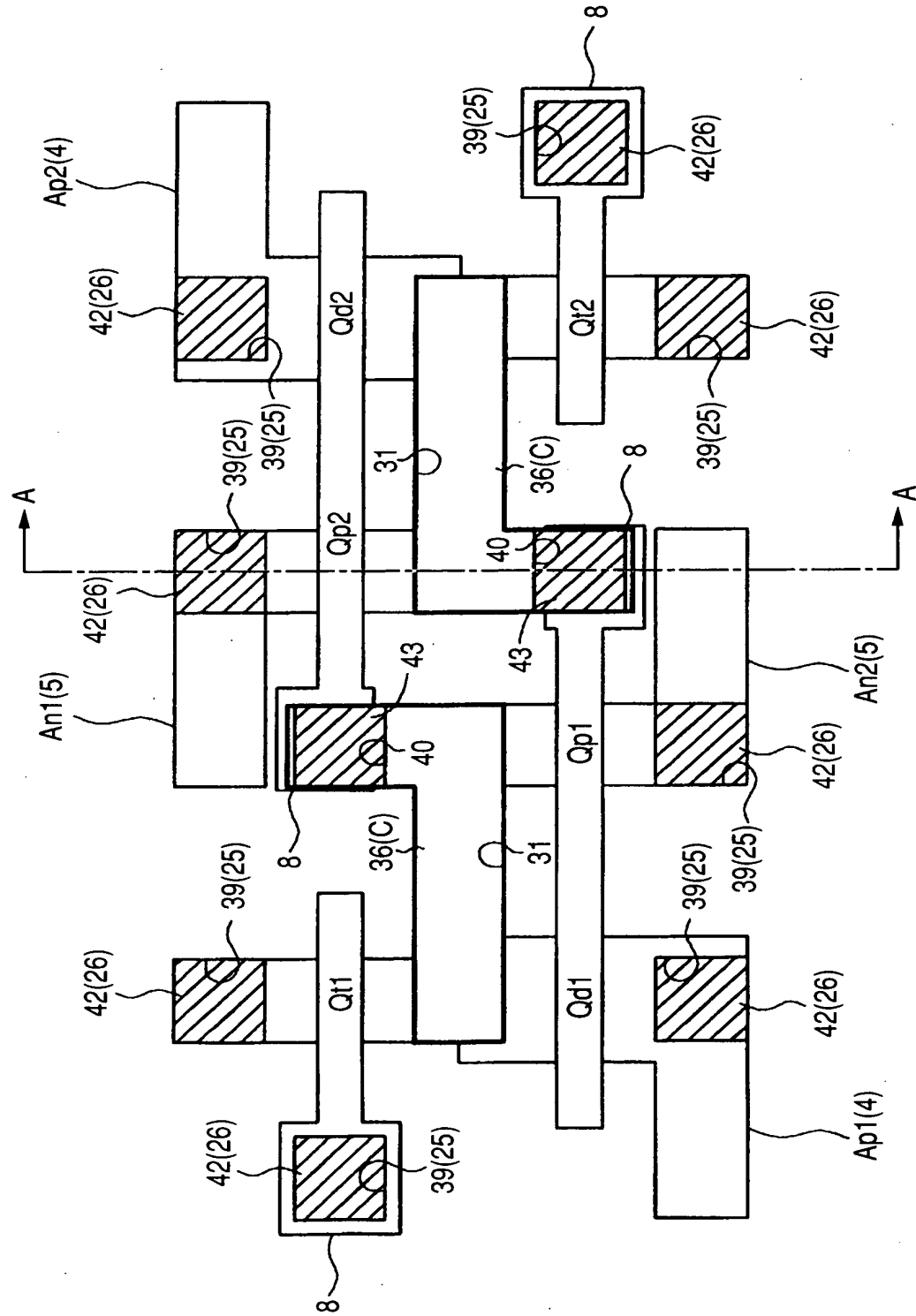
**FIG. 10****FIG. 11**



FIG. 12



**FIG. 13**

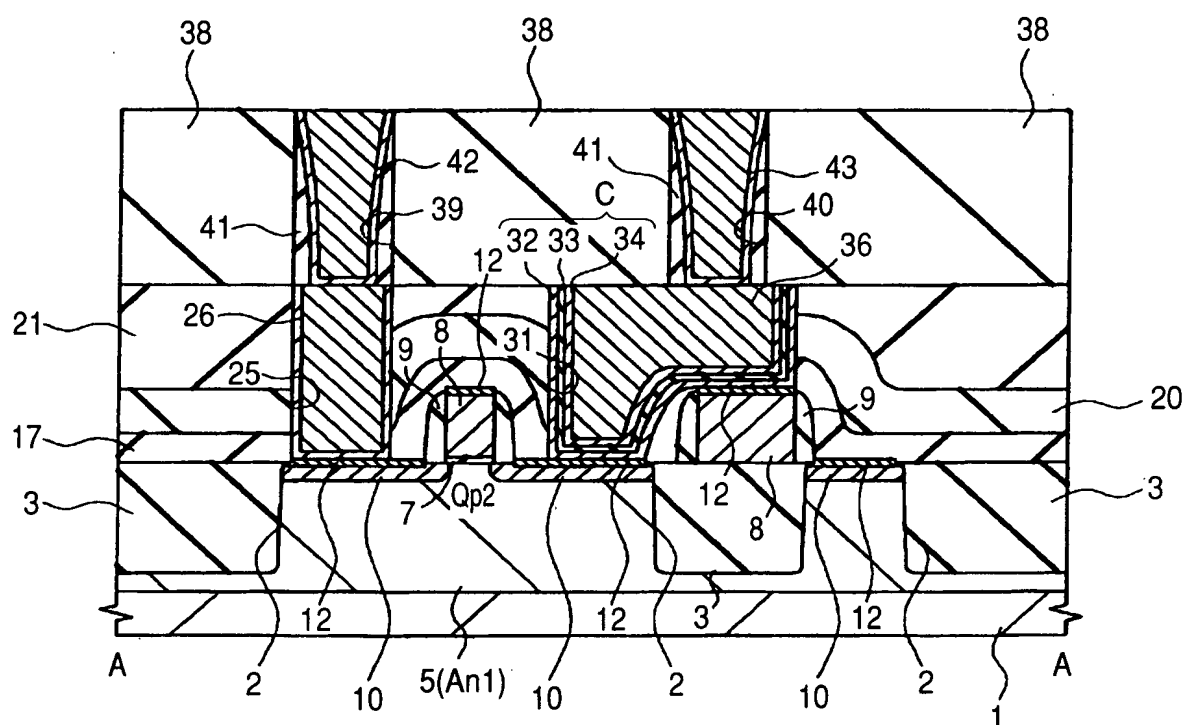
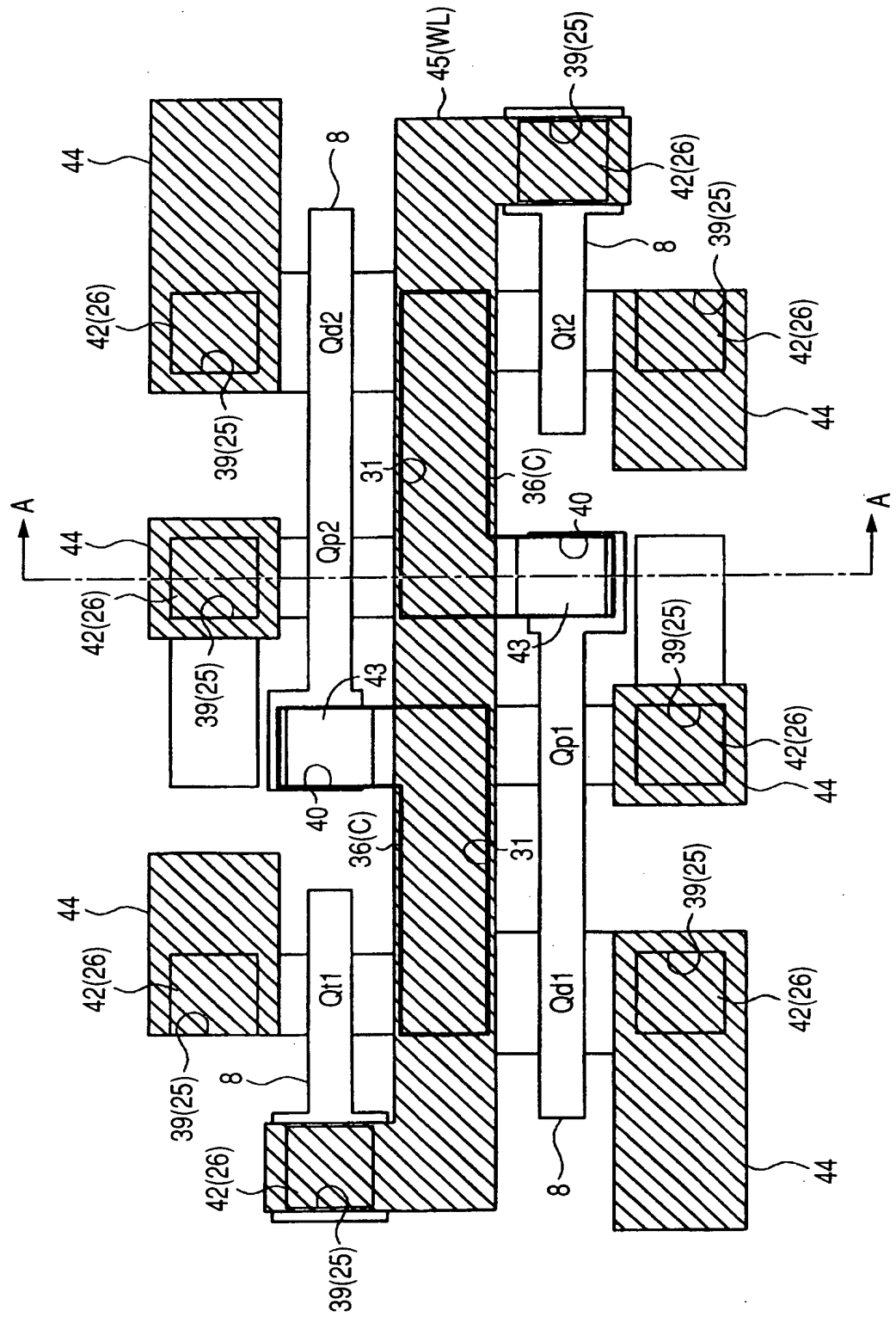
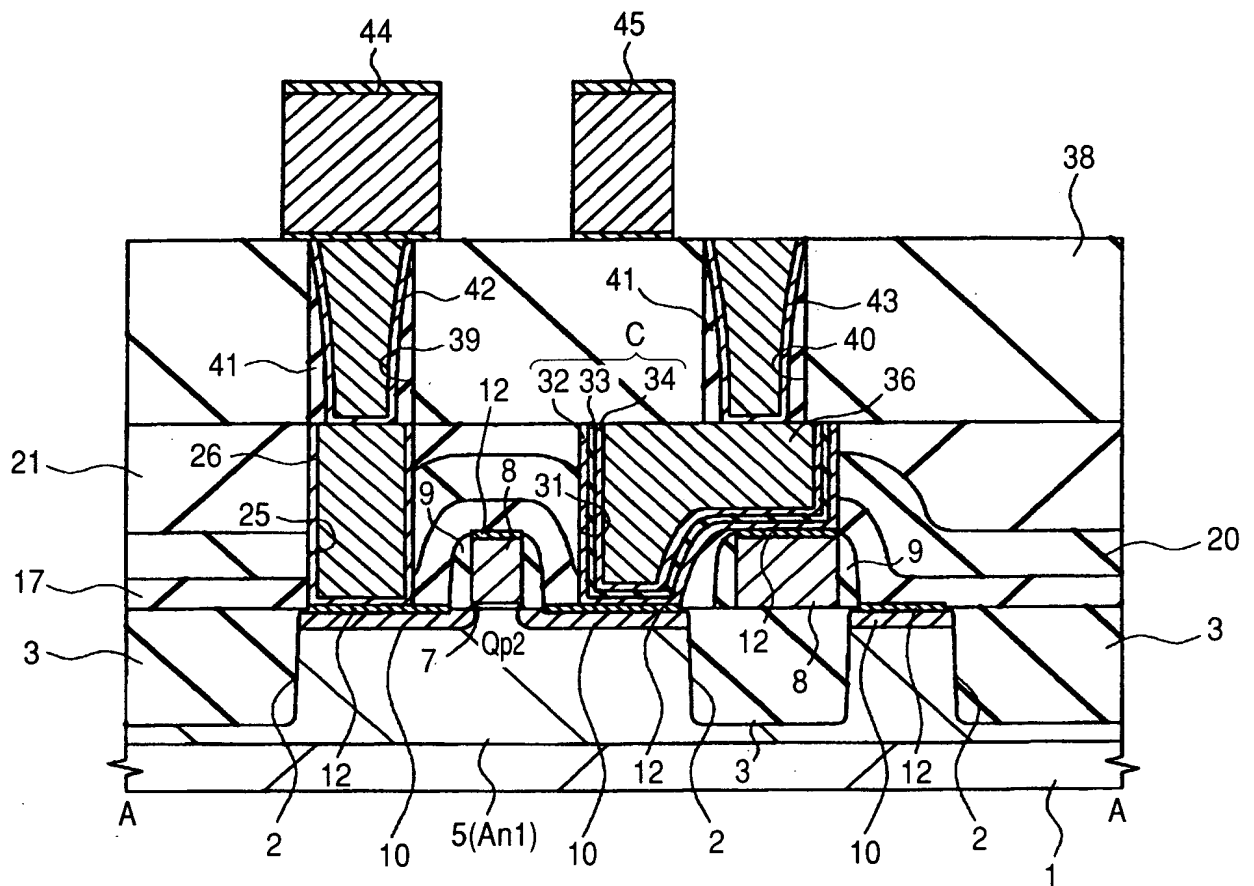


FIG. 14







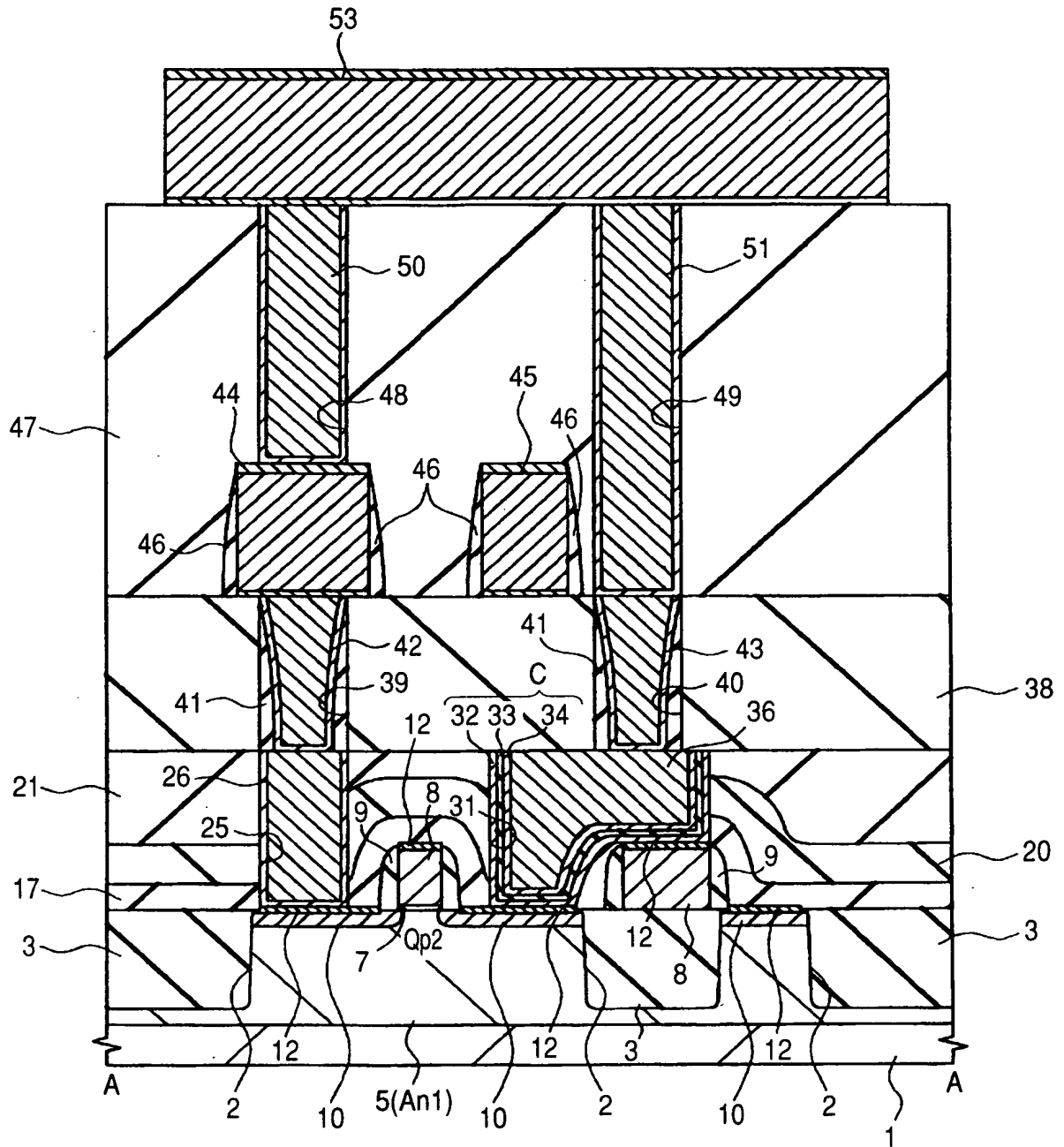
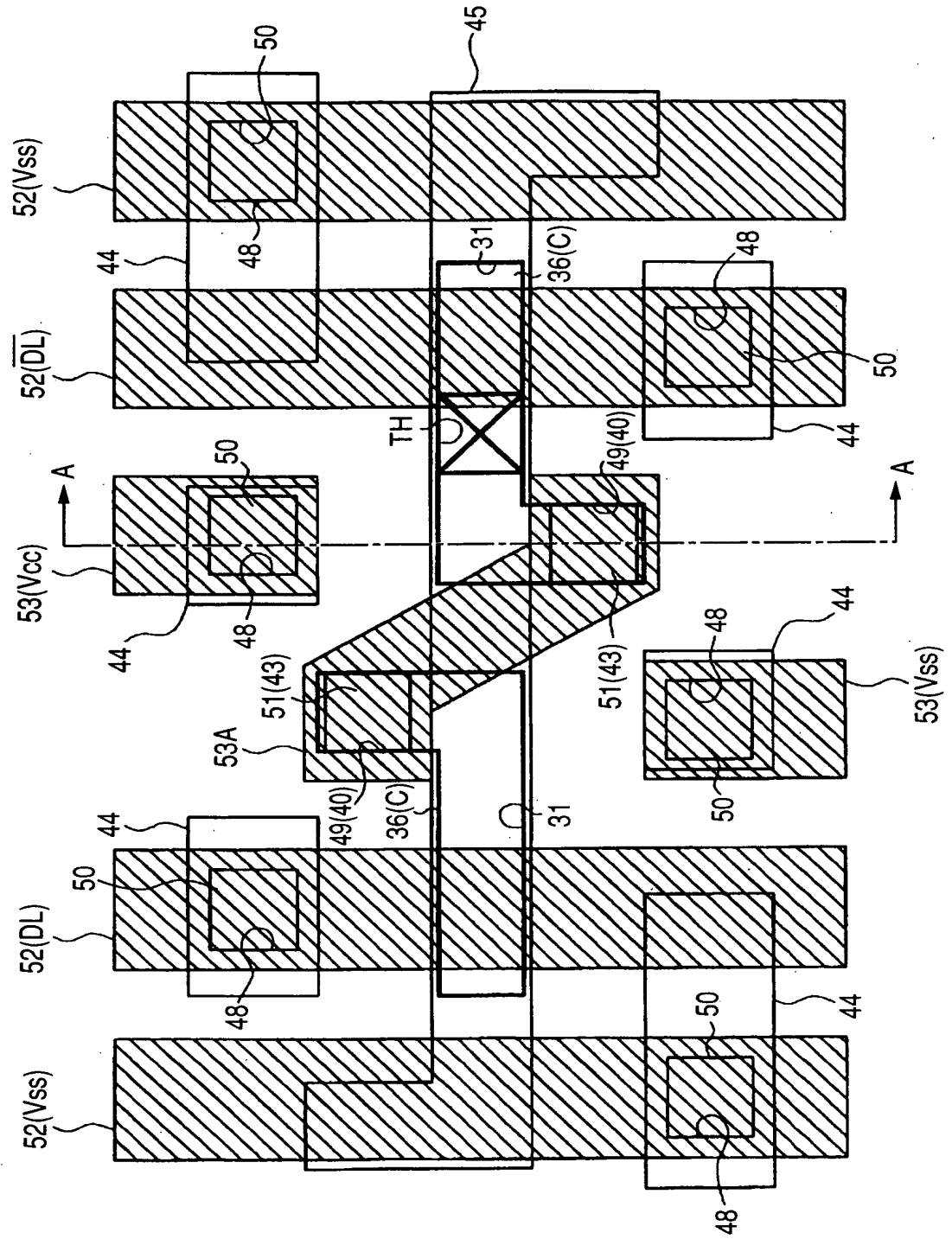
**FIG. 17**

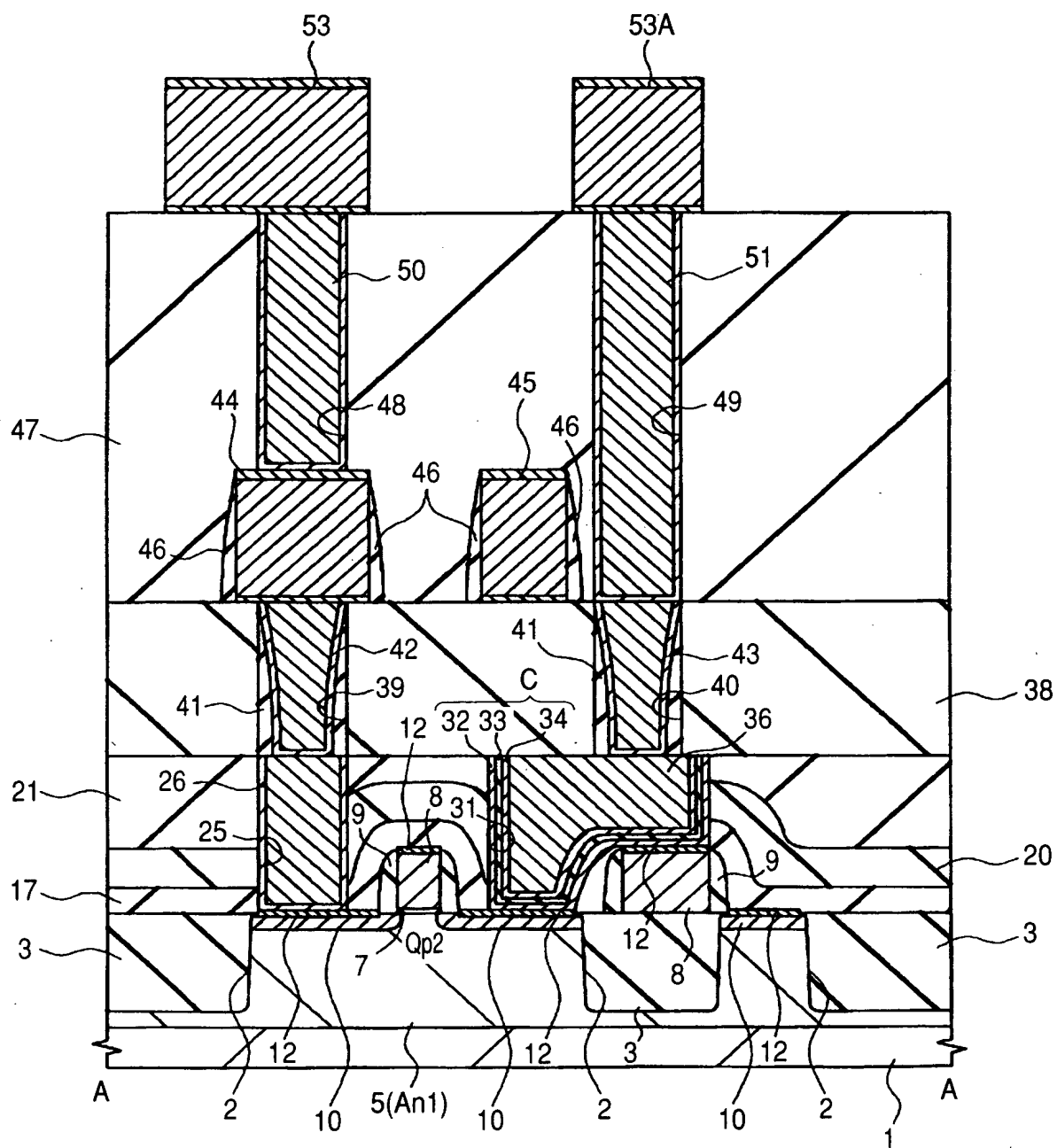


FIG. 19





**FIG. 20**



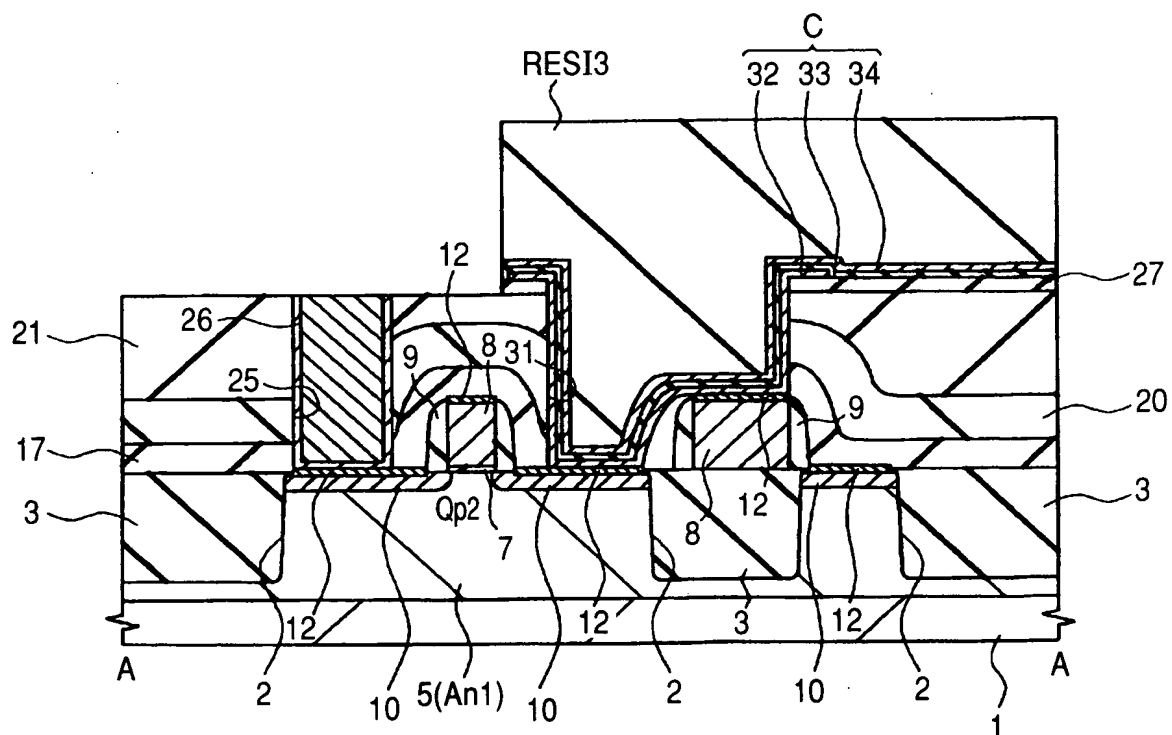




FIG. 24

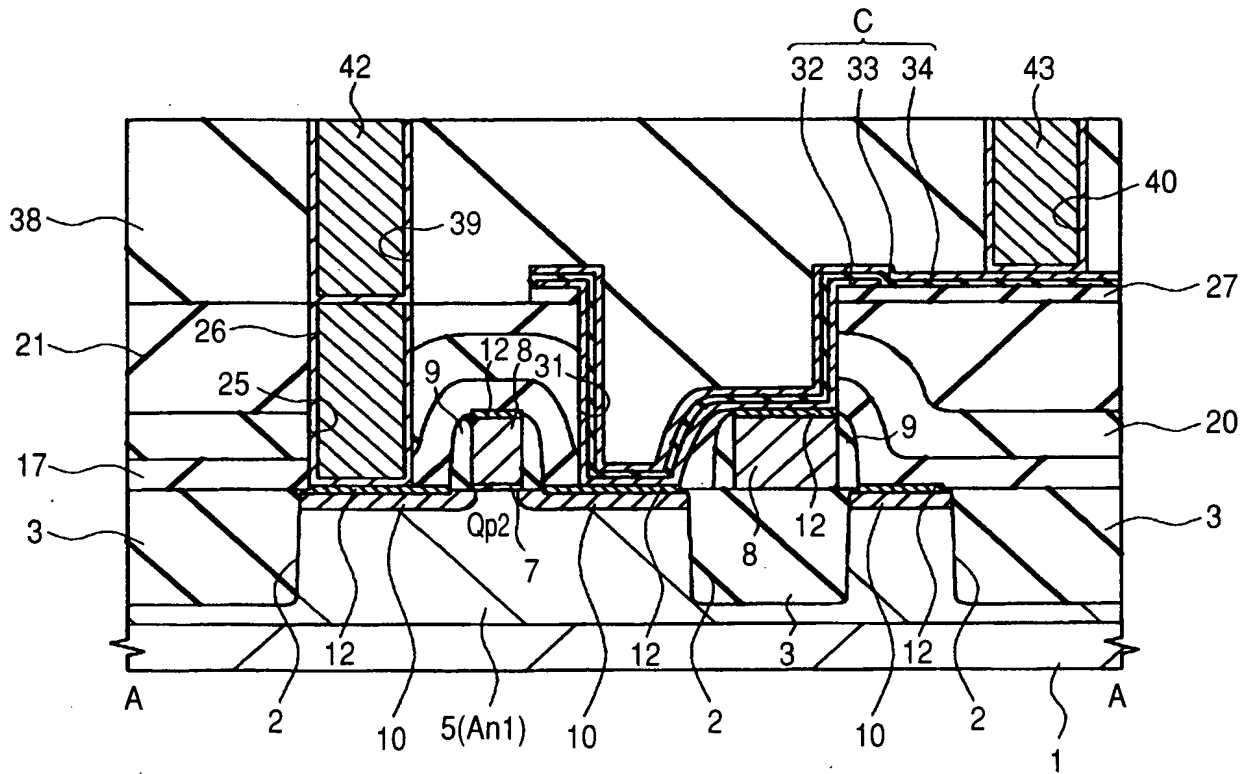


FIG. 25

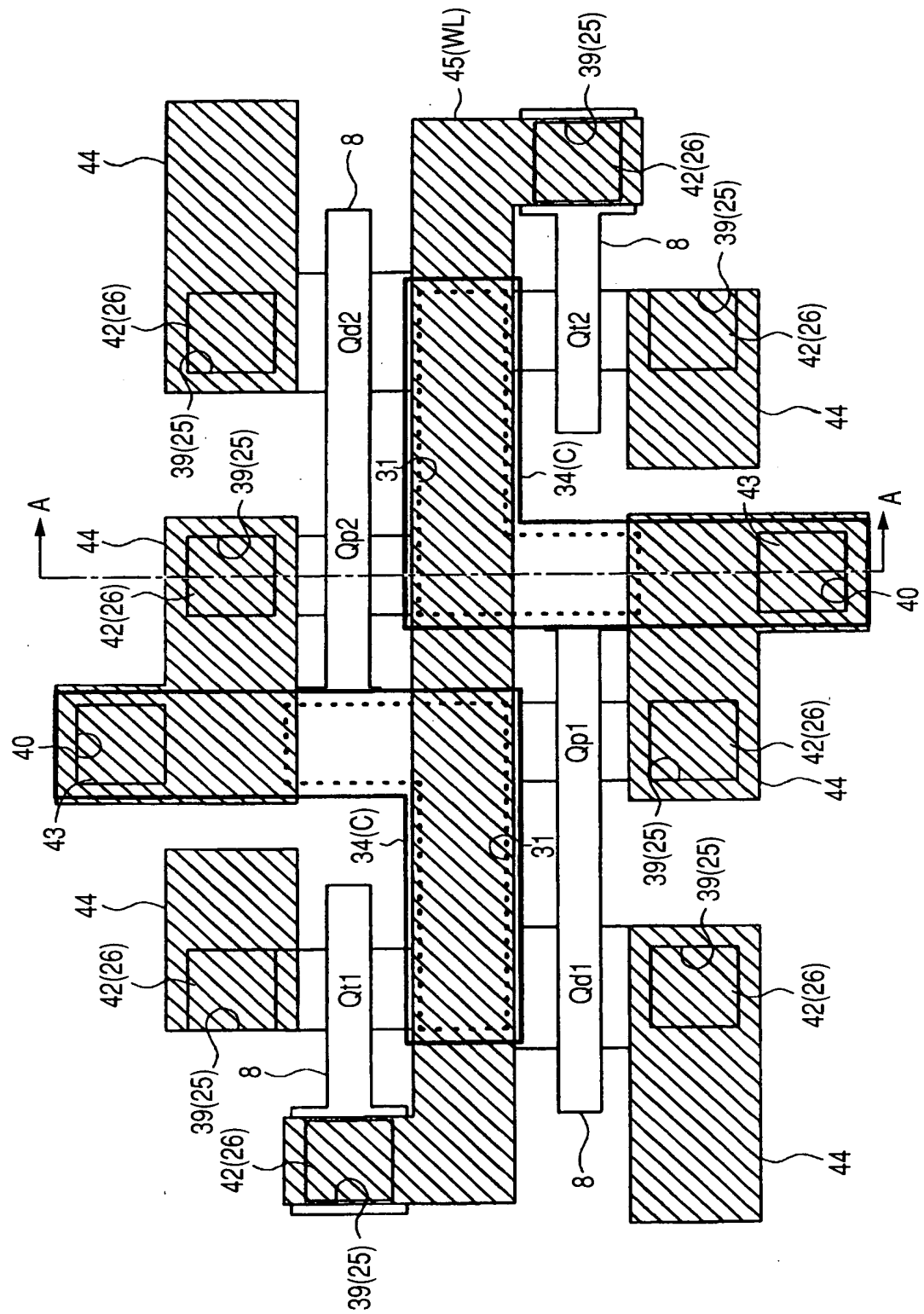


FIG. 26

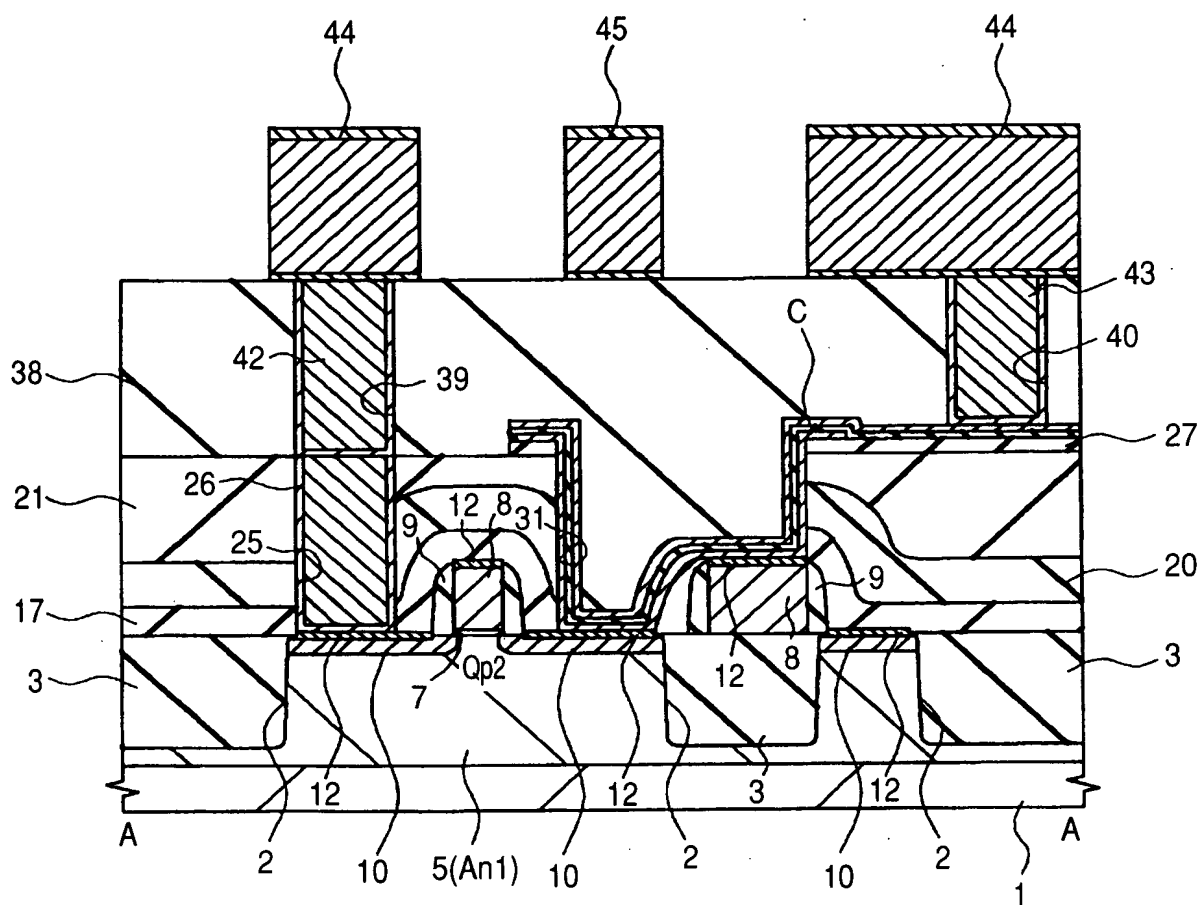
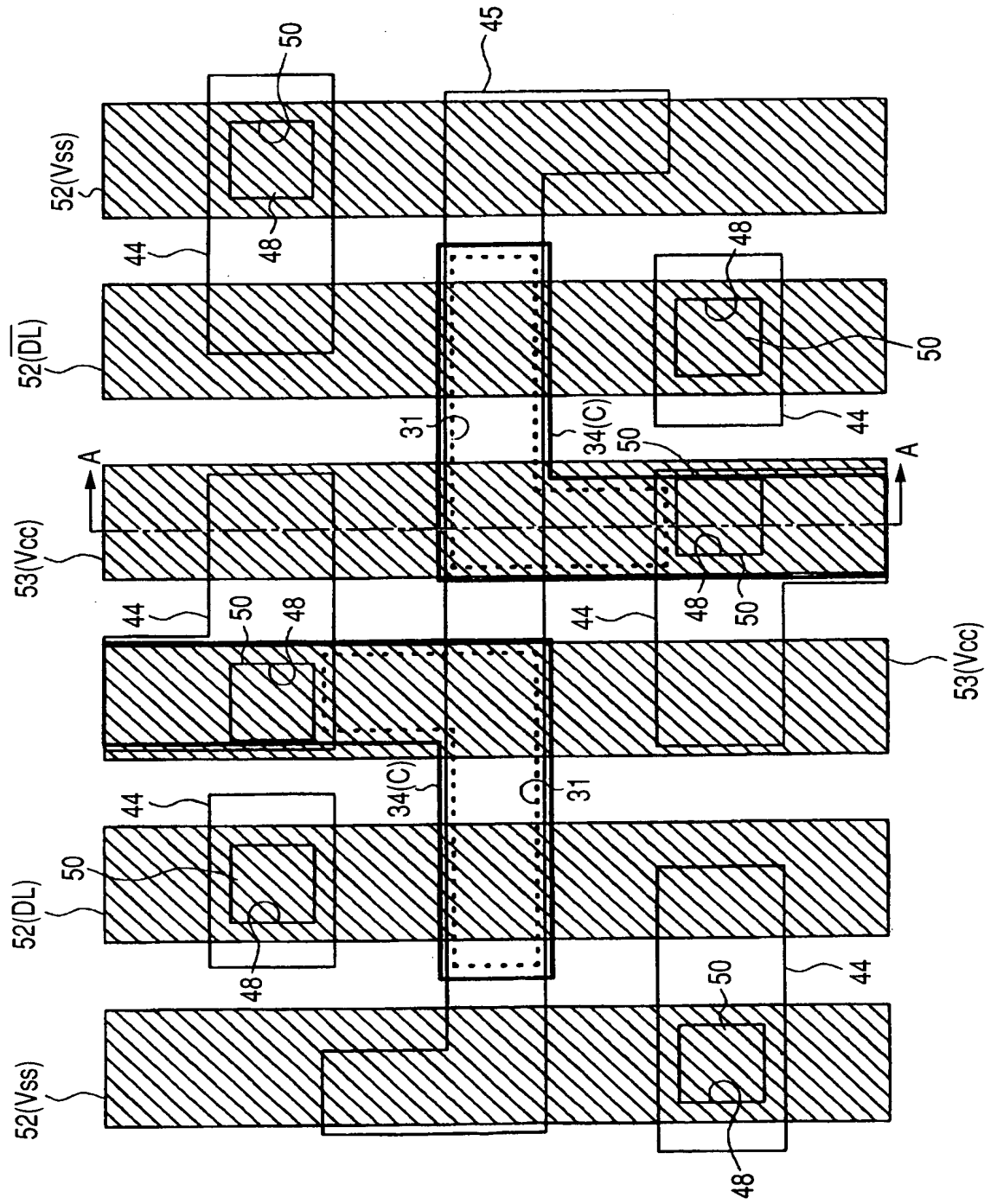
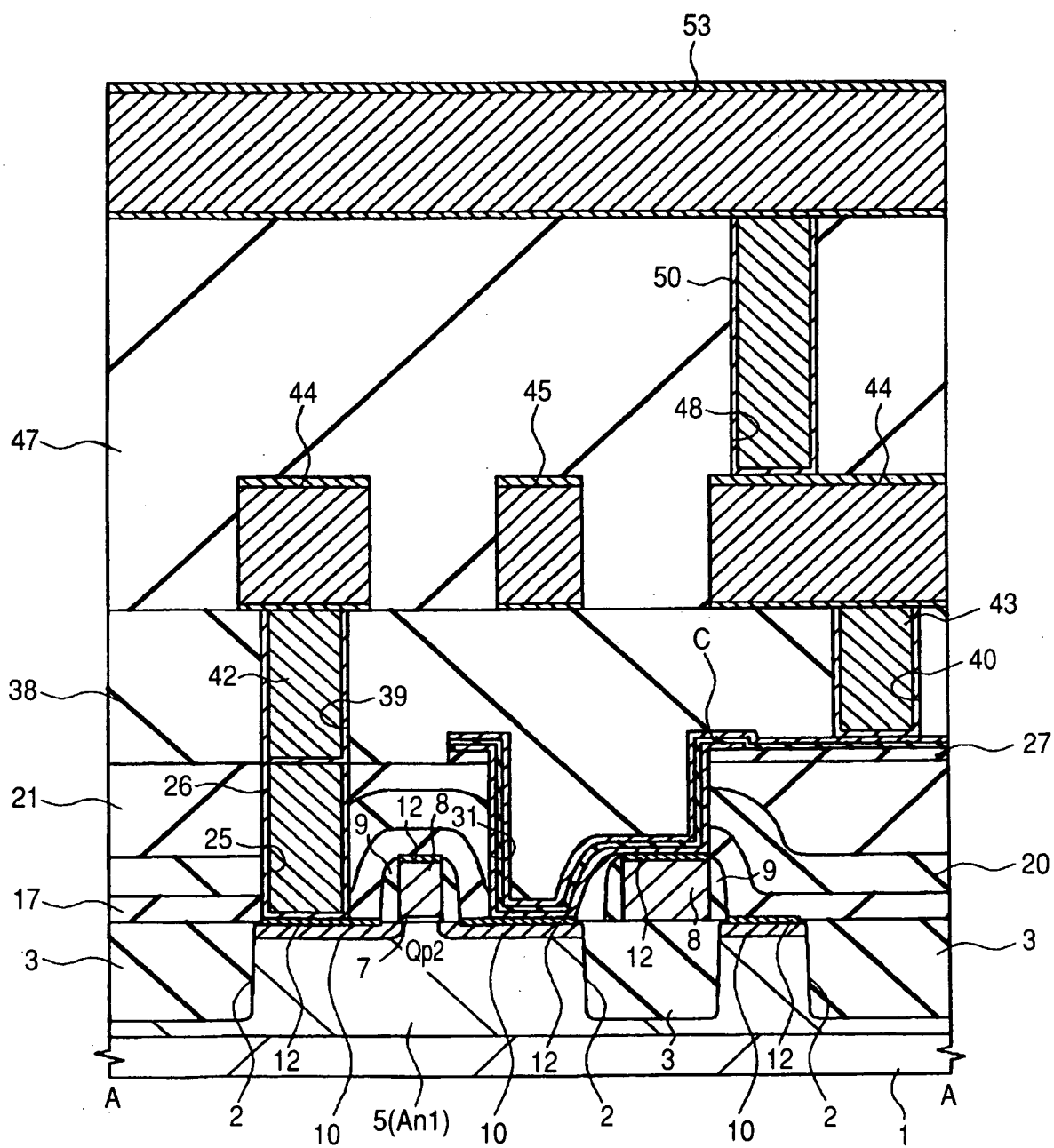


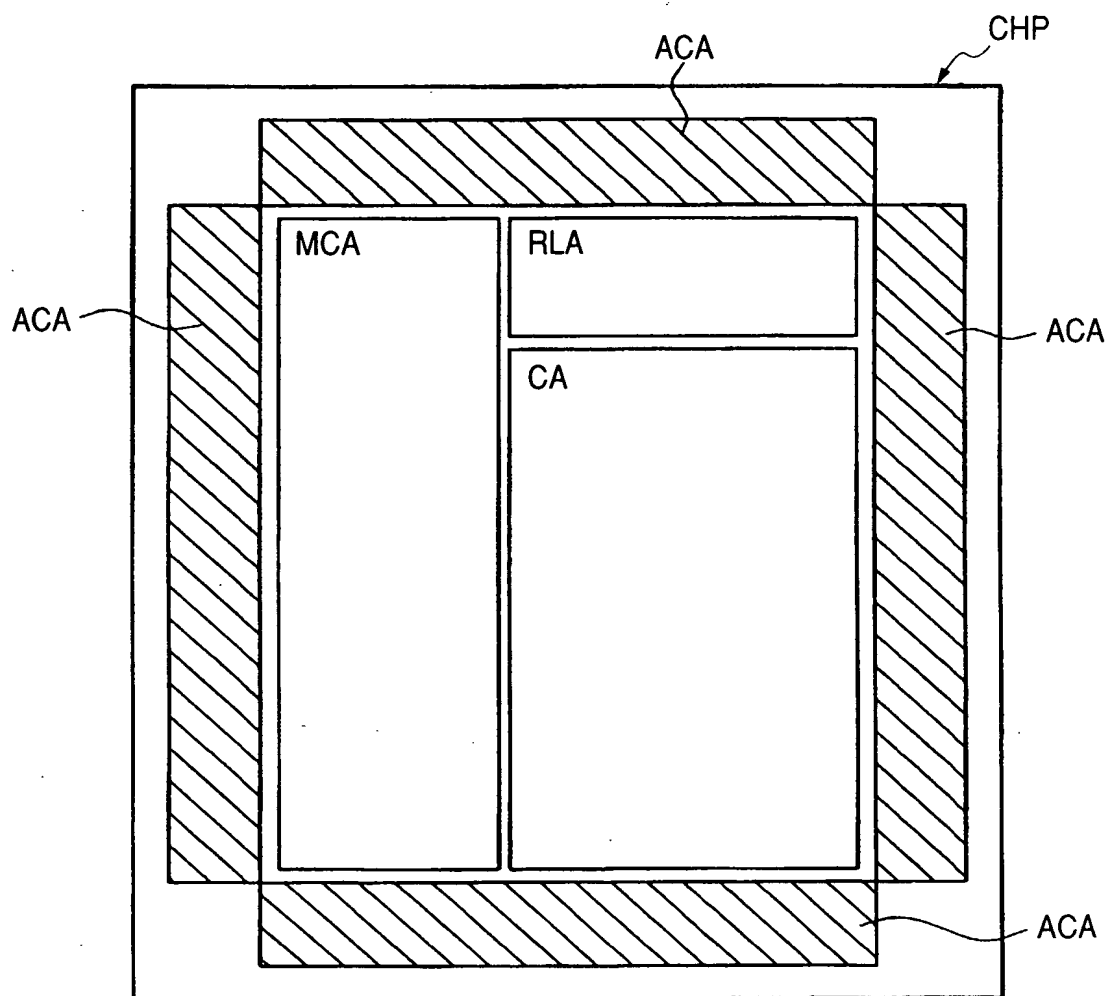
FIG. 27









*FIG. 30*

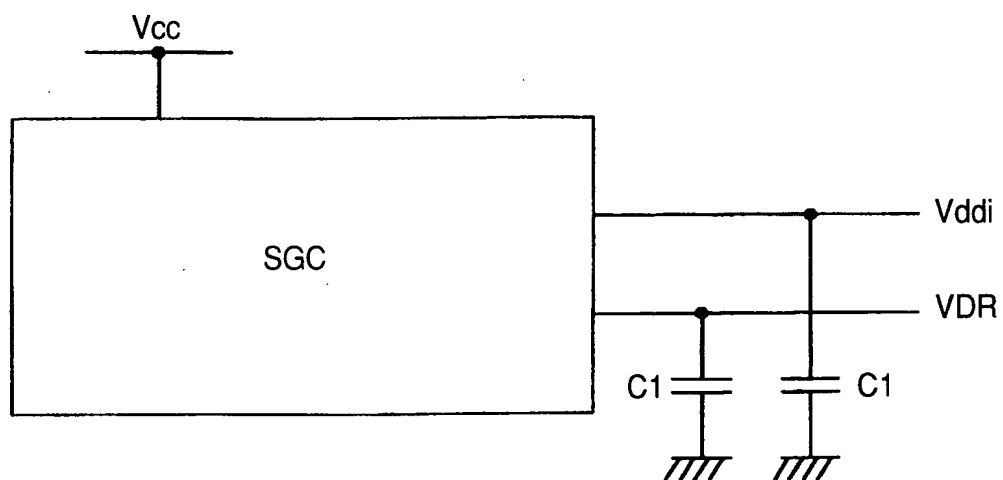
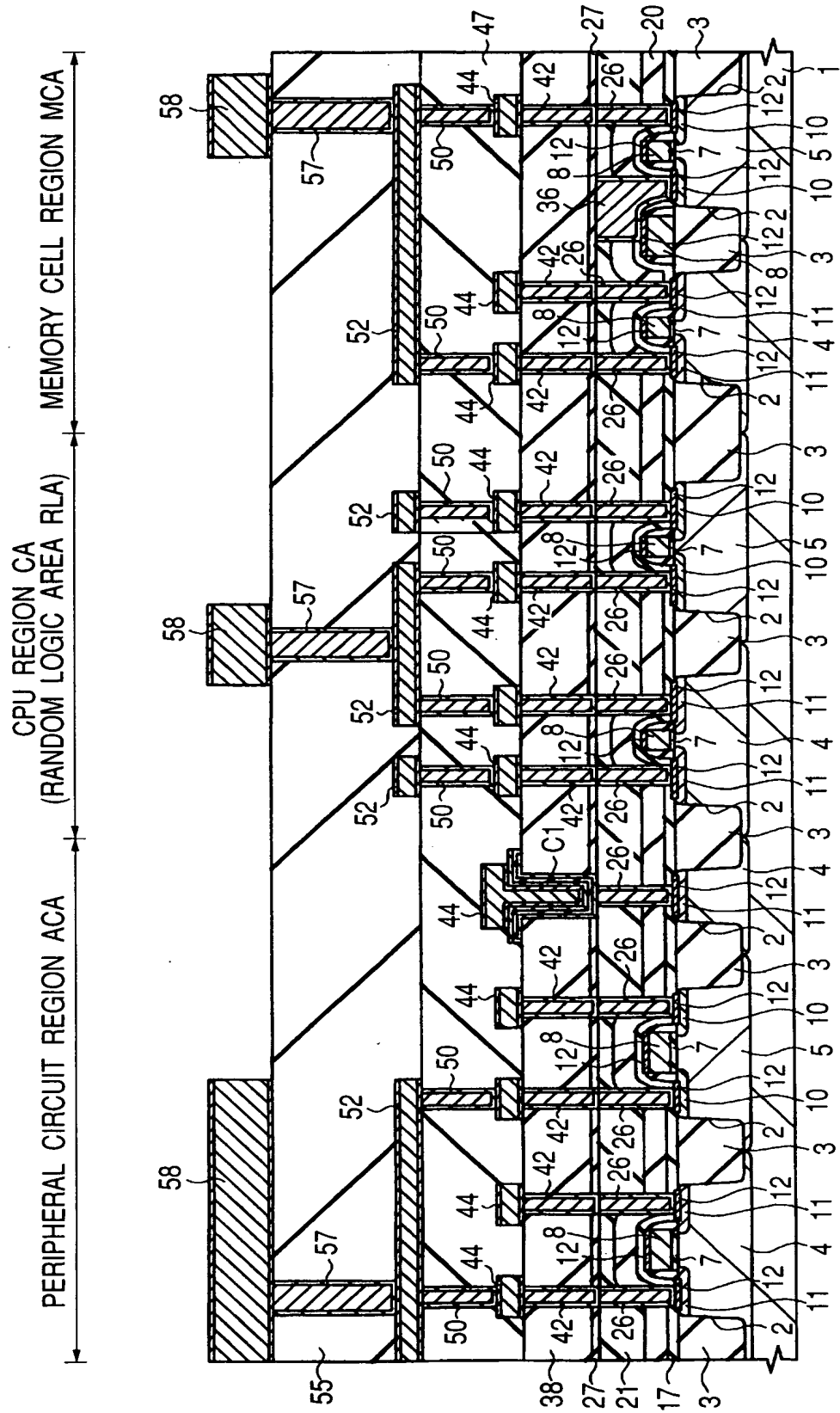
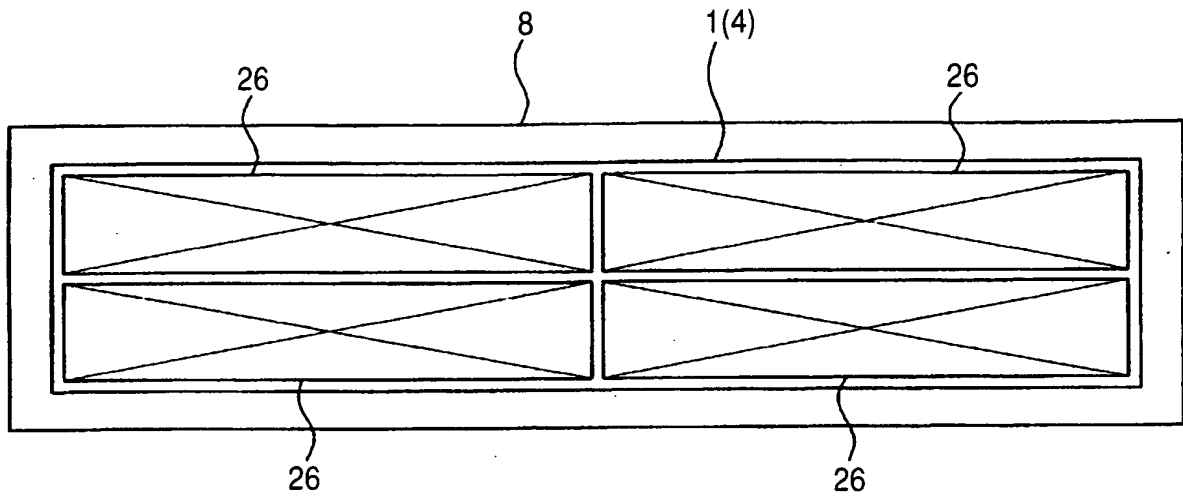
*FIG. 31*

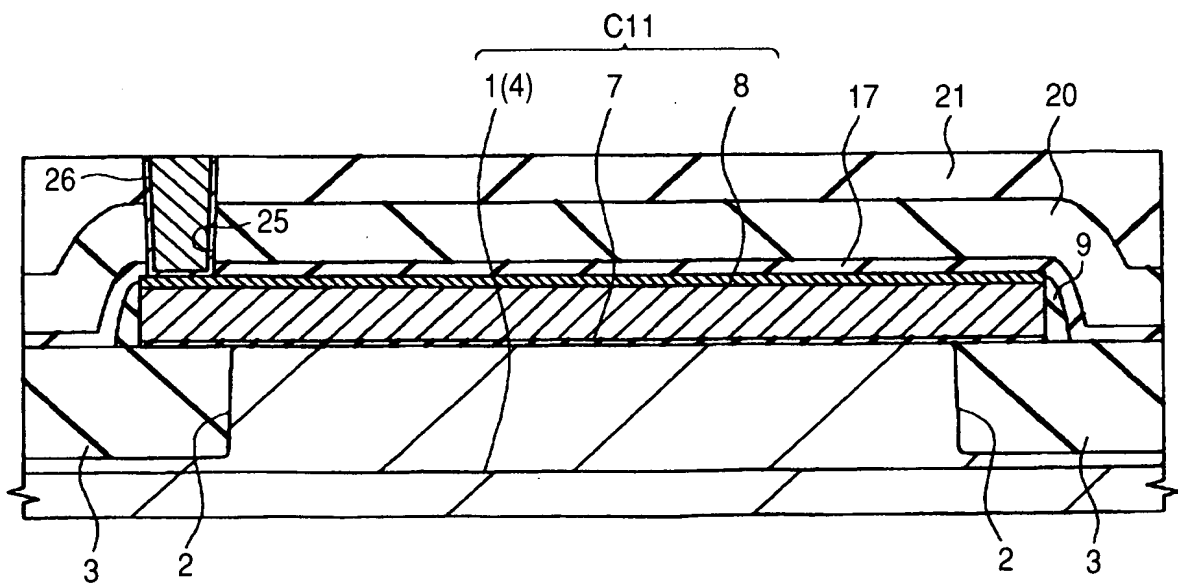
FIG. 32



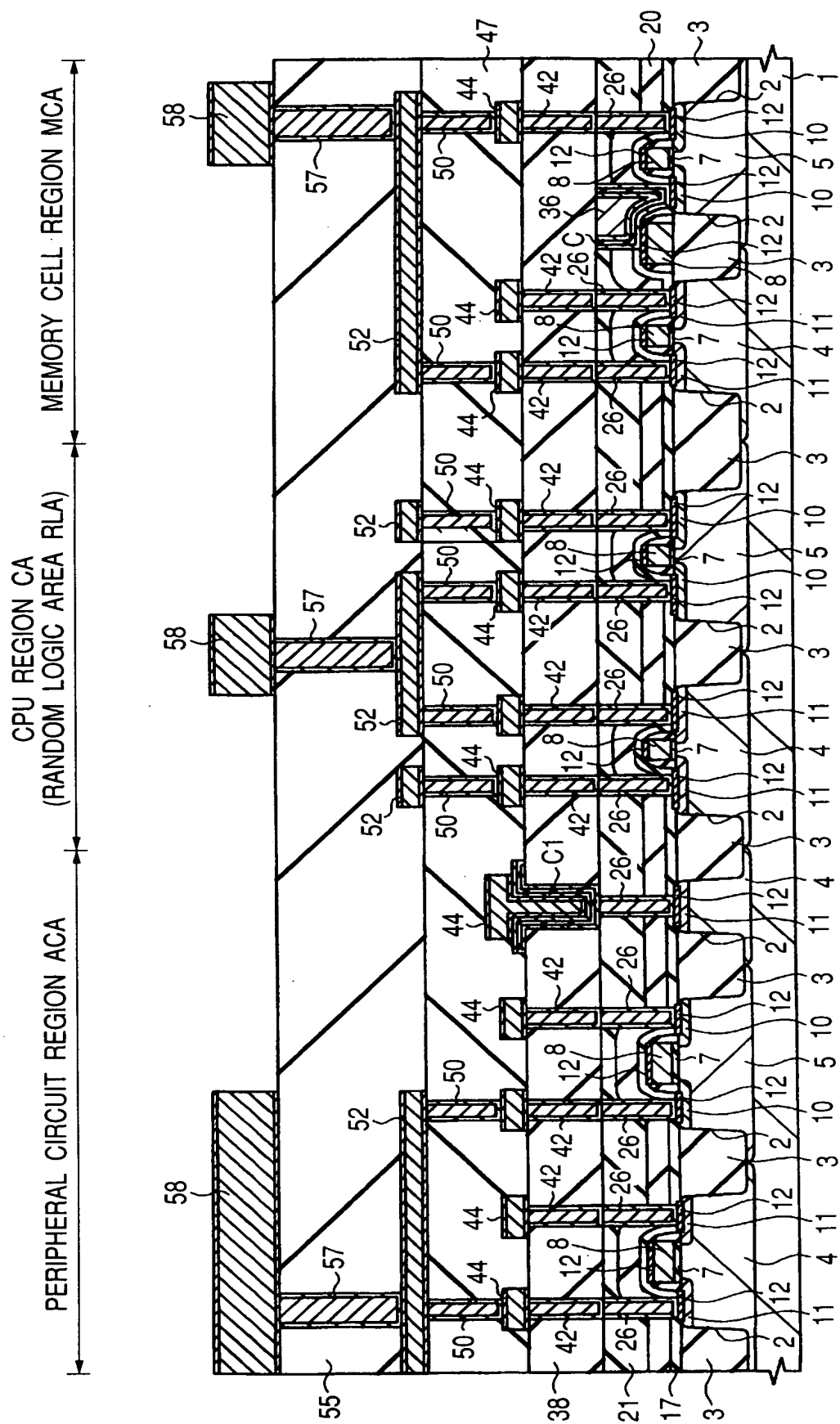
**FIG. 33**



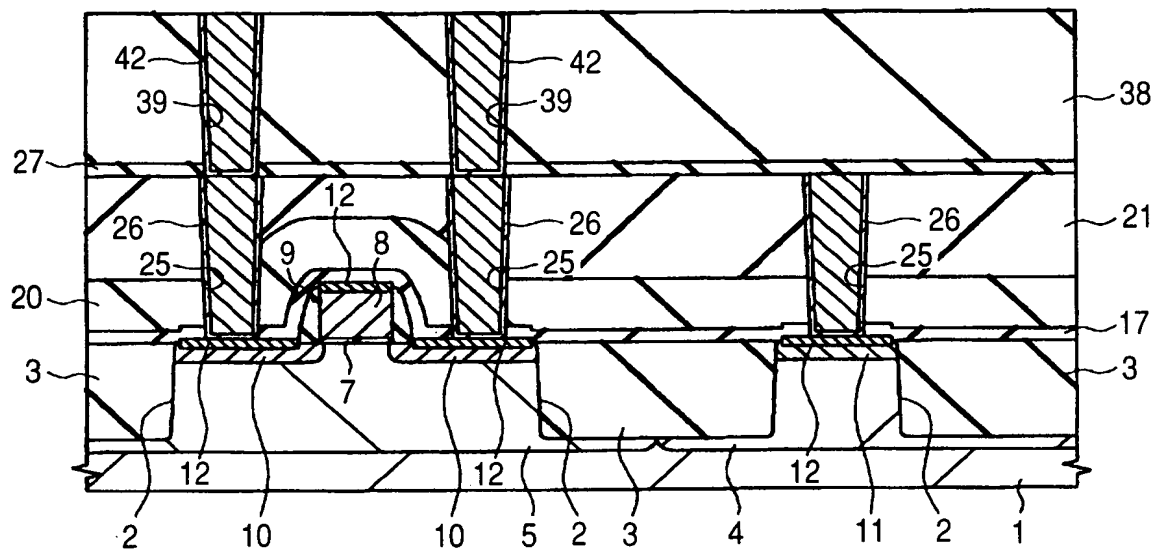
**FIG. 34**



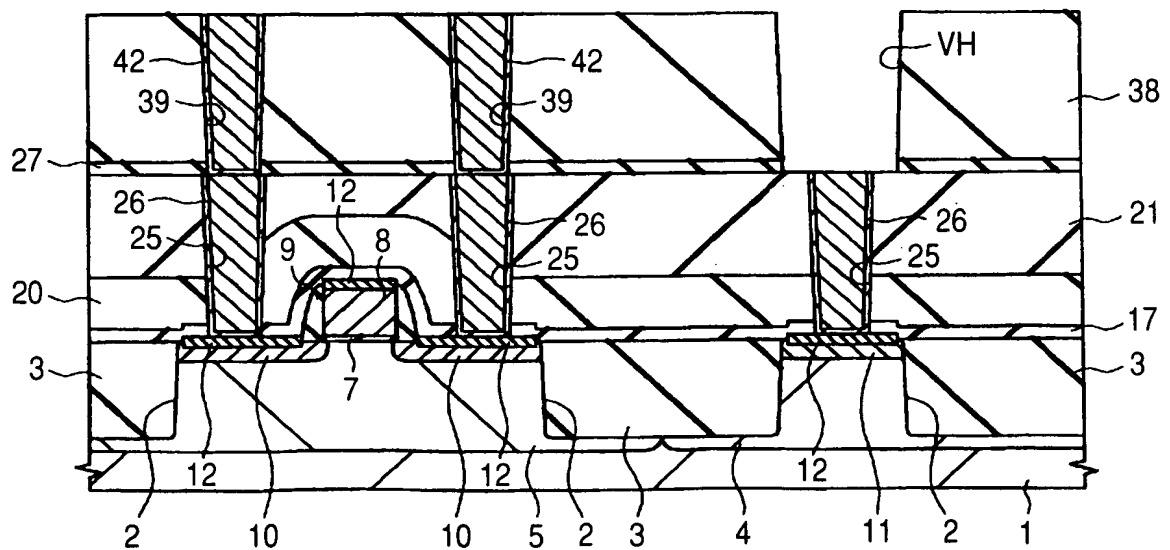
**FIG. 35**



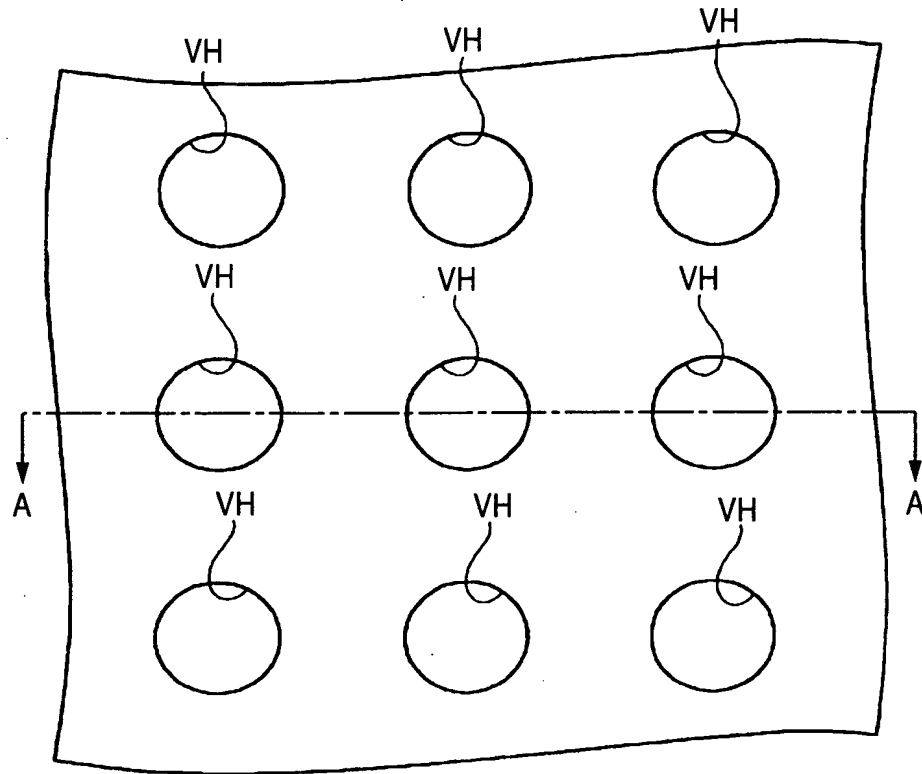
**FIG. 36**



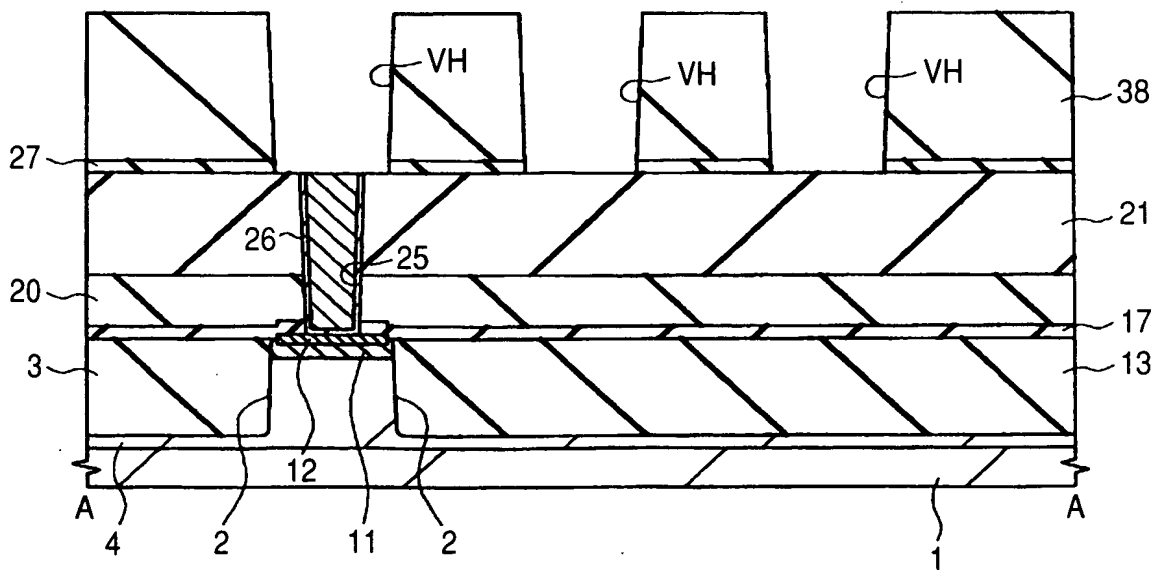
**FIG. 37**



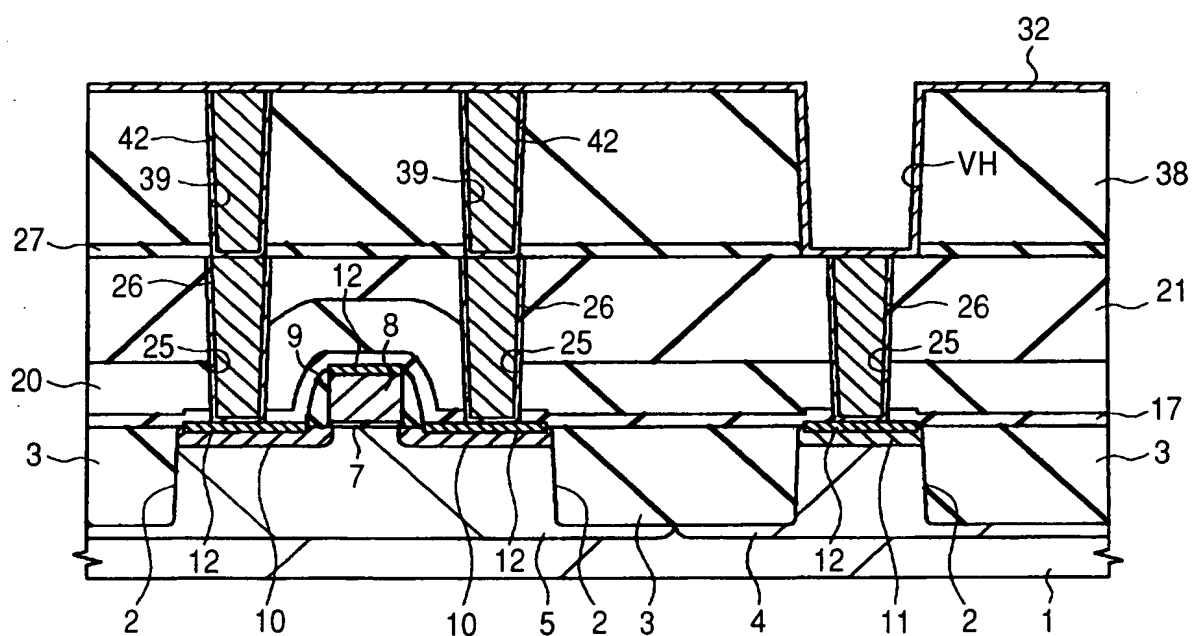
**FIG. 38**



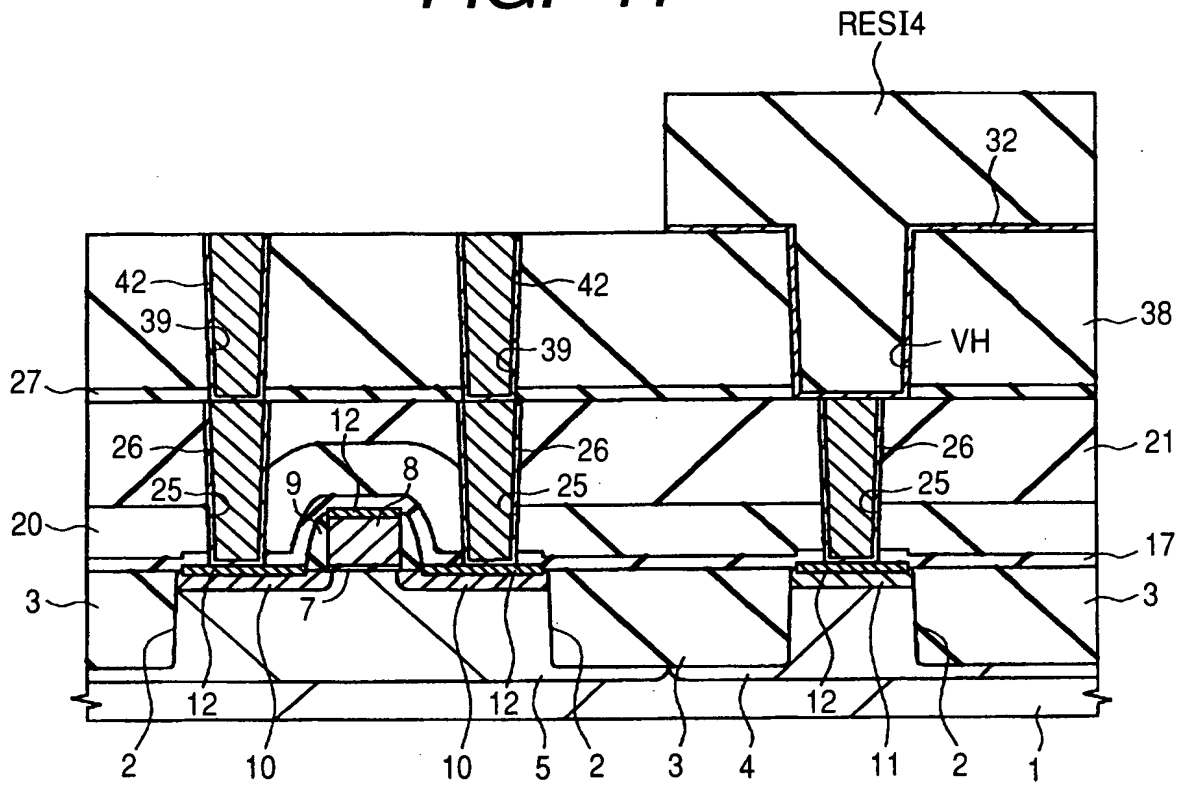
**FIG. 39**



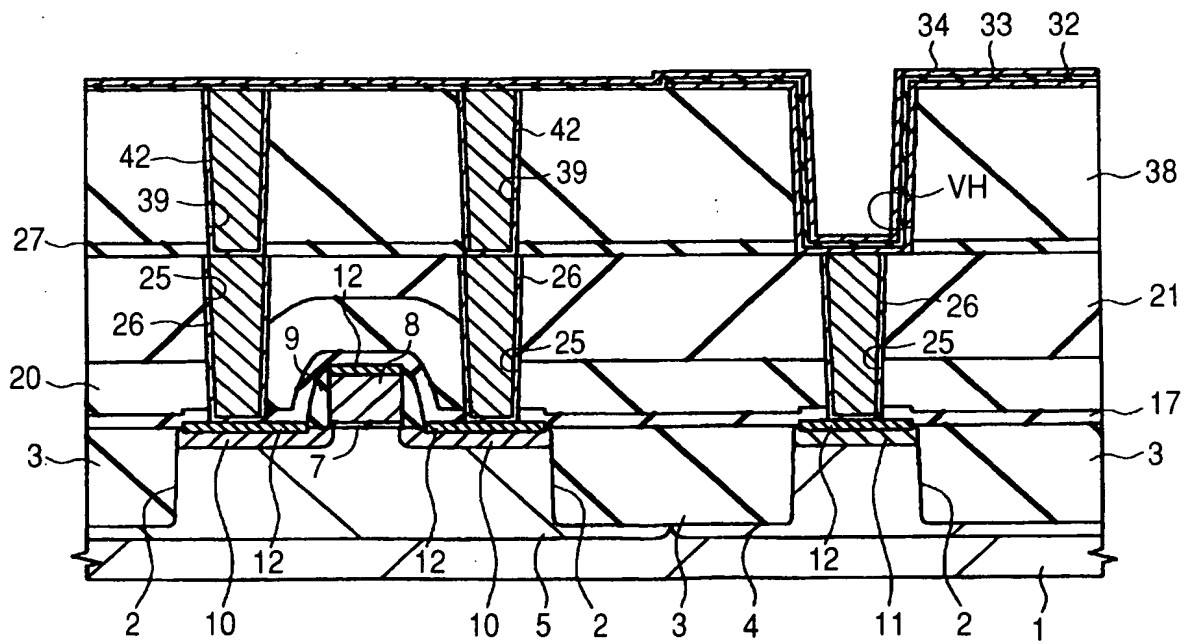


**FIG. 40**

**FIG. 41**



**FIG. 42**



**FIG. 43**

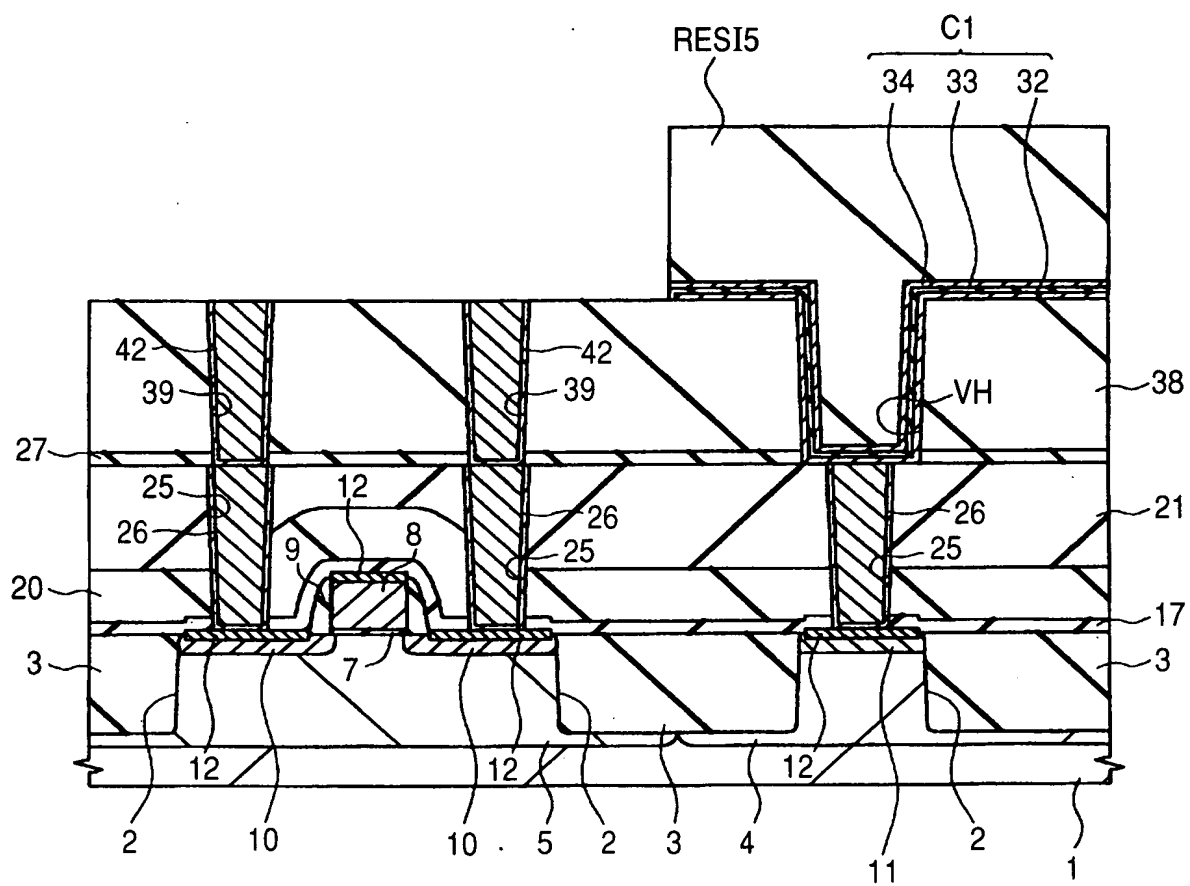
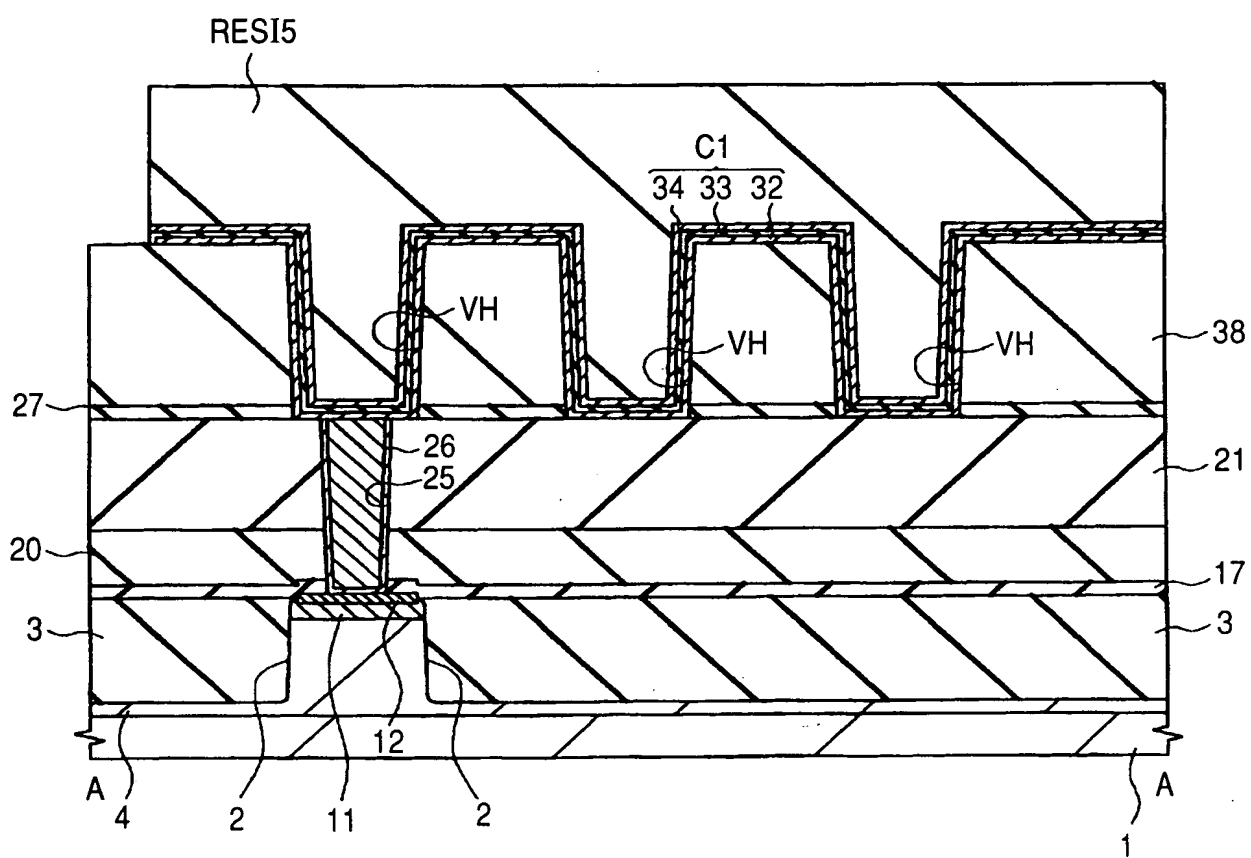


FIG. 44



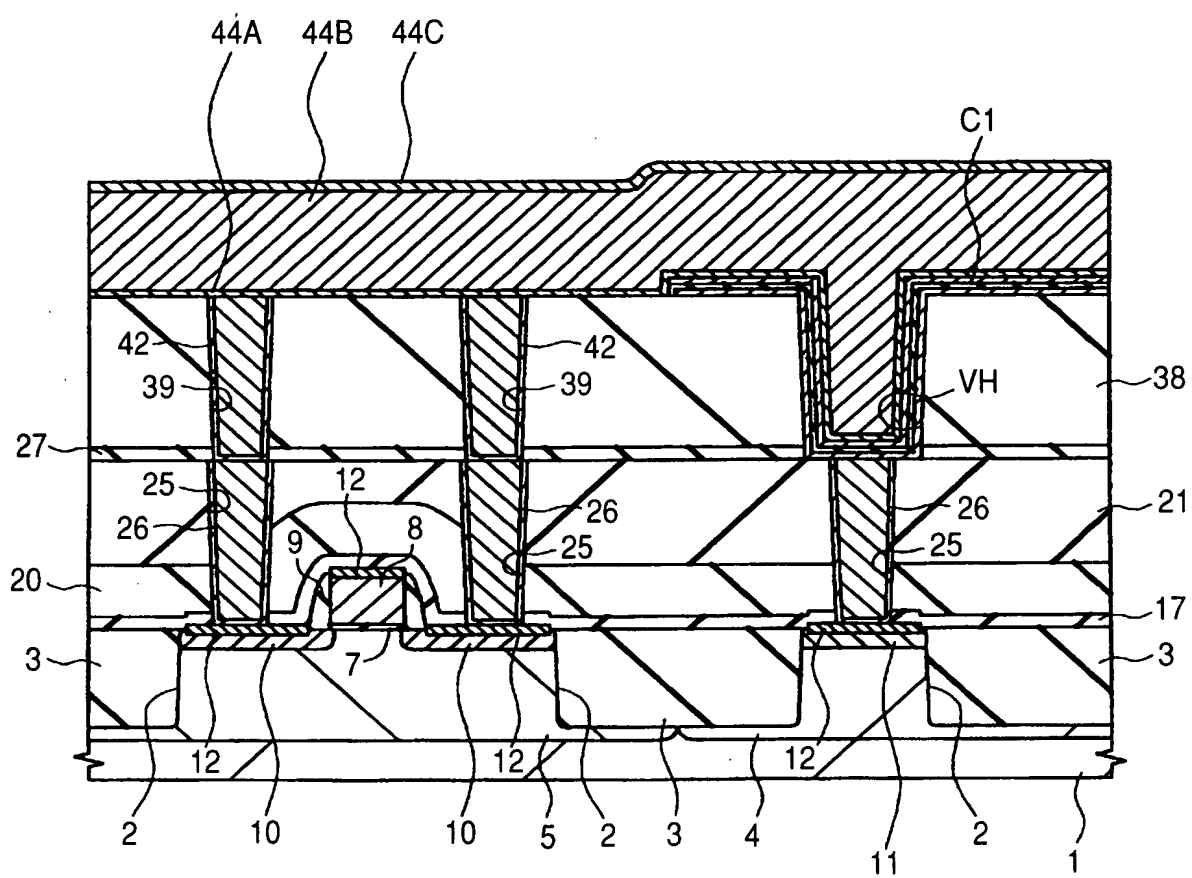
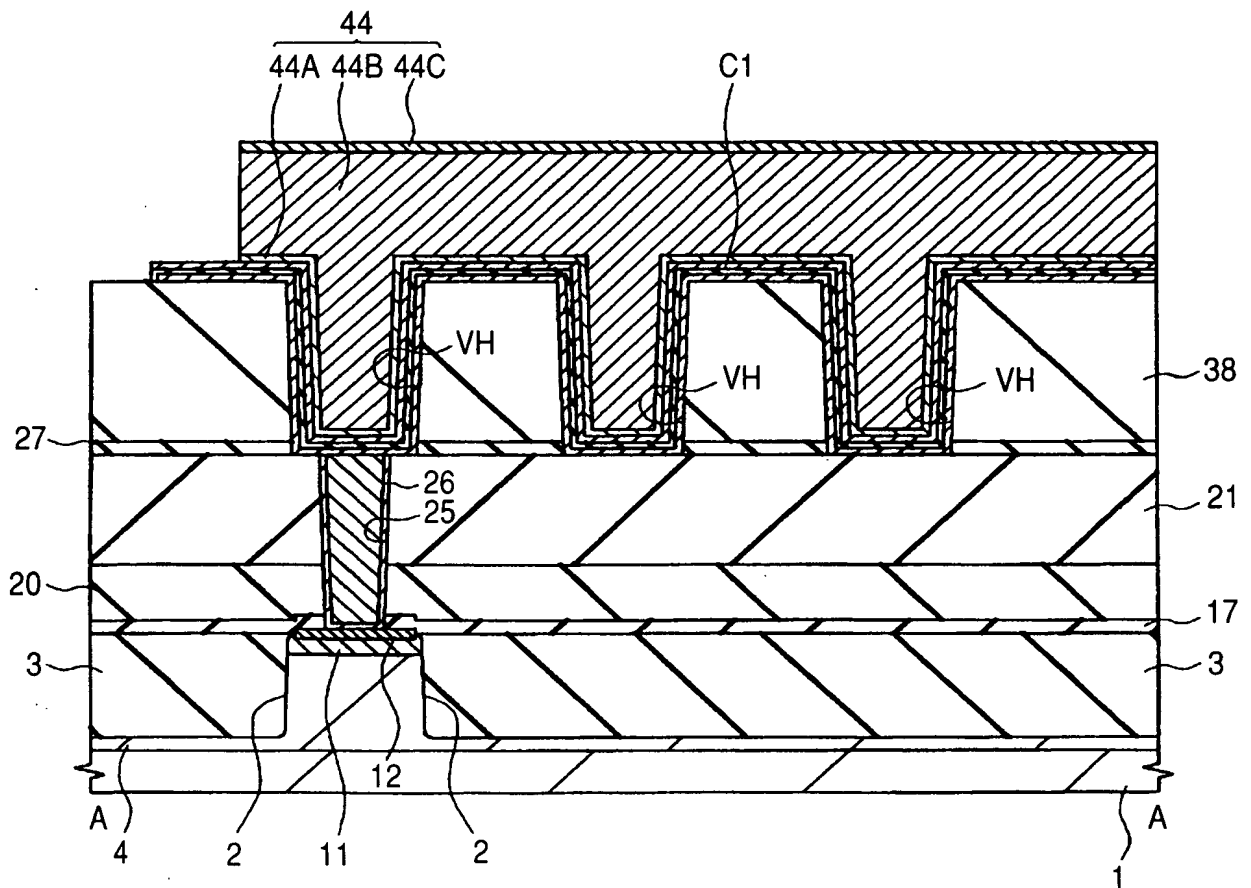
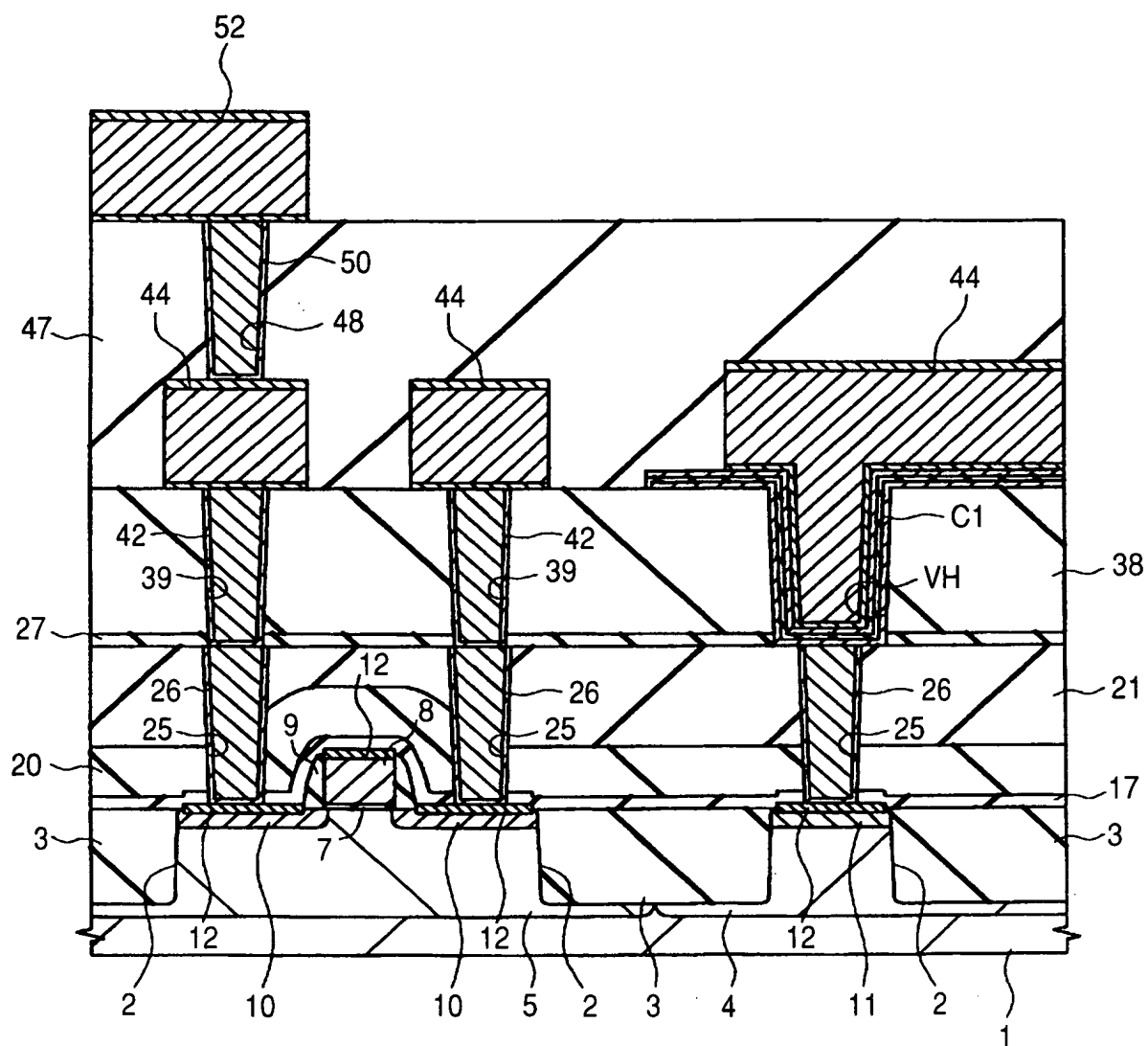
**FIG. 45**



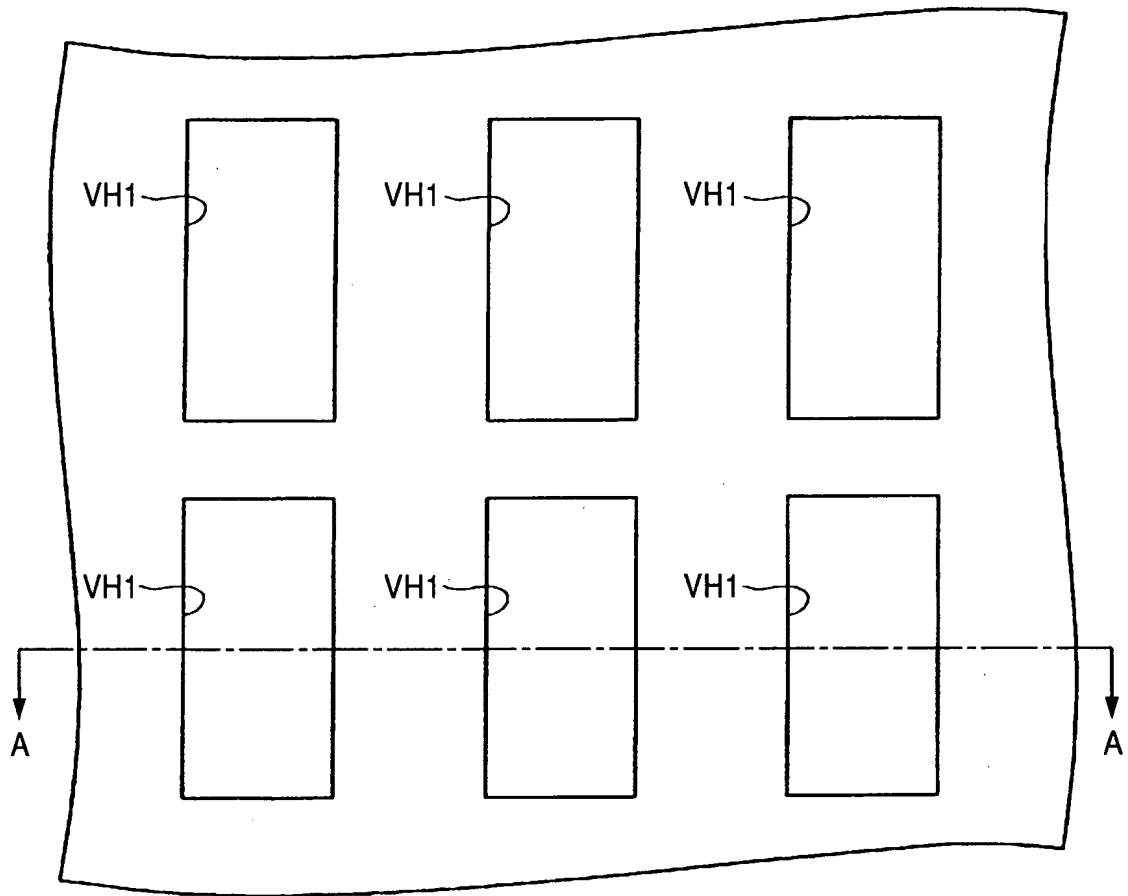
FIG. 47



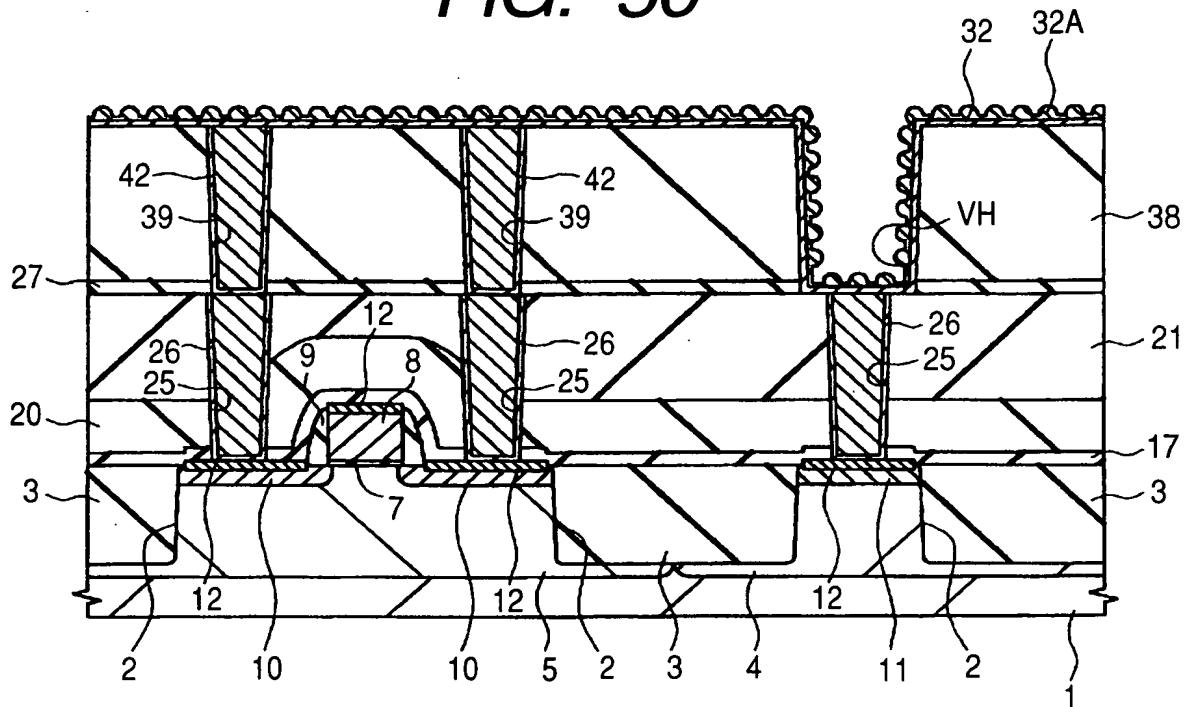




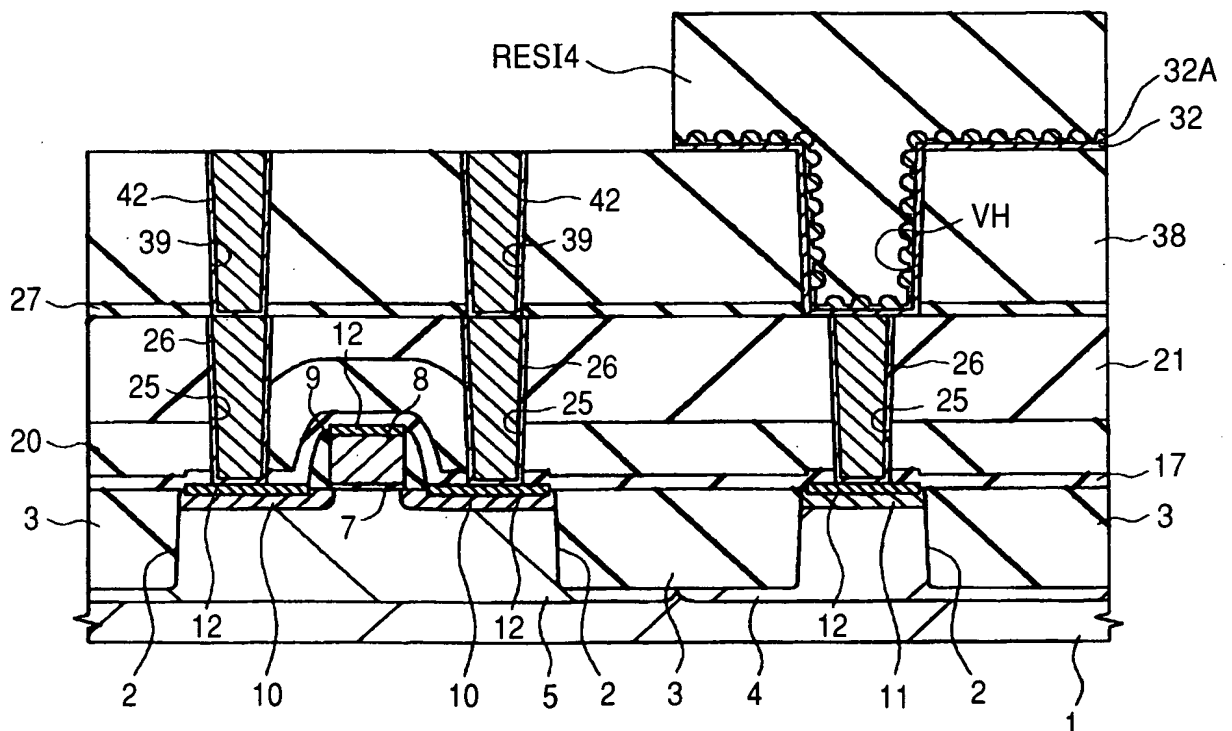
**FIG. 49**

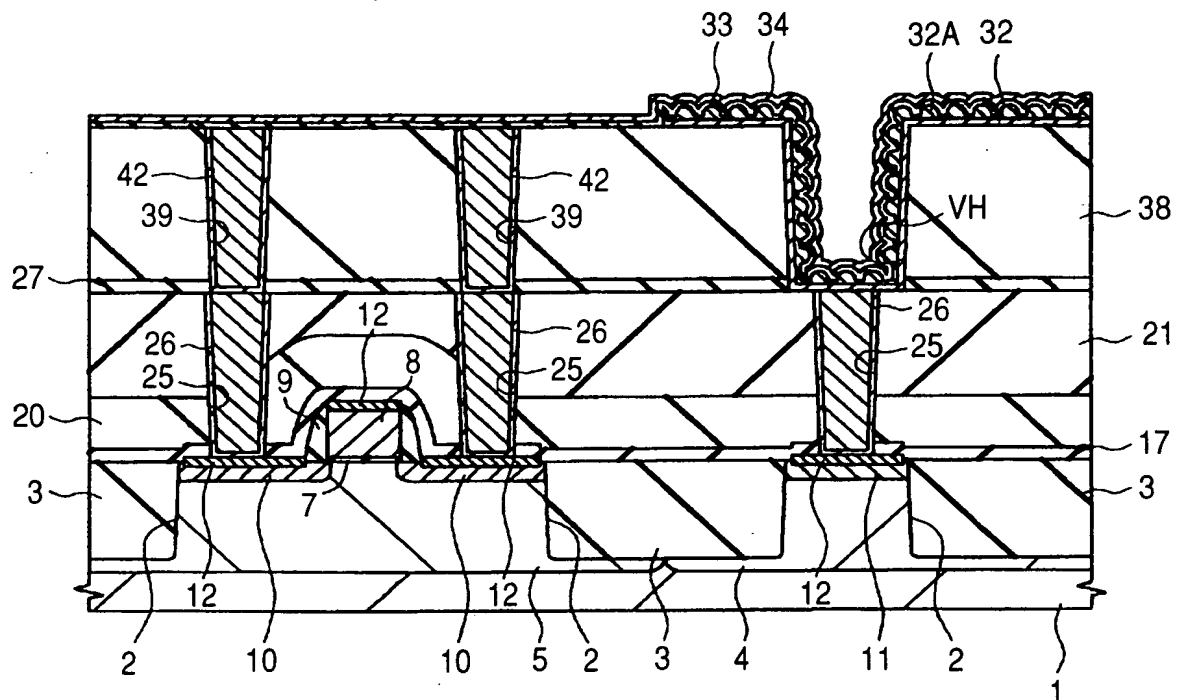
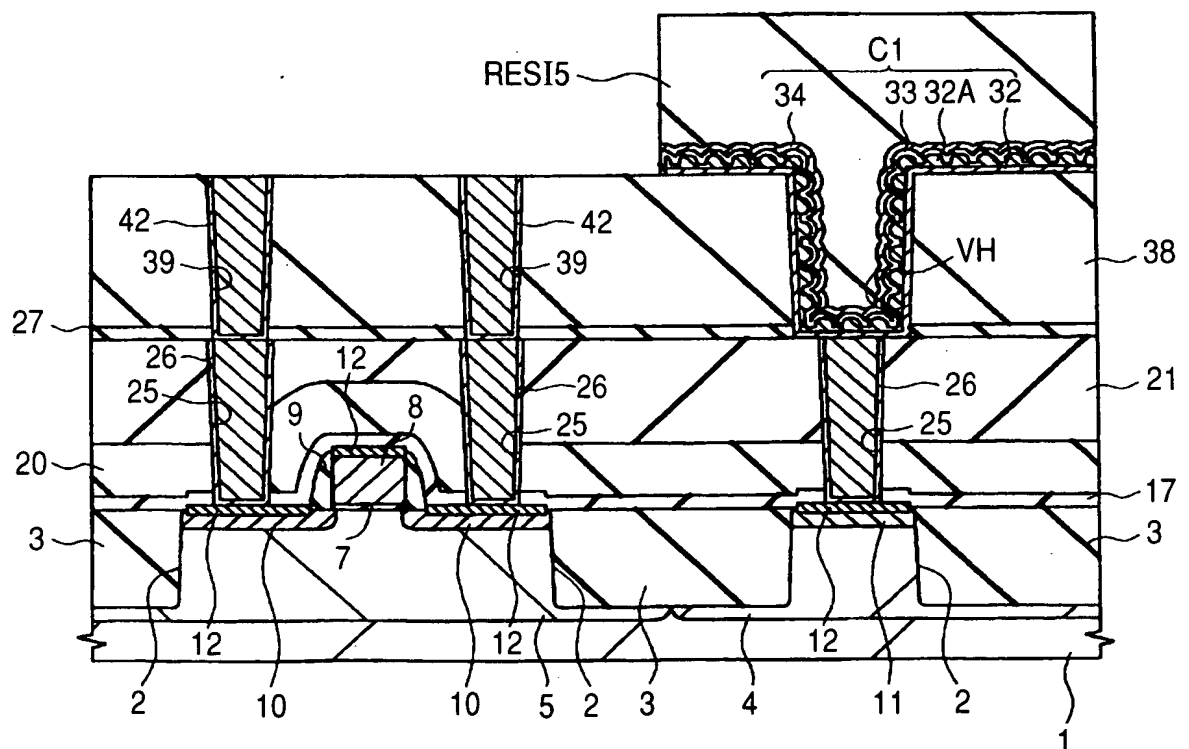


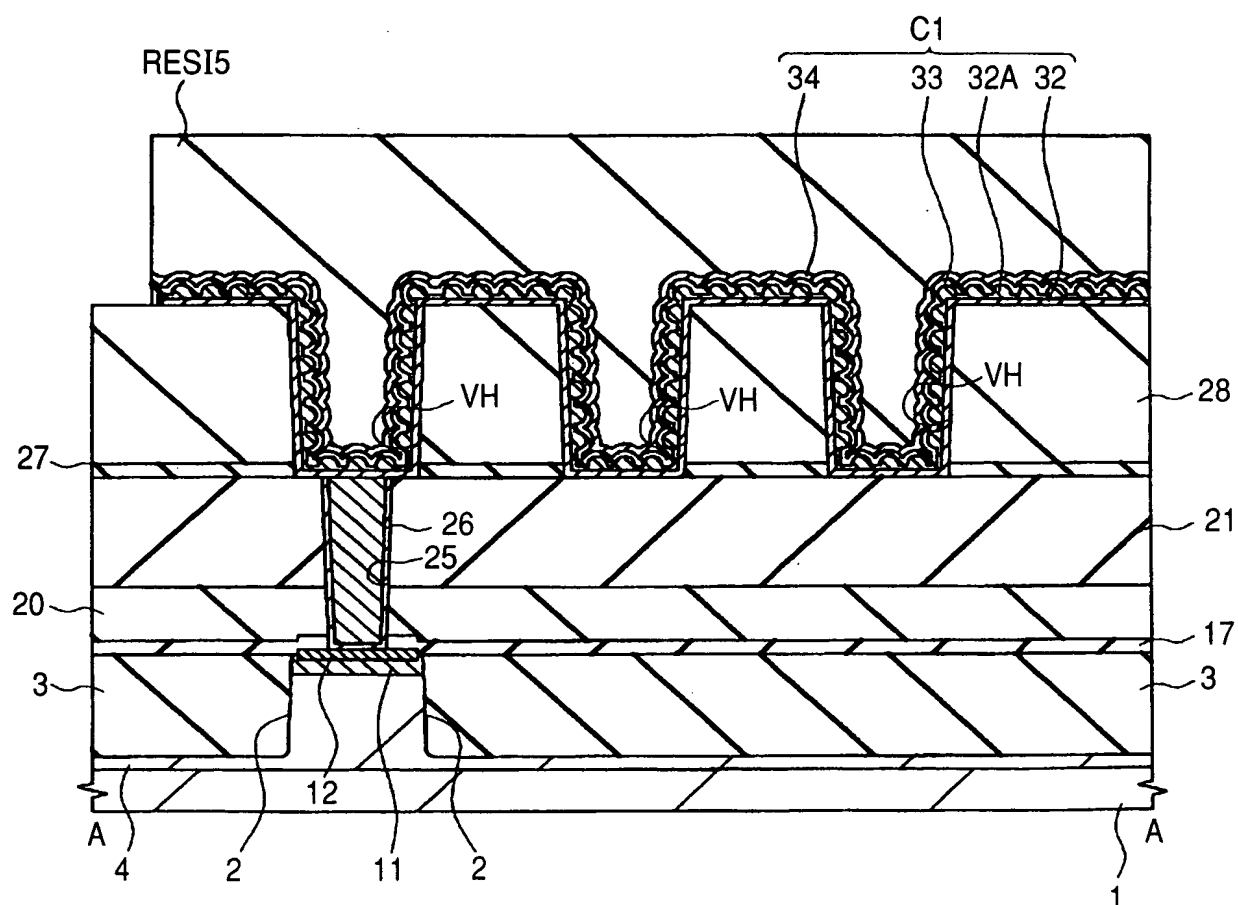
**FIG. 50**



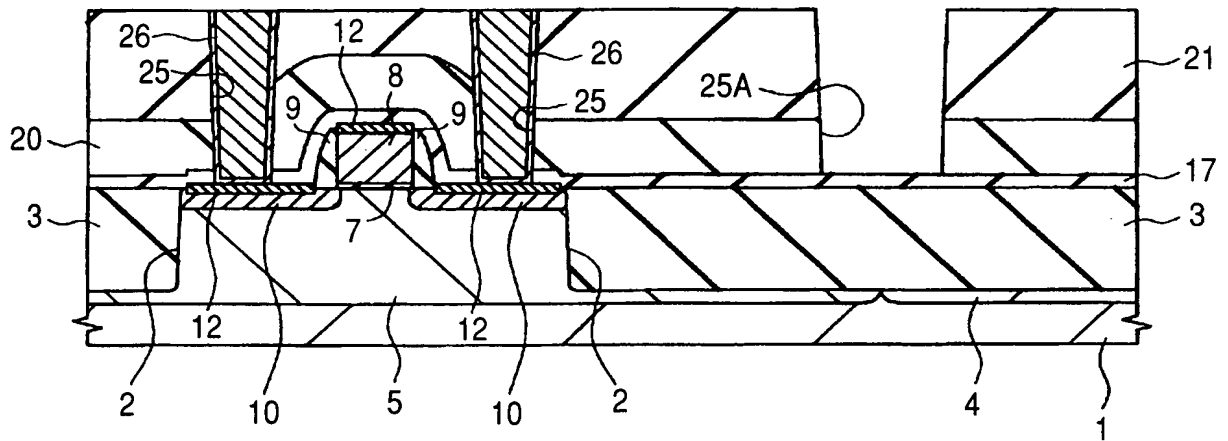
**FIG. 51**



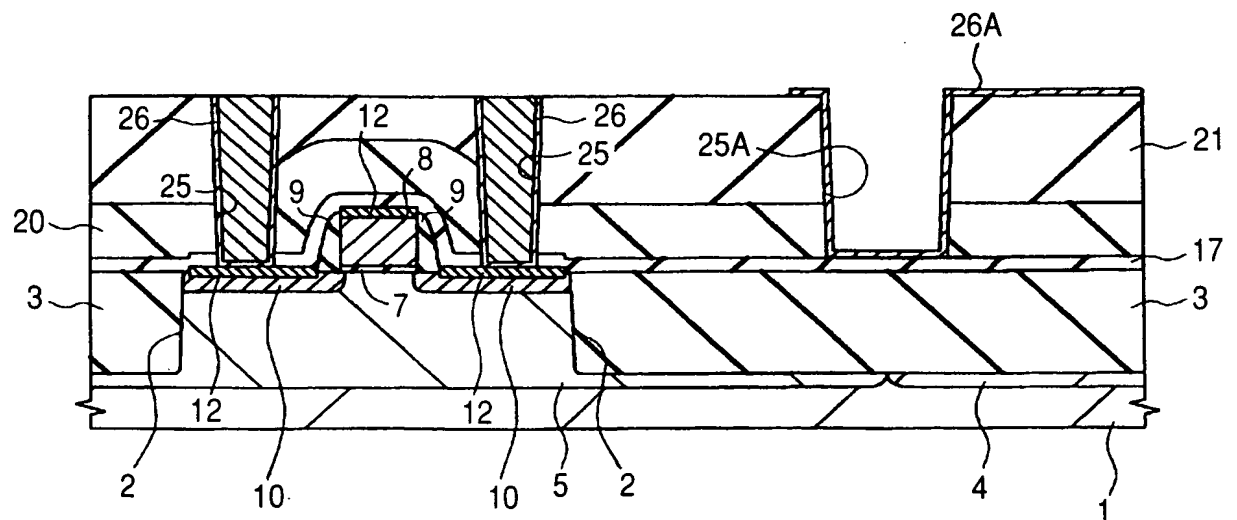
**FIG. 52****FIG. 53**



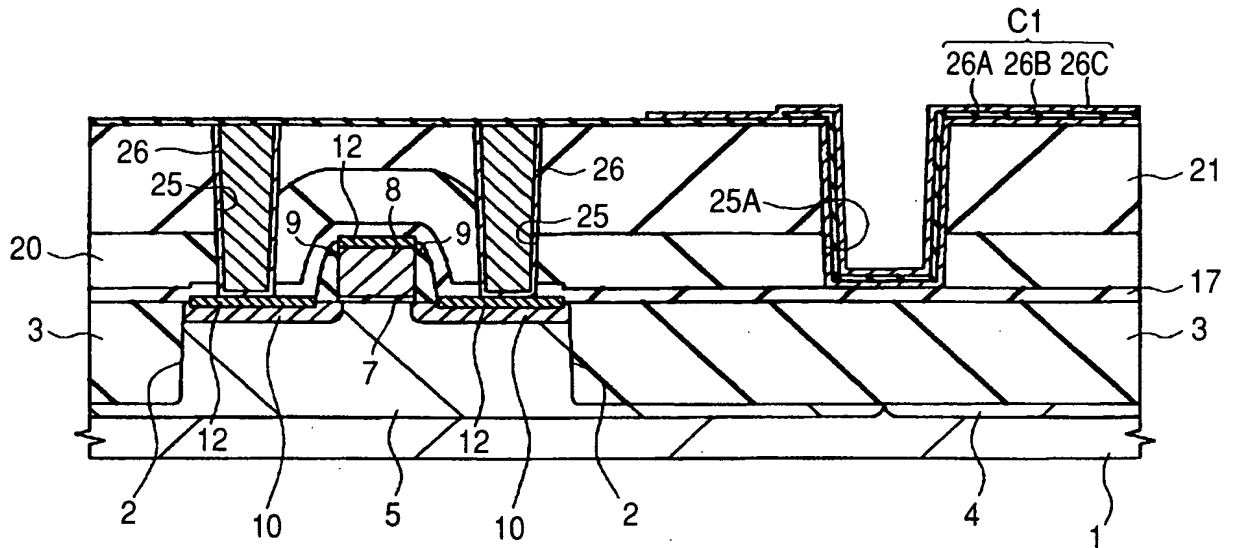
**FIG. 55**



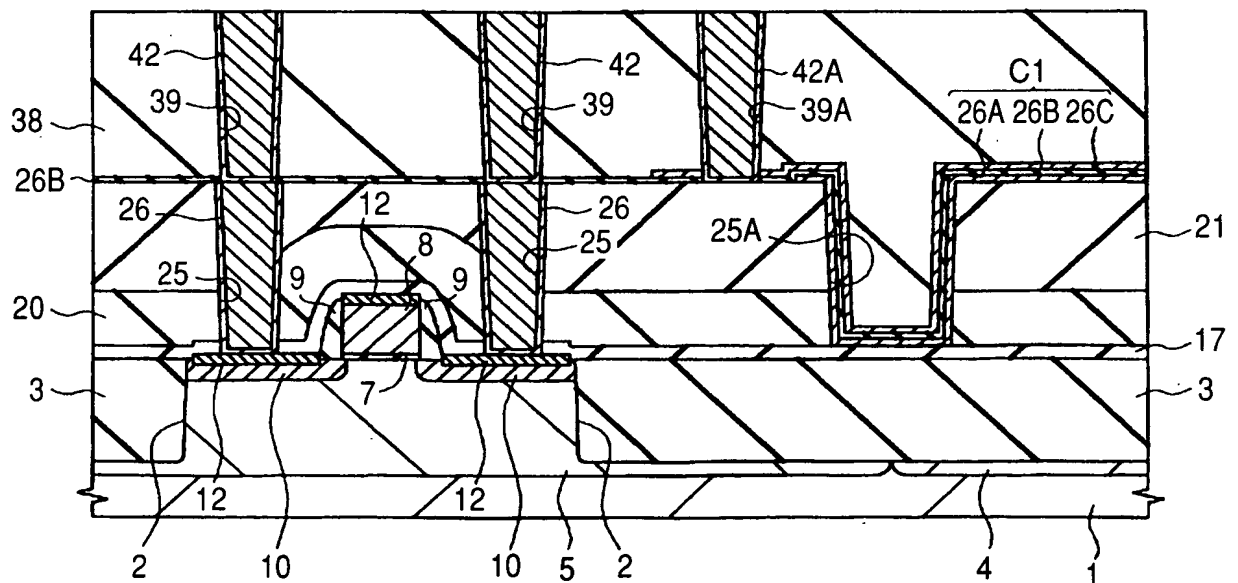
**FIG. 56**



**FIG. 57**



**FIG. 58**



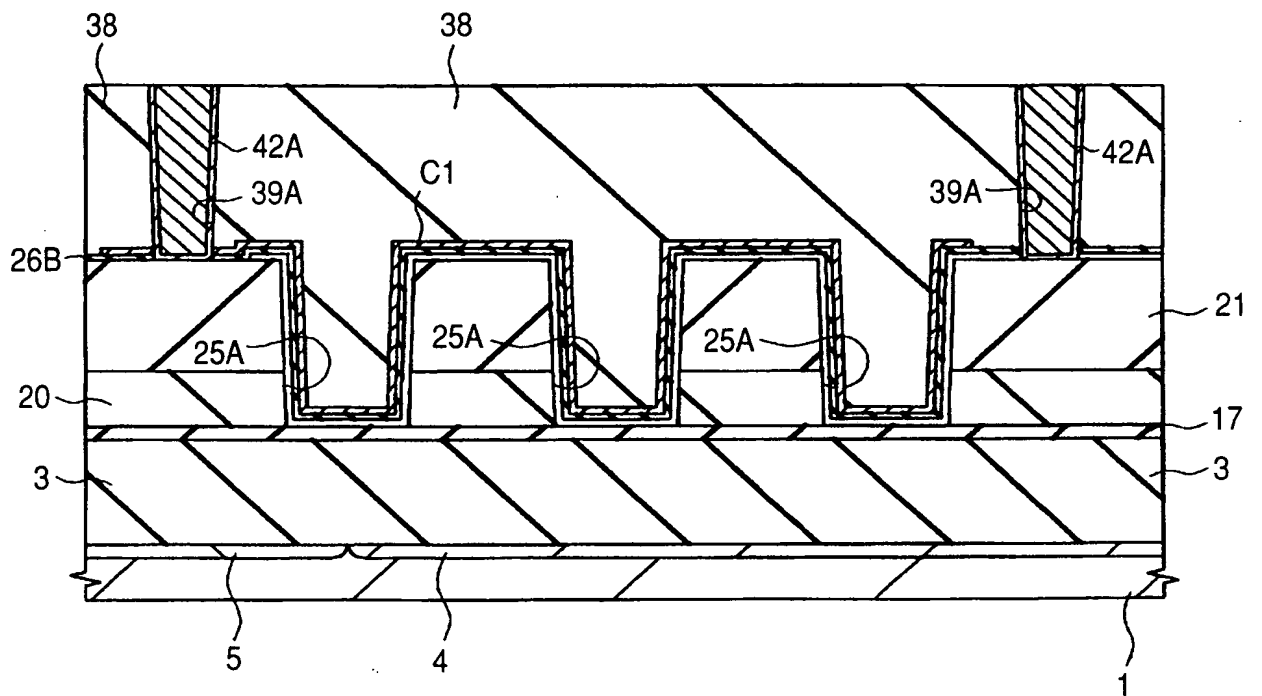
*FIG. 59*

FIG. 60

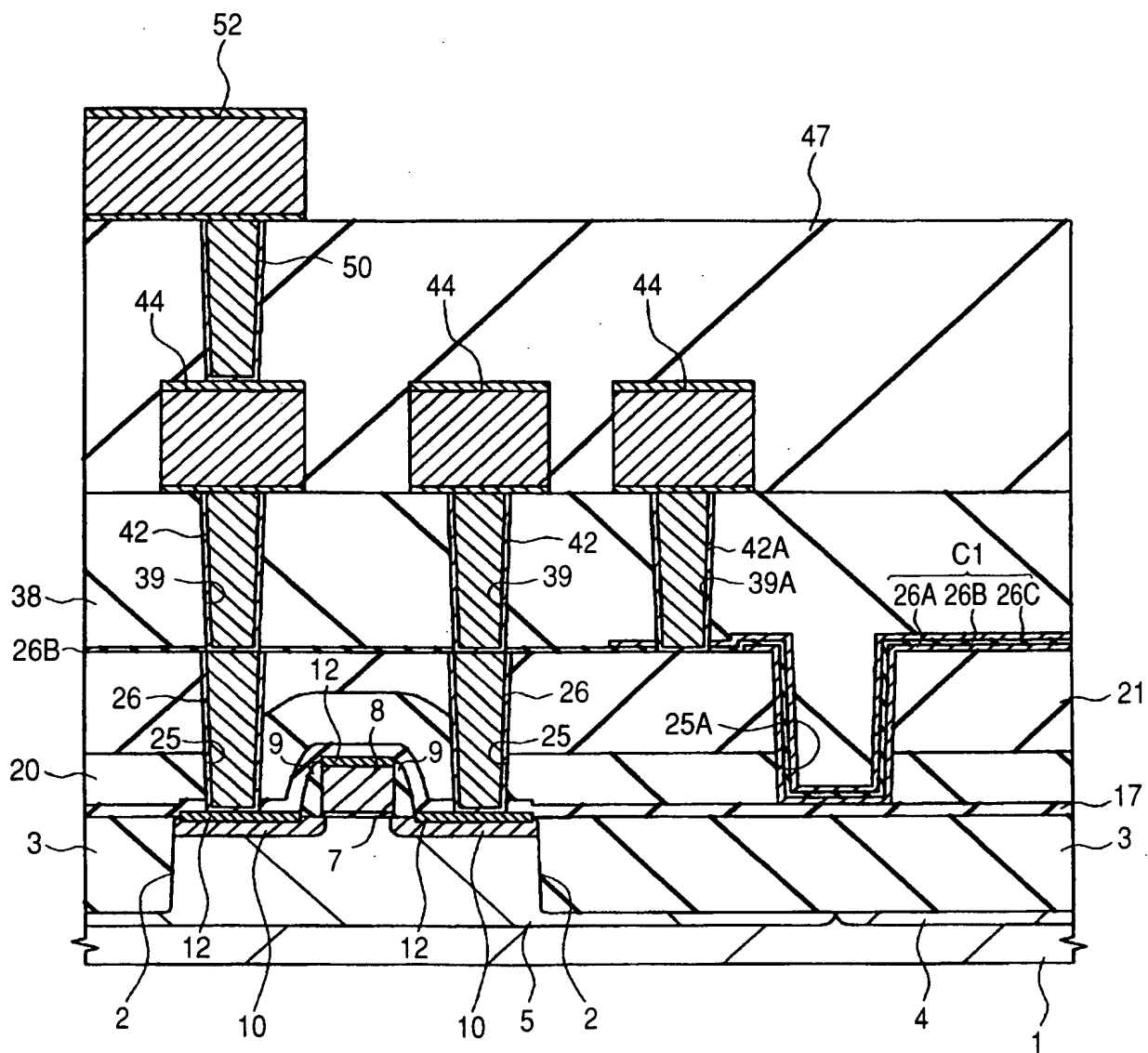




FIG. 61

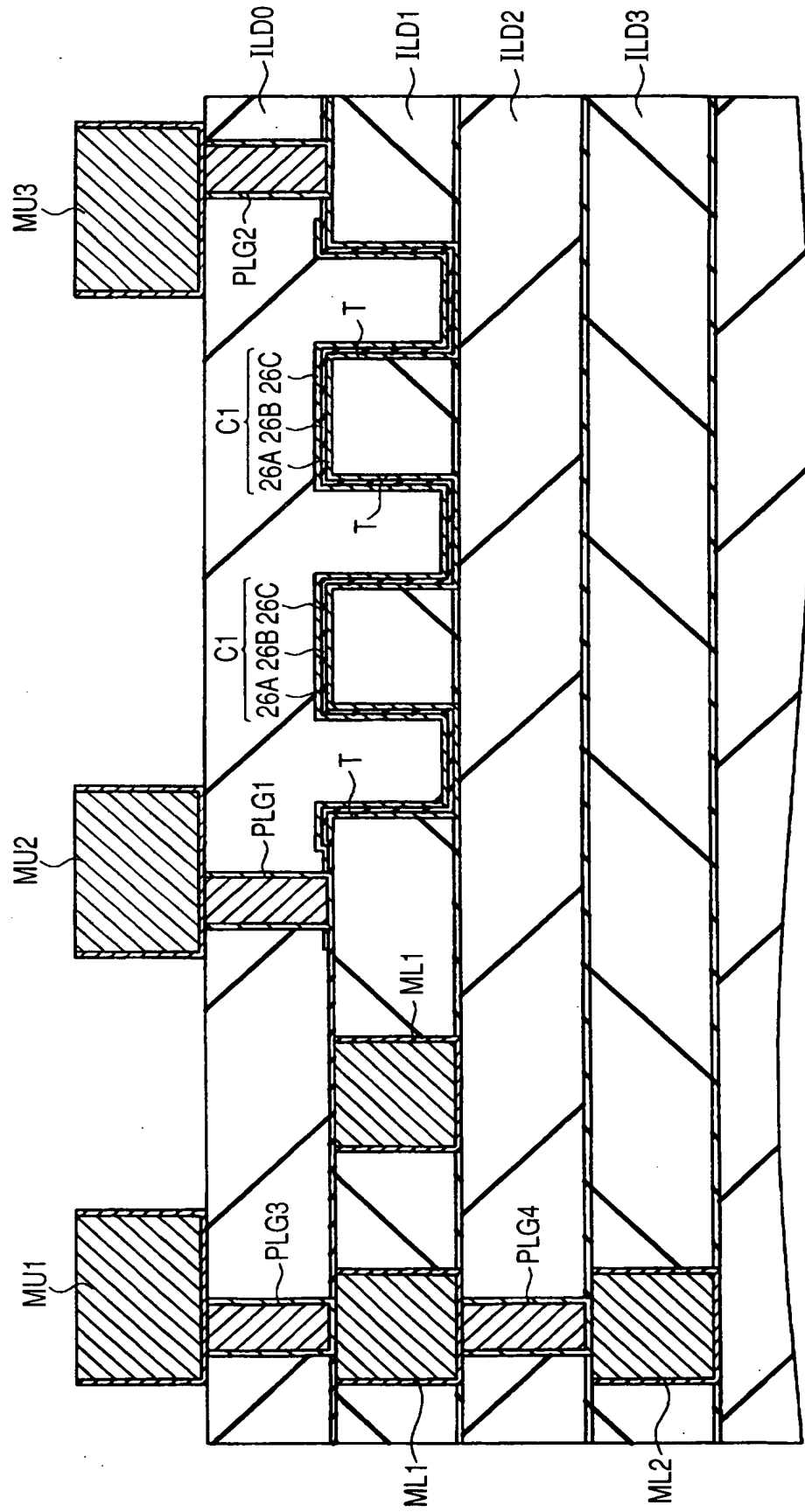
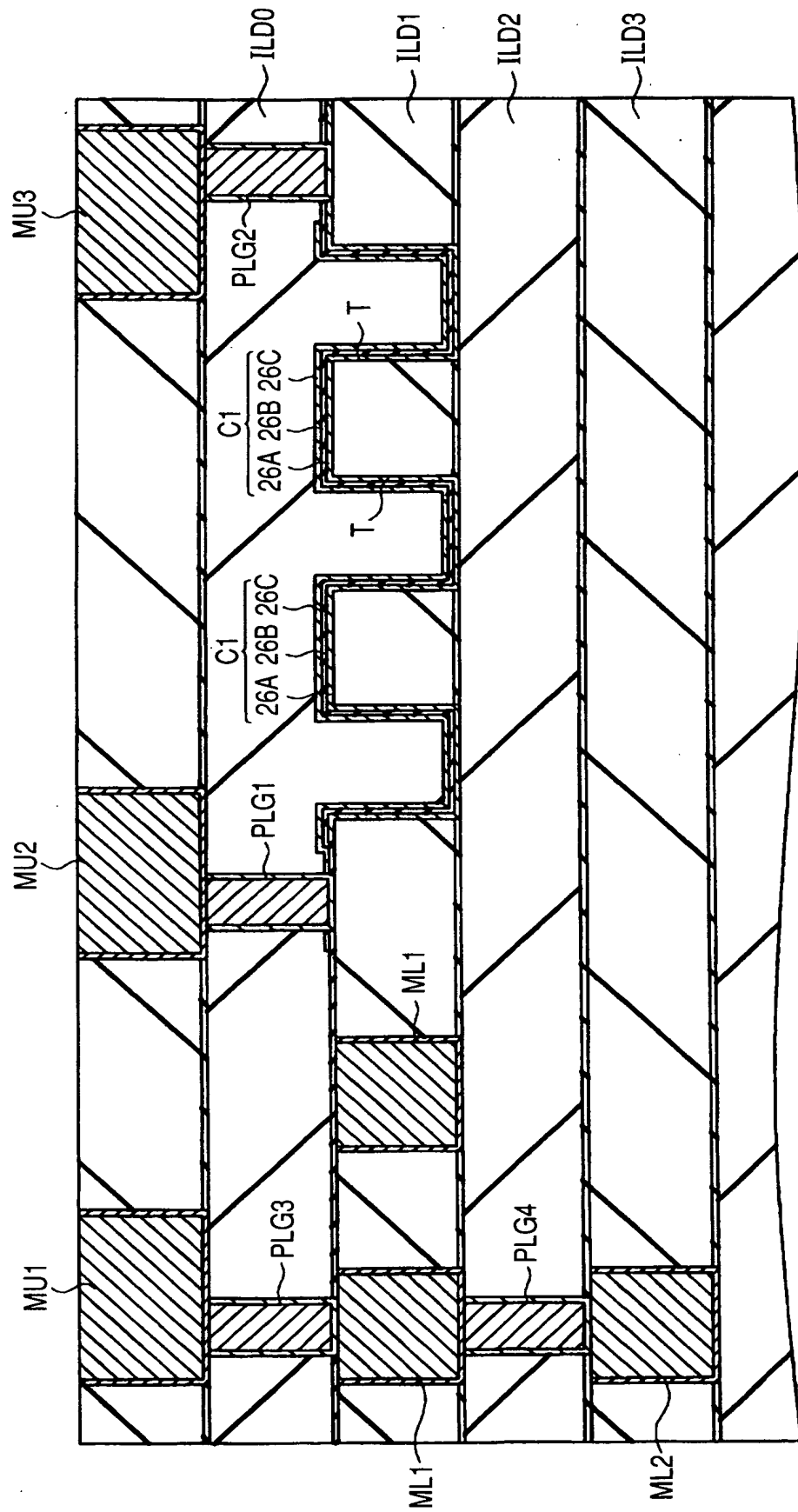
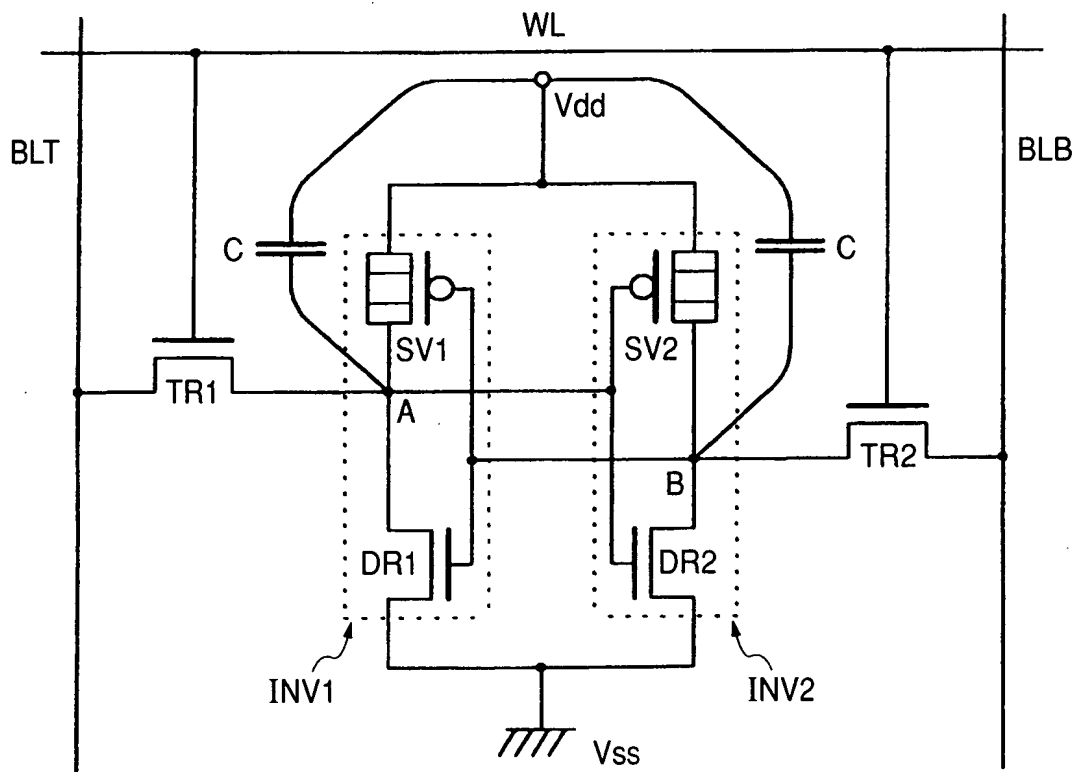
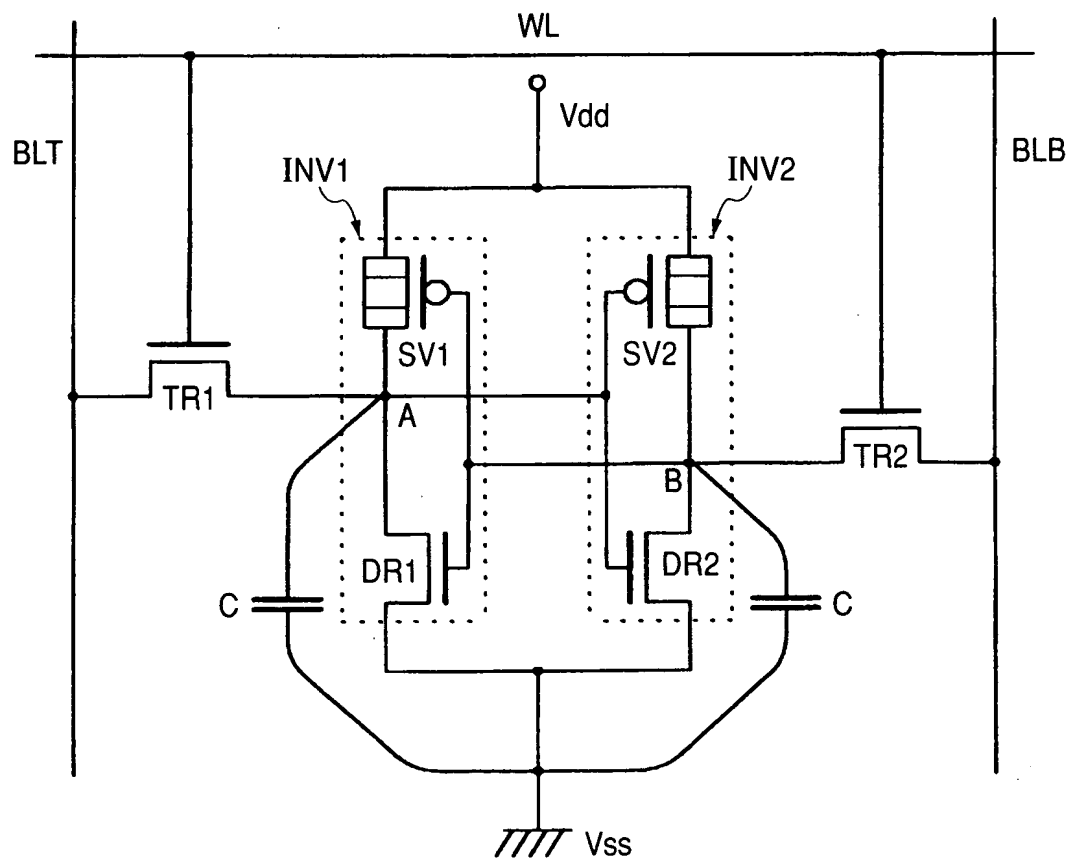


FIG. 62



*FIG. 63*

**FIG. 64**

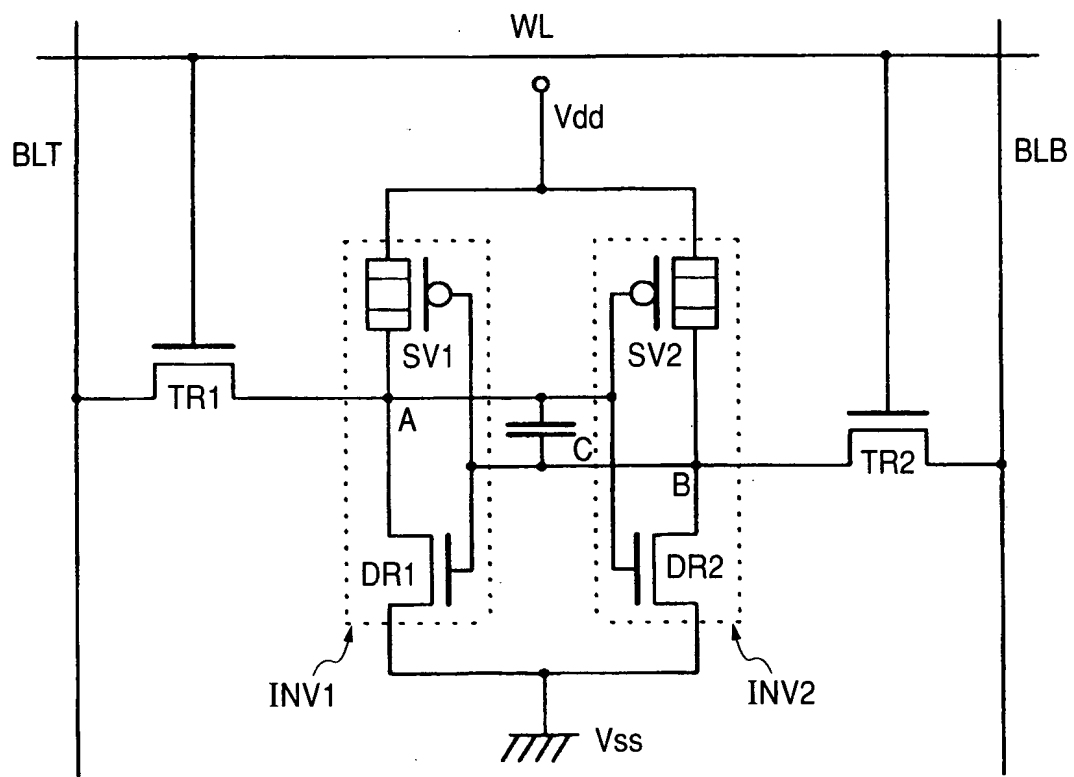
*FIG. 65*

FIG. 66

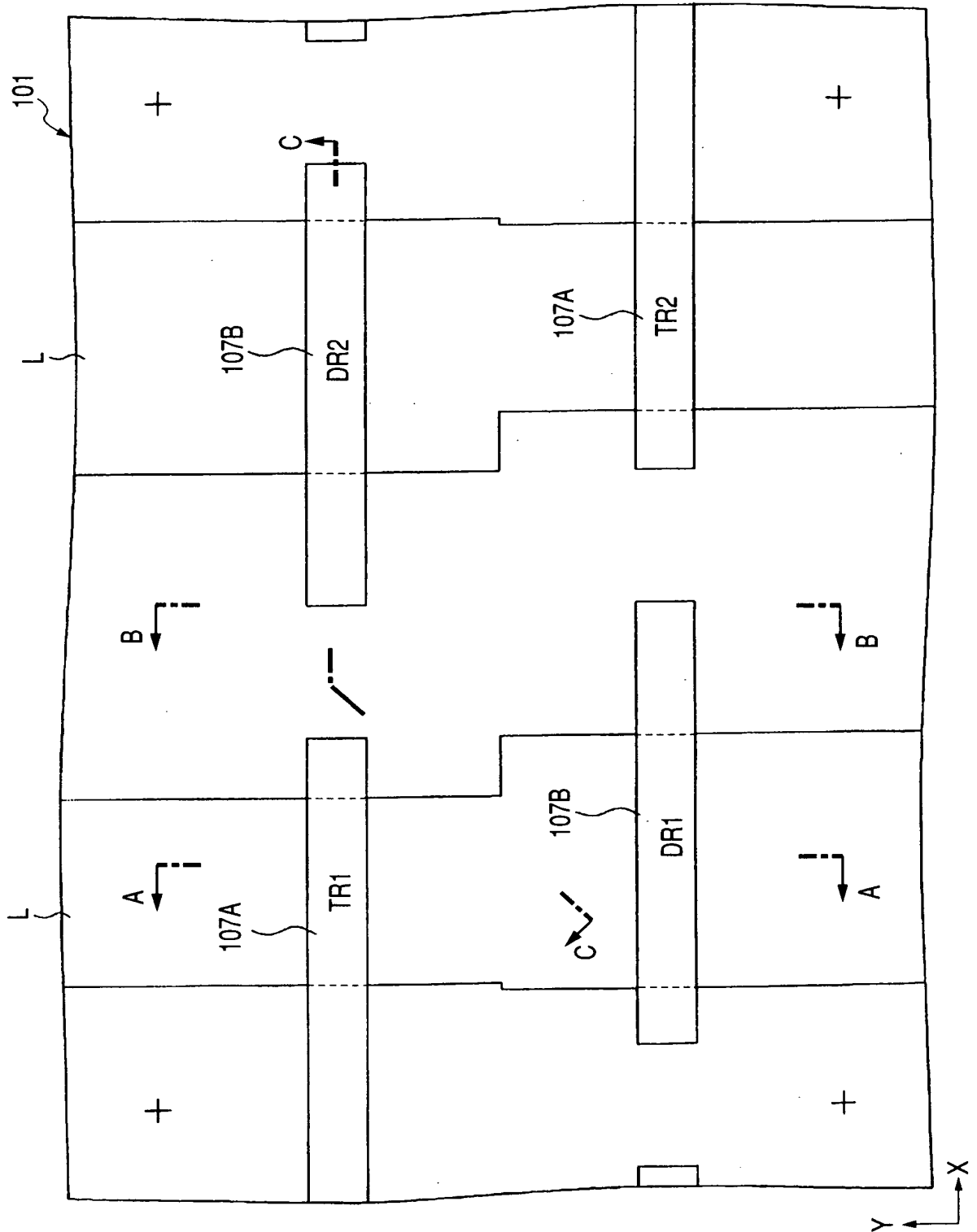


FIG. 67

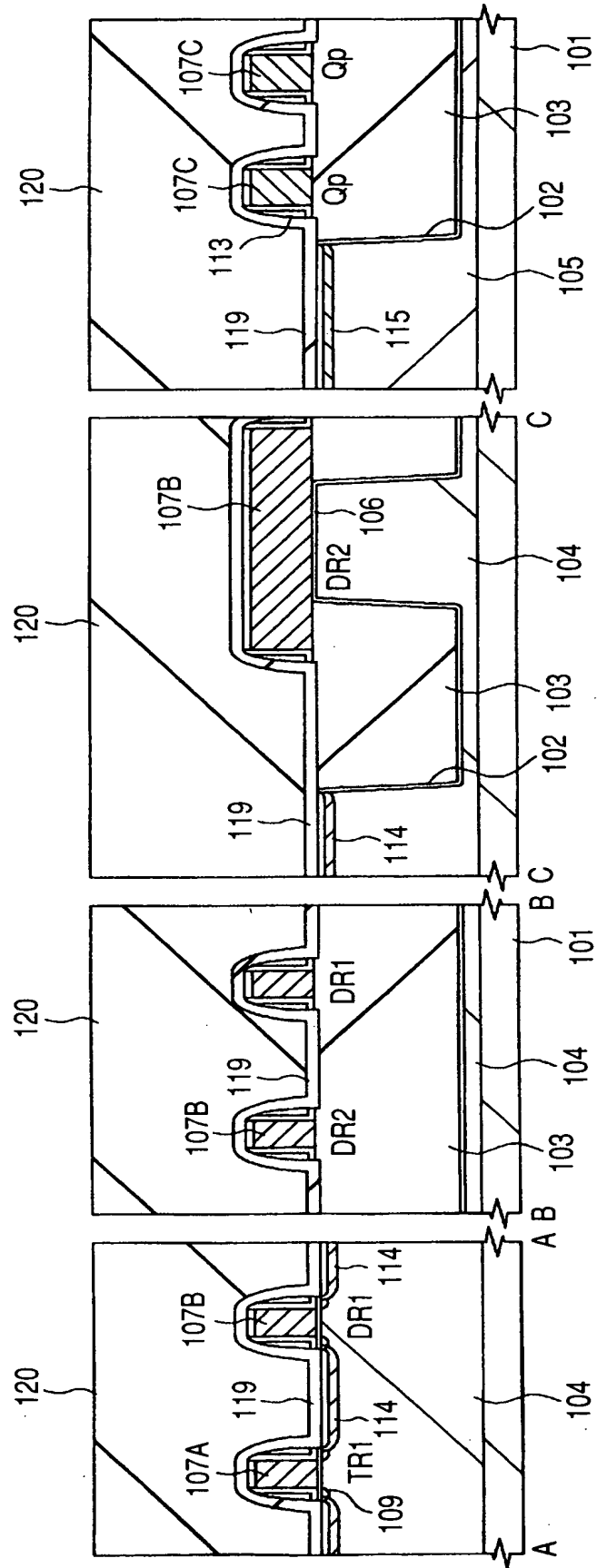






FIG. 69

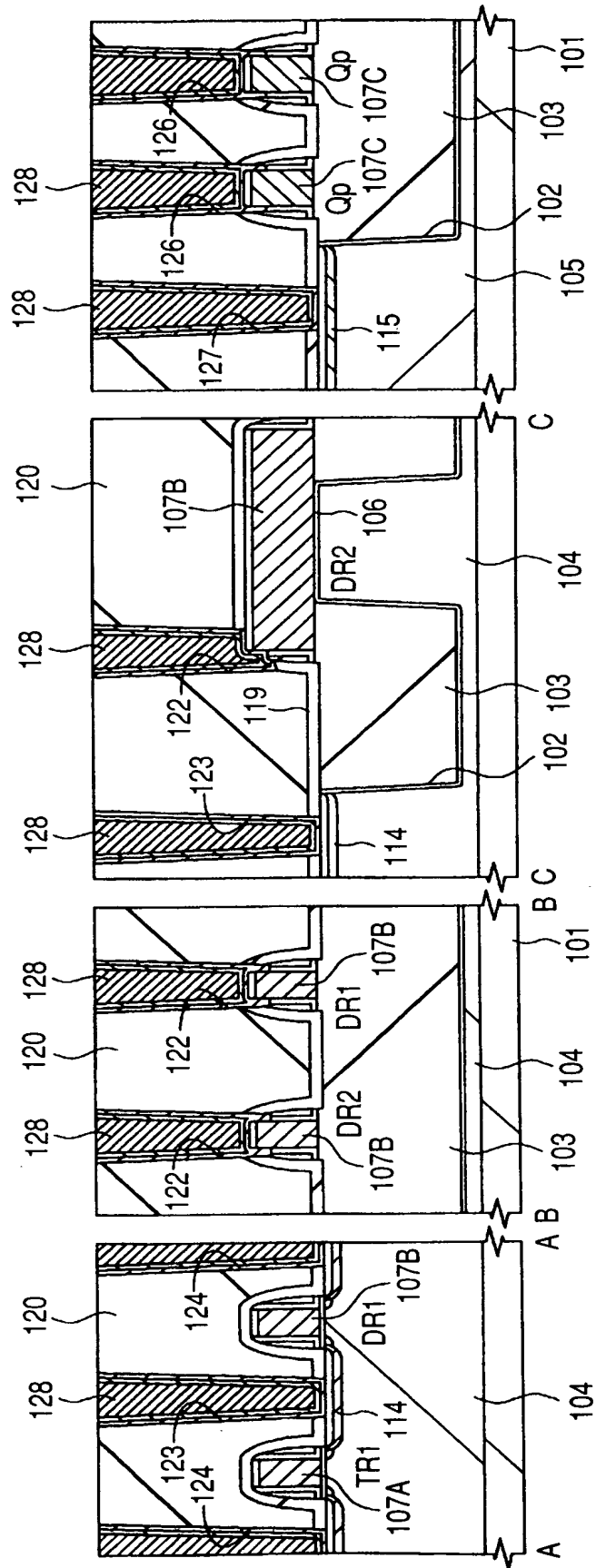






FIG. 72

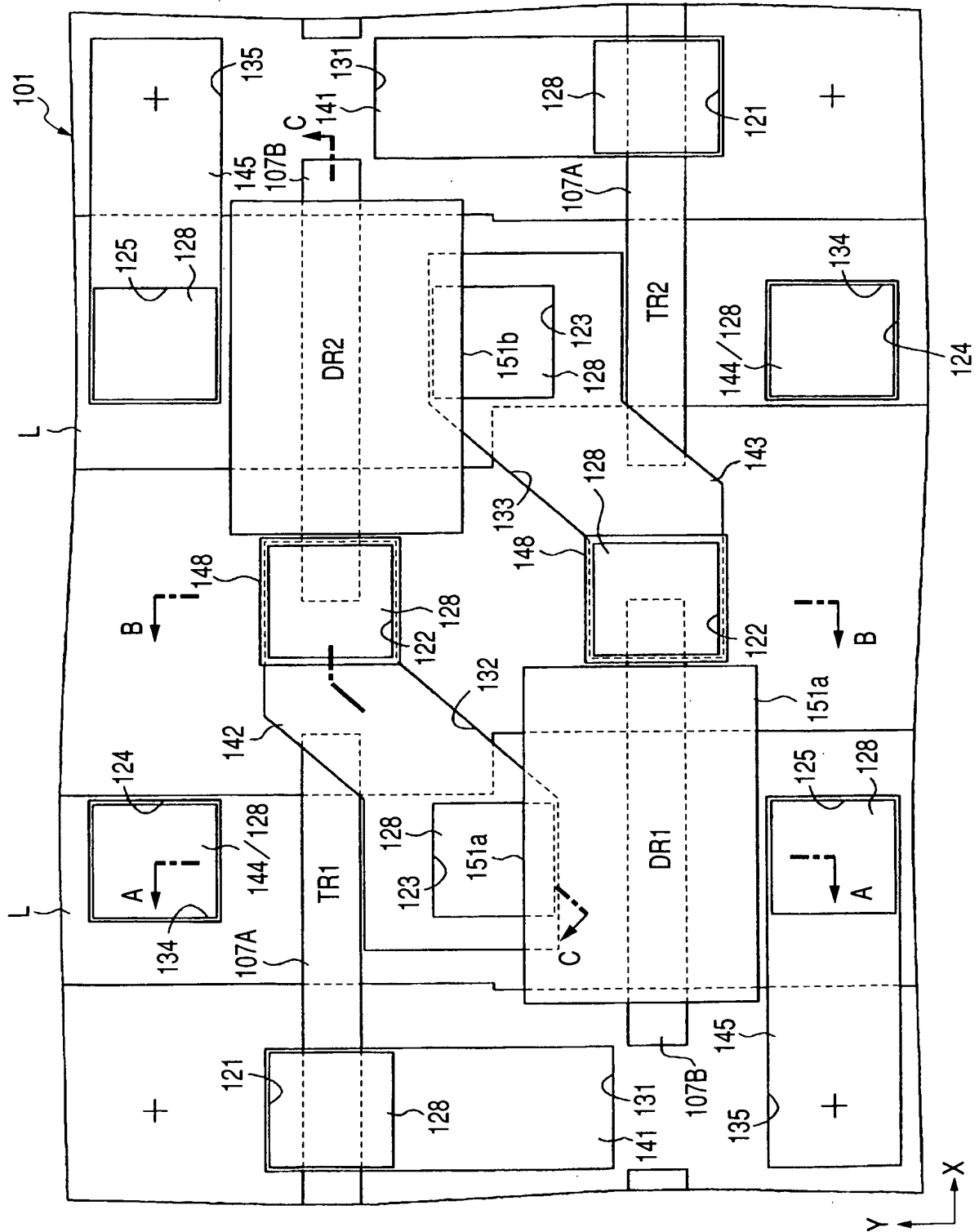






FIG. 75

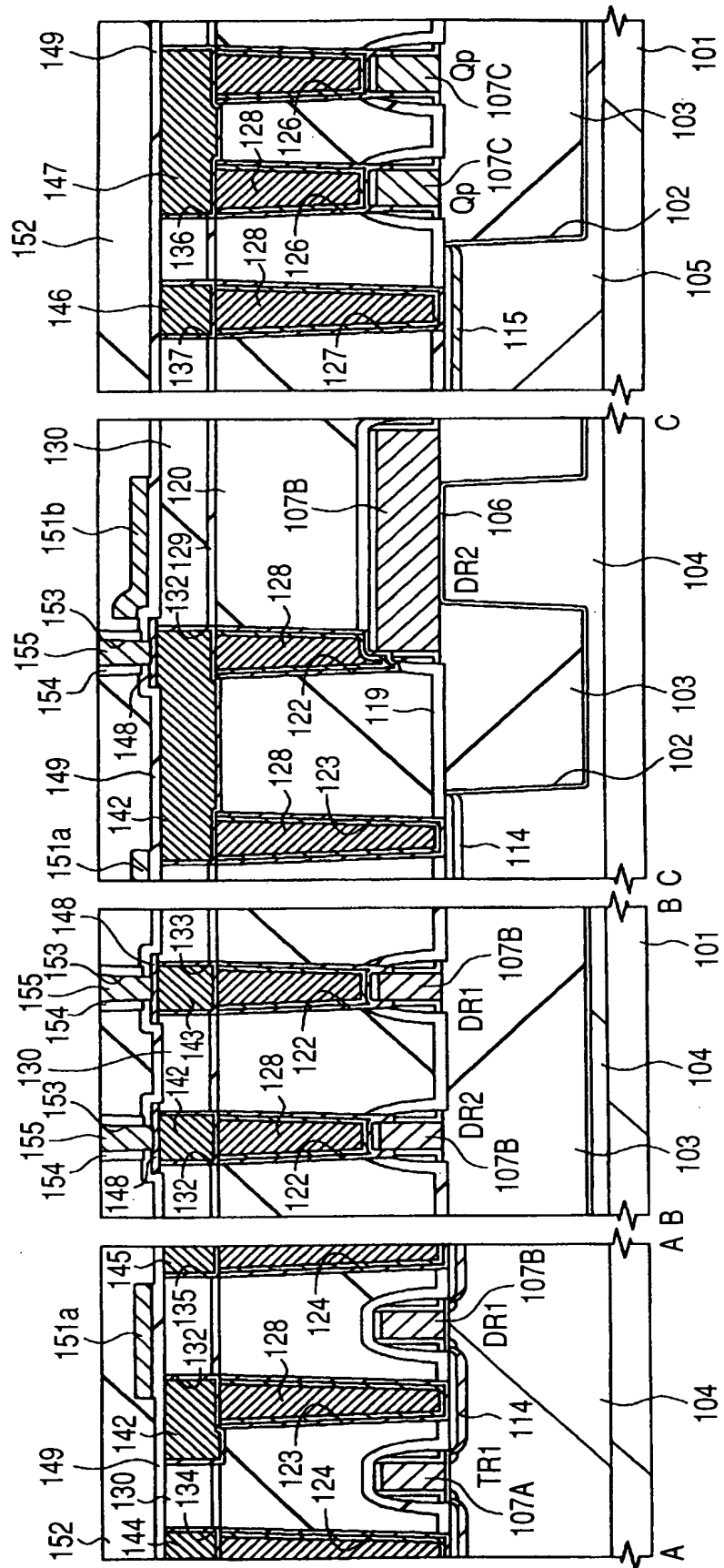






FIG. 77

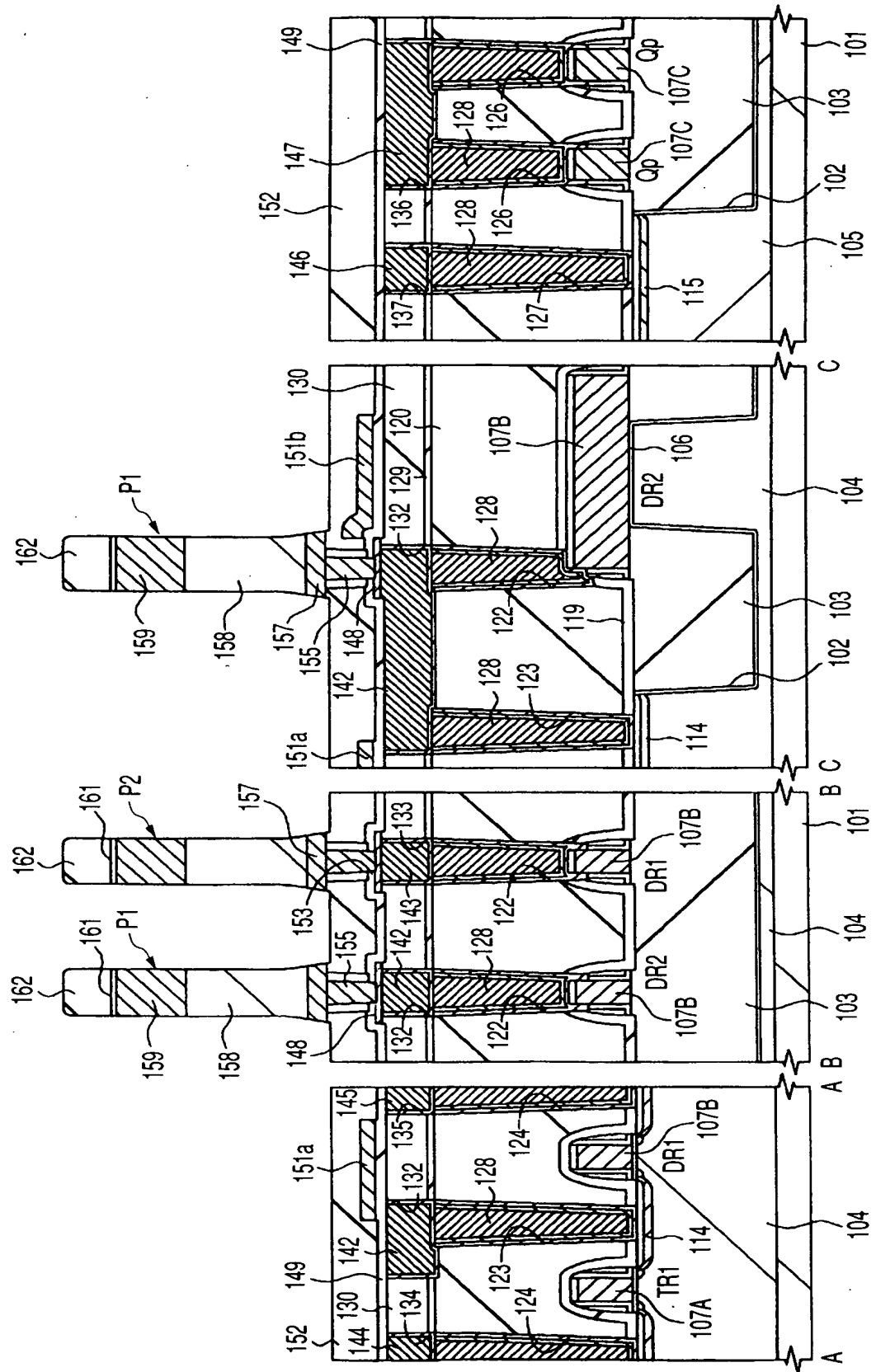


FIG. 78

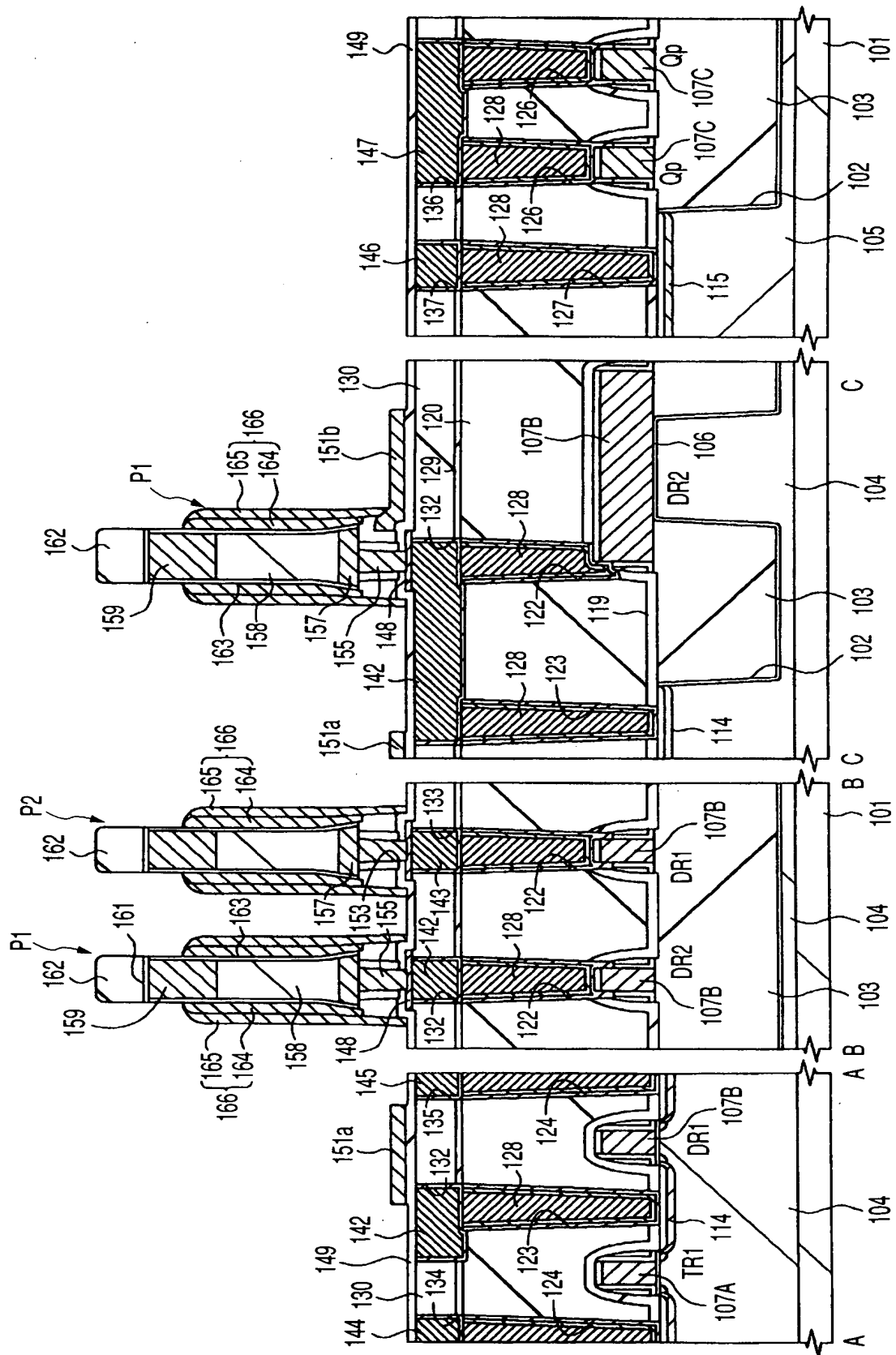


FIG. 79

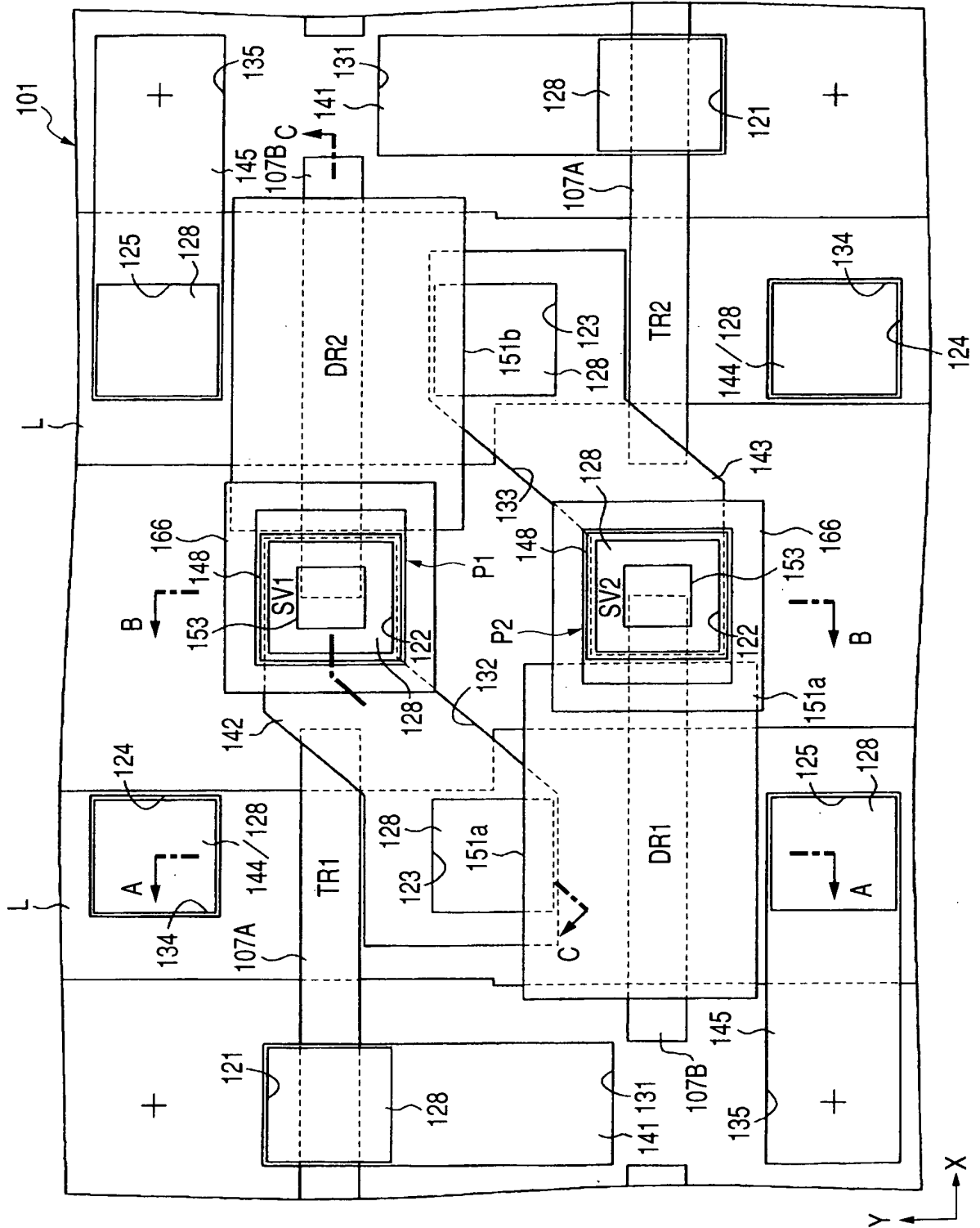
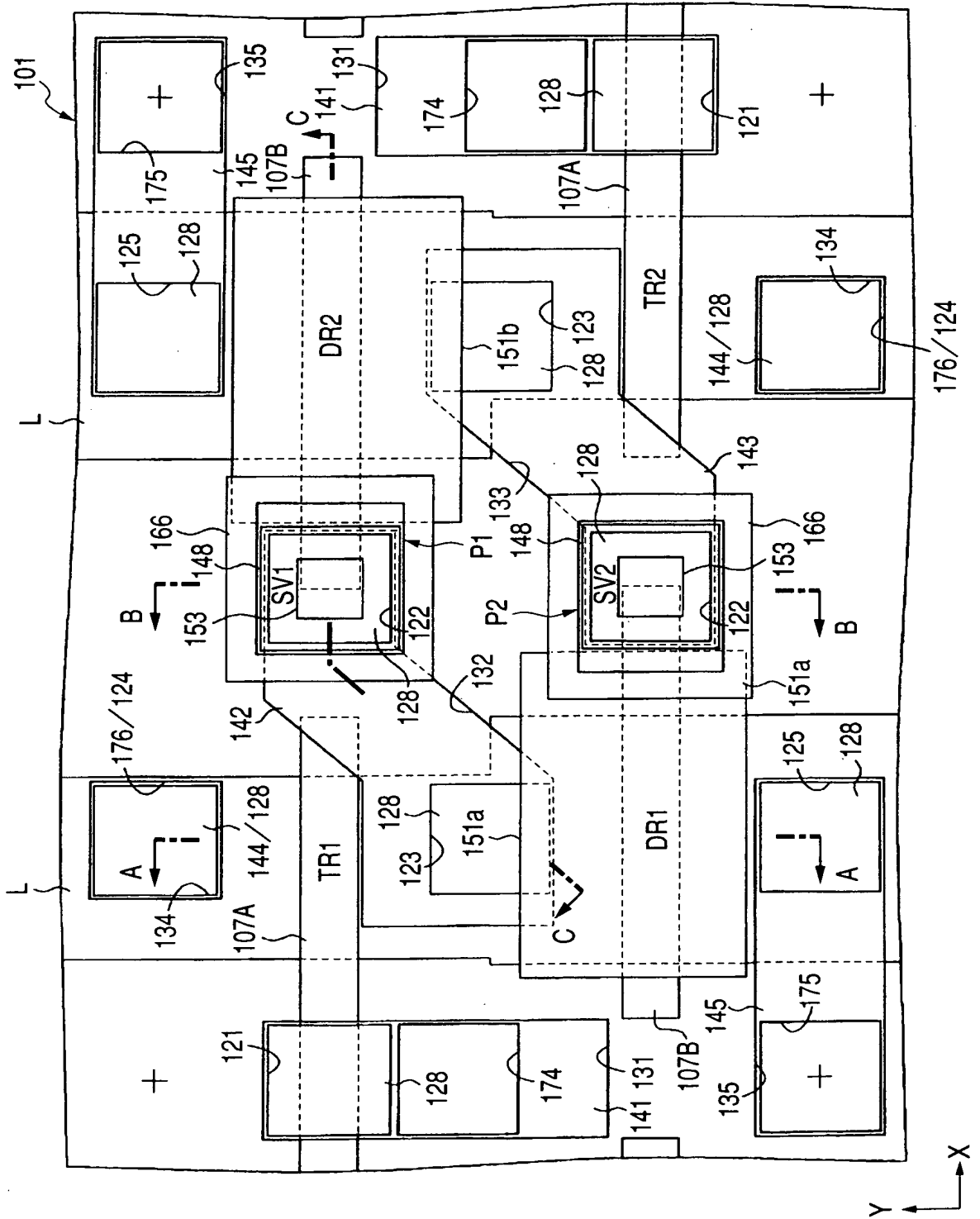






FIG. 82



**FIG. 83**

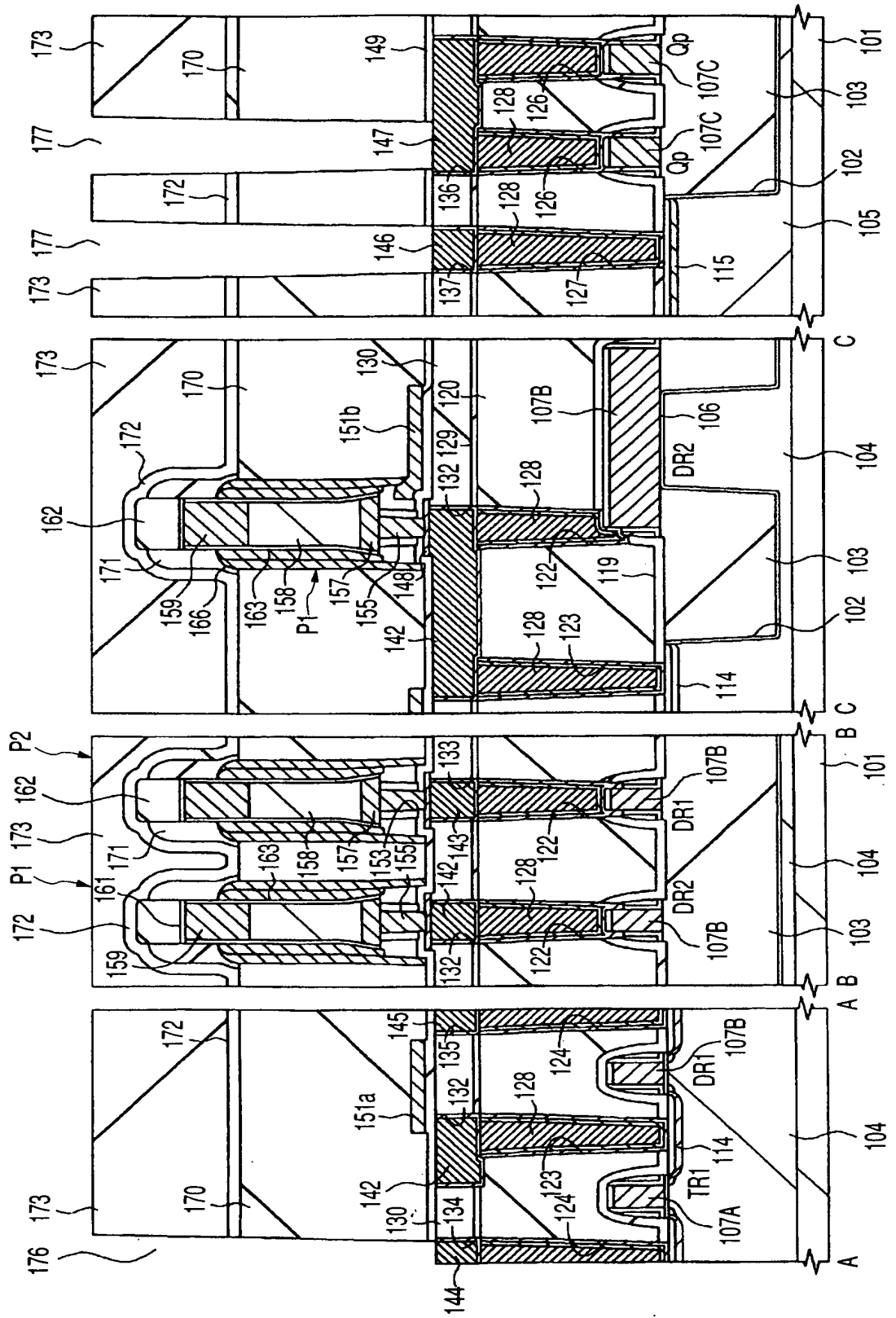


FIG. 84

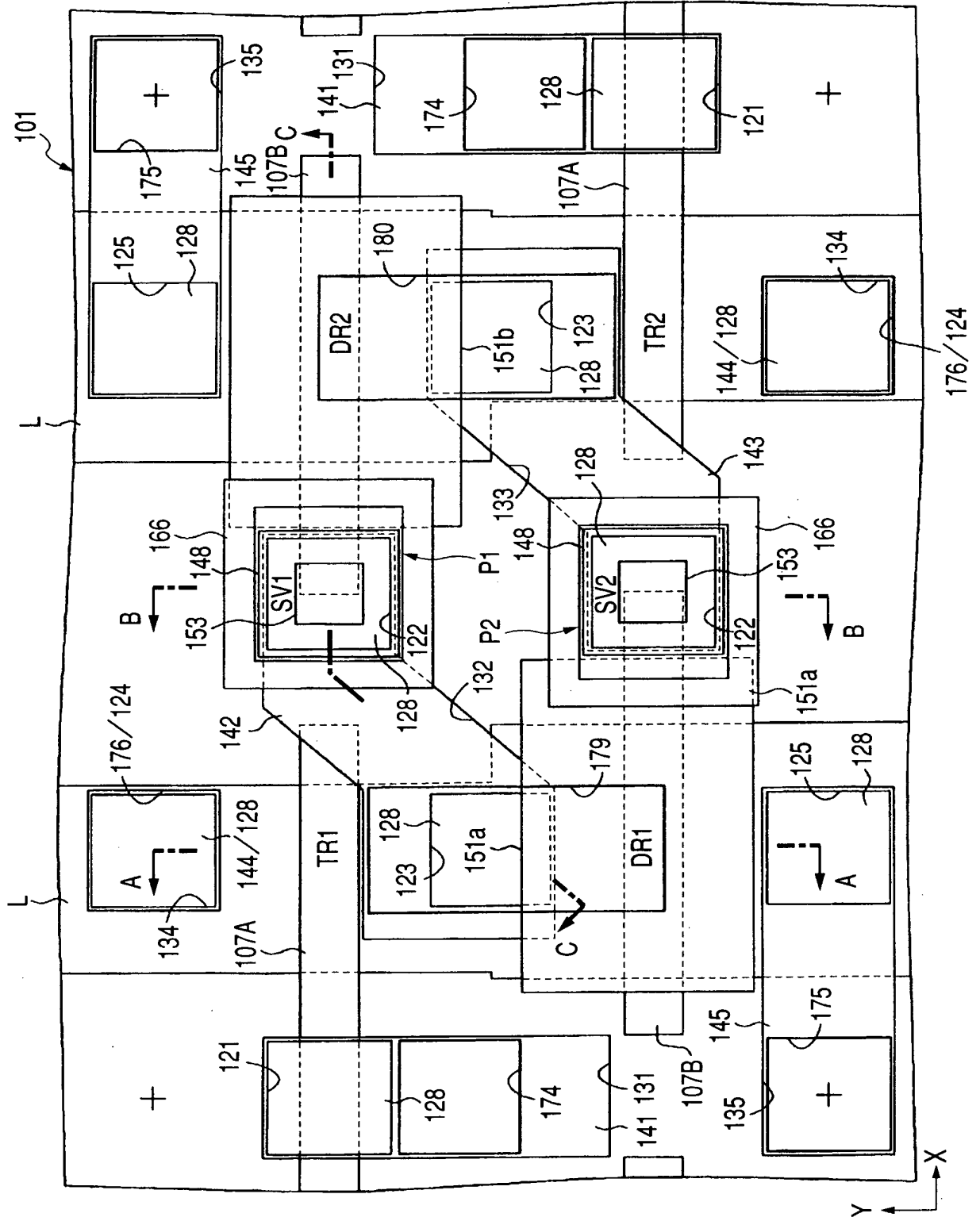




FIG. 85

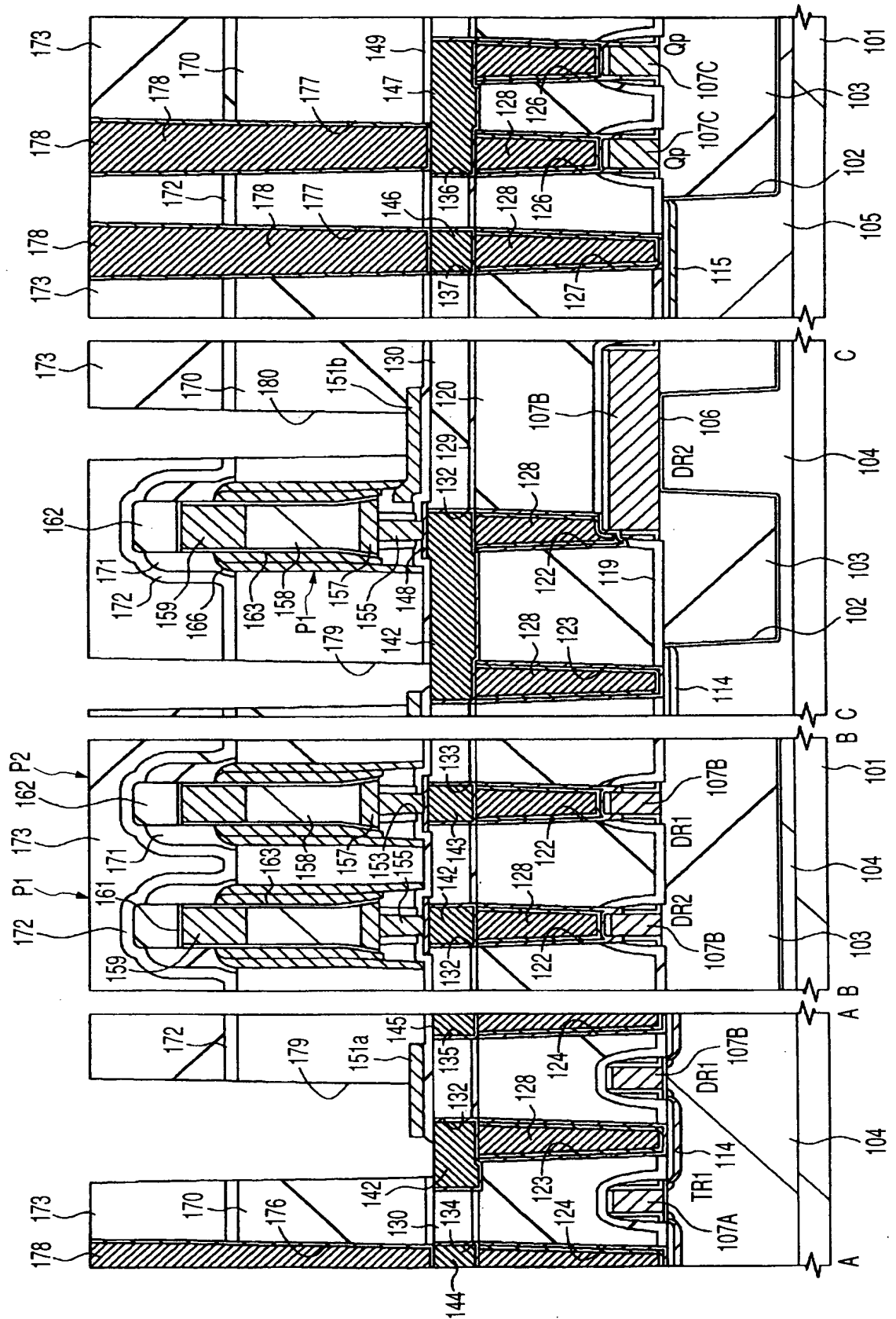
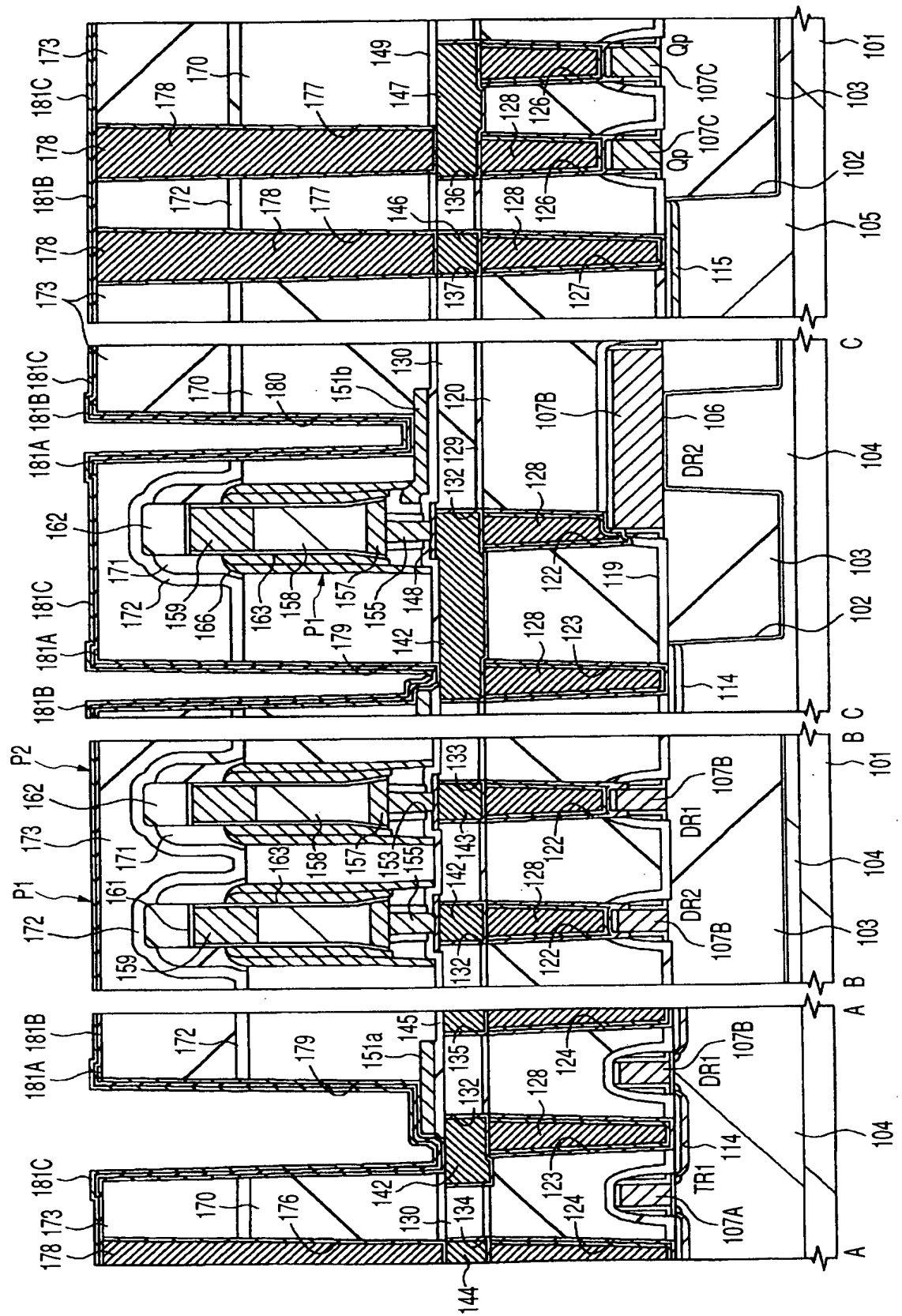




FIG. 87



**FIG. 88**

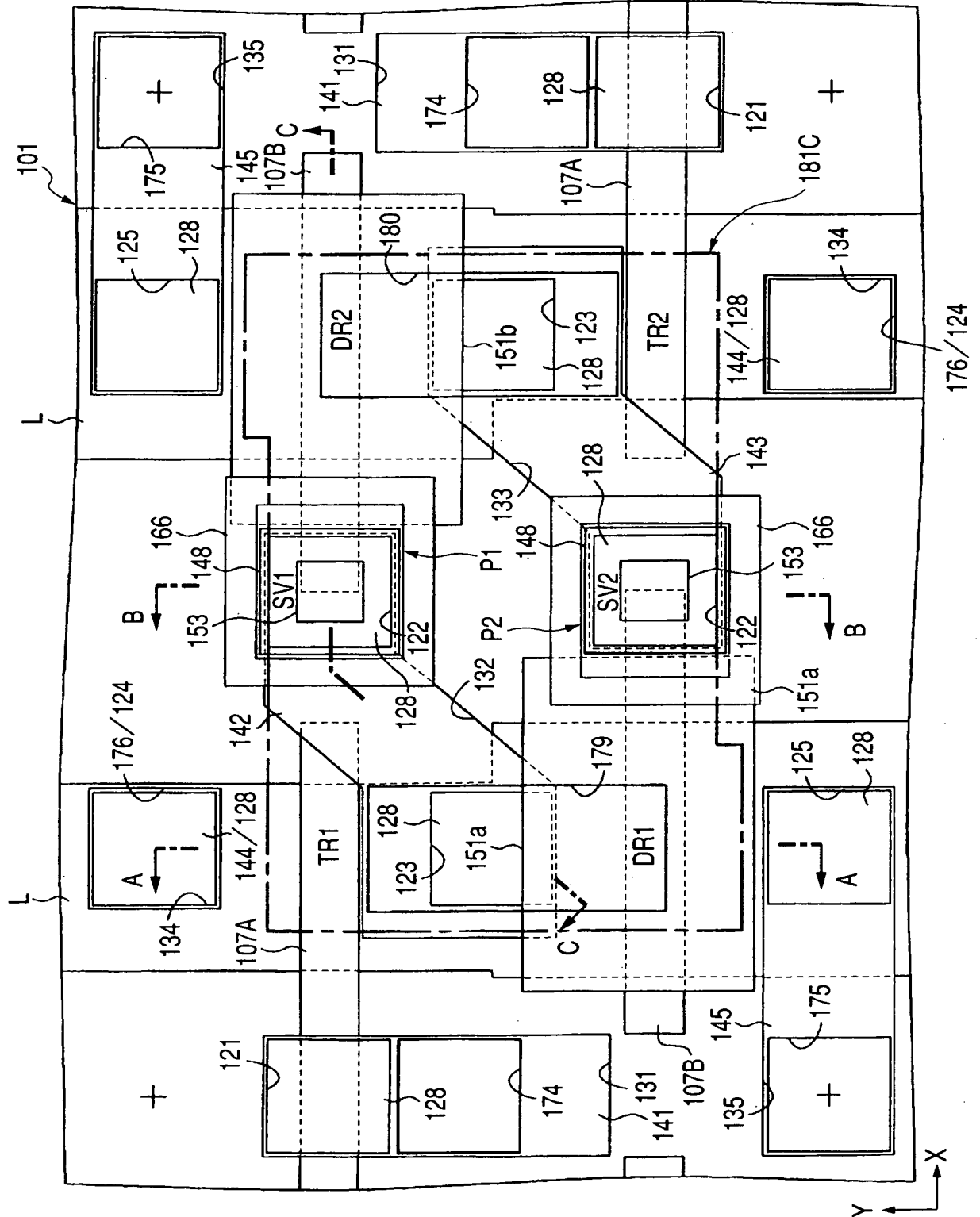
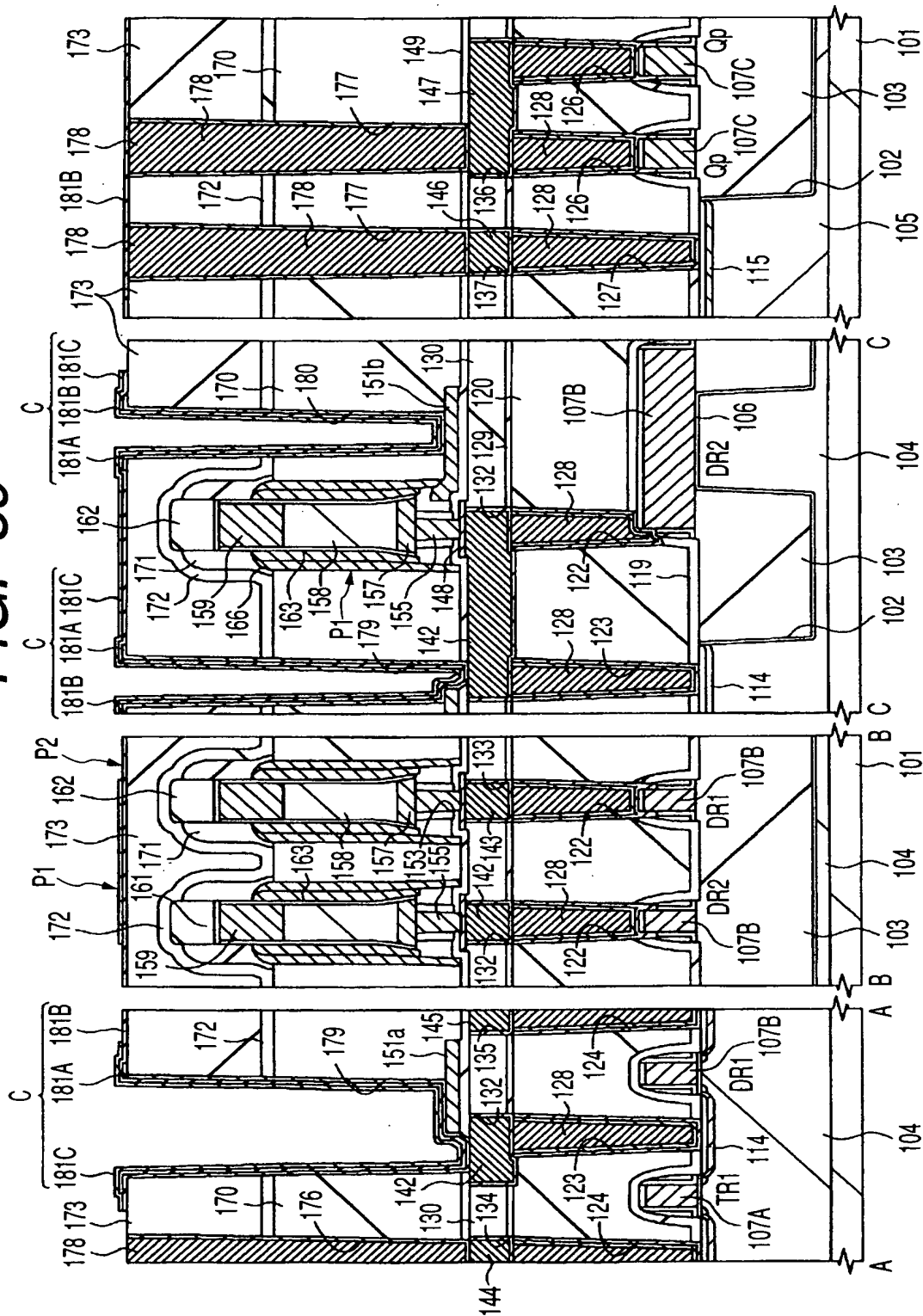


FIG. 89



- 170: SILICON OXIDE FILM (FIRST INSULATING FILM) 179, 180: THROUGH-HOLE (FIRST OPENING)  
 172: SILICON NITRIDE FILM (FIRST INSULATING FILM) 181A: TIN FILM (FIRST CONDUCTIVE FILM)  
 173: SILICON OXIDE FILM (FIRST INSULATING FILM) 181B: SILICON NITRIDE FILM (SECOND INSULATING FILM)  
 181C: TIN FILM (SECOND CONDUCTIVE FILM)  
 C: CAPACITIVE ELEMENT  
 C: CAPACITIVE ELEMENT (FIRST CAPACITIVE ELEMENT)





FIG. 92

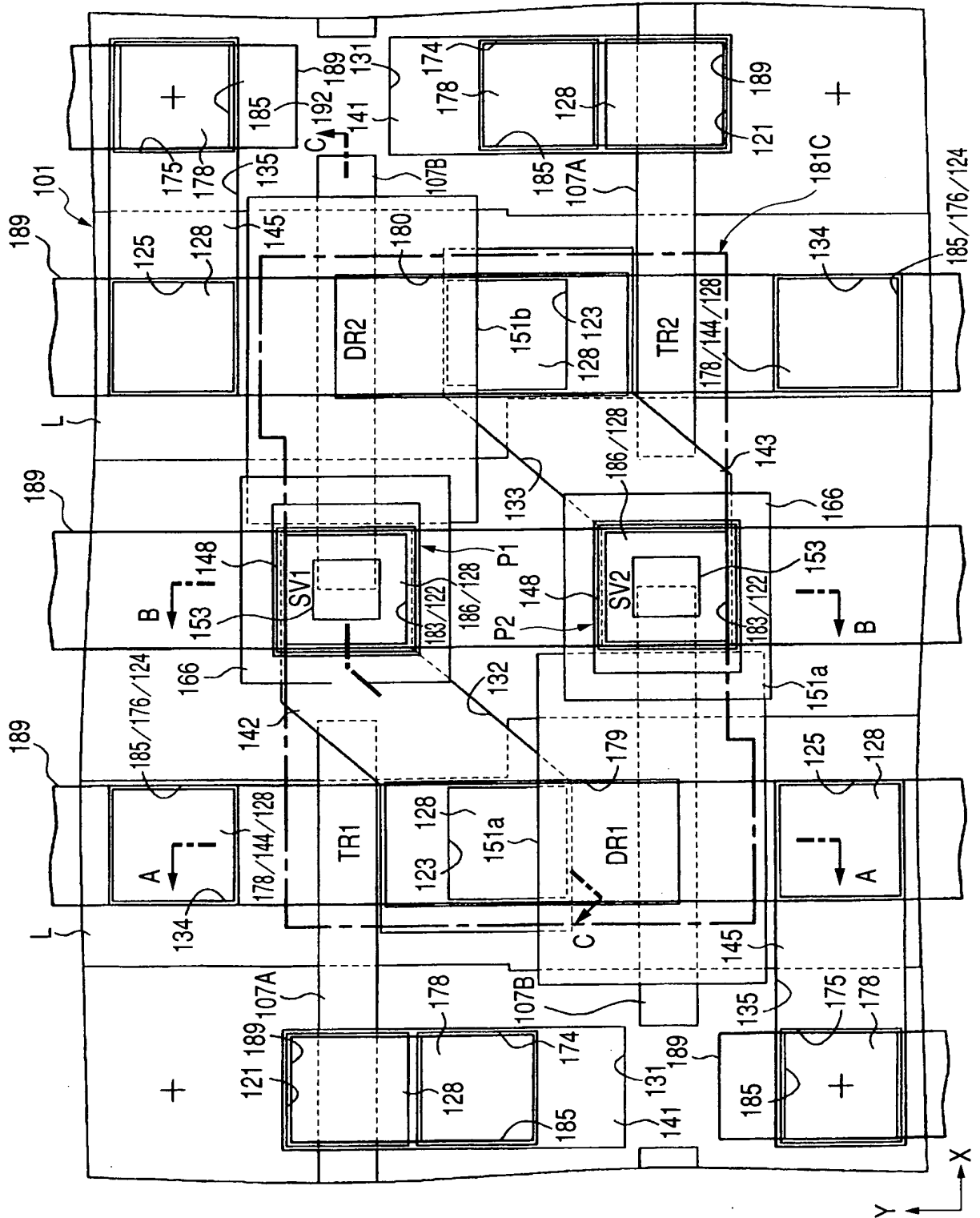




FIG. 93

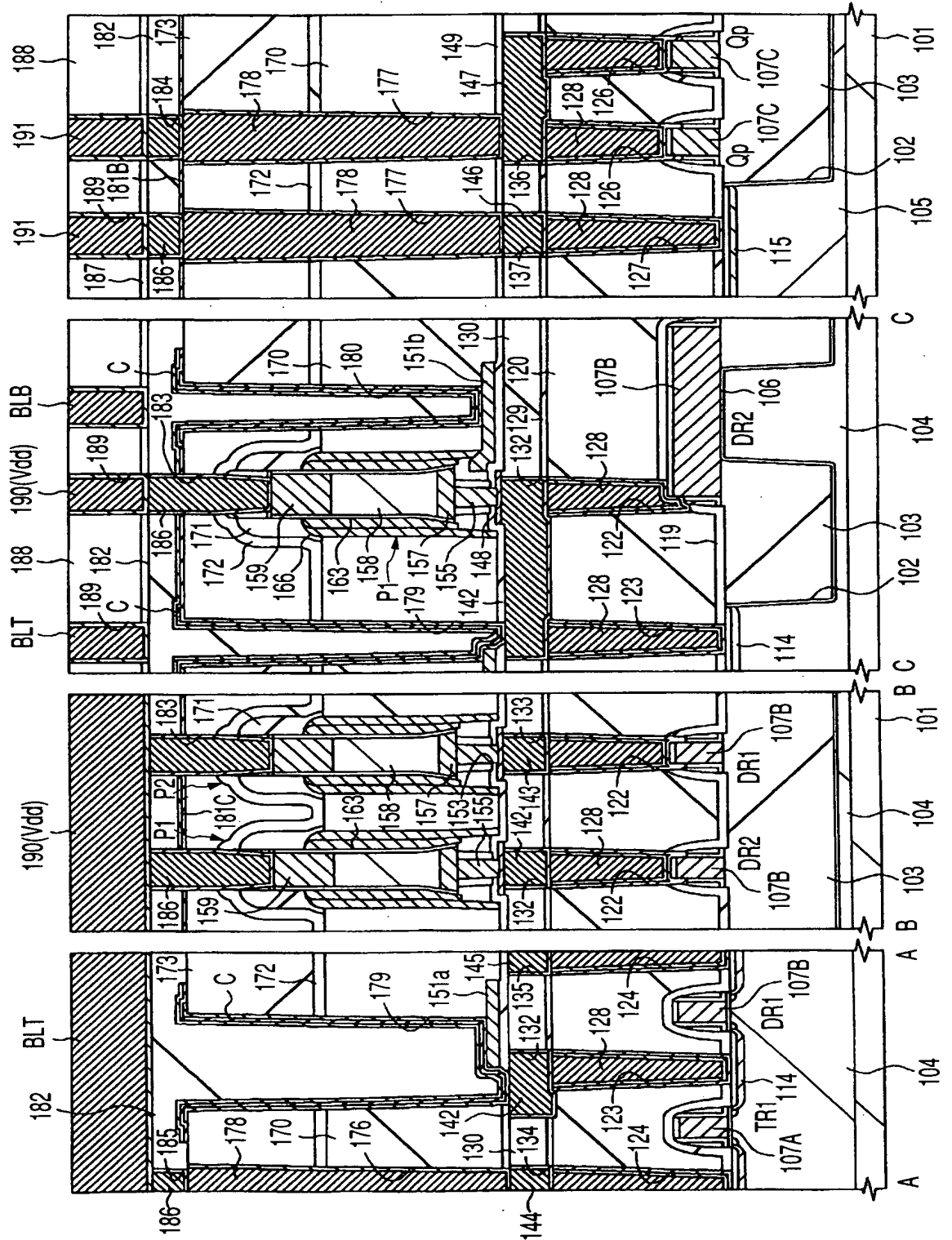


FIG. 94

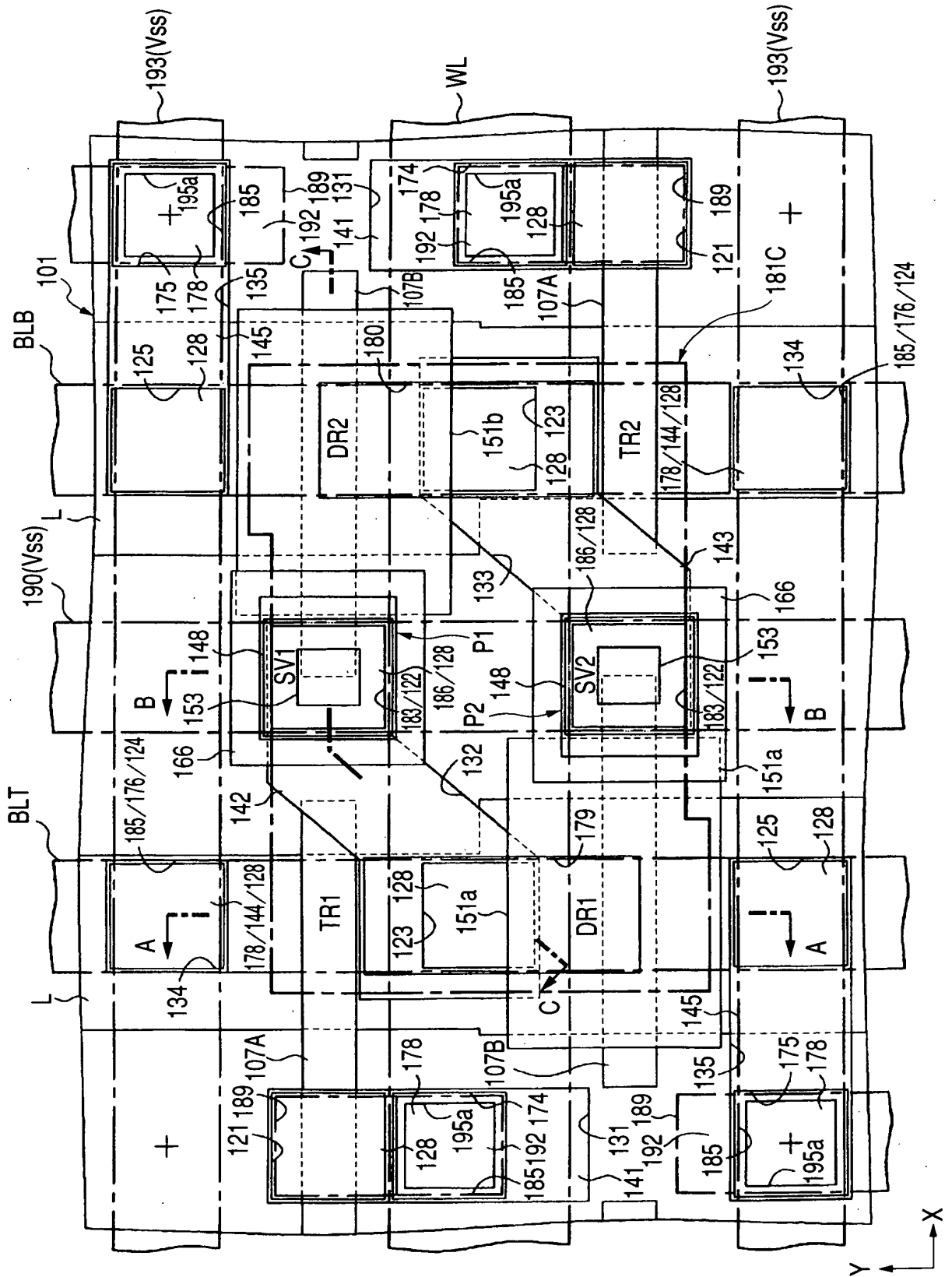


FIG. 95

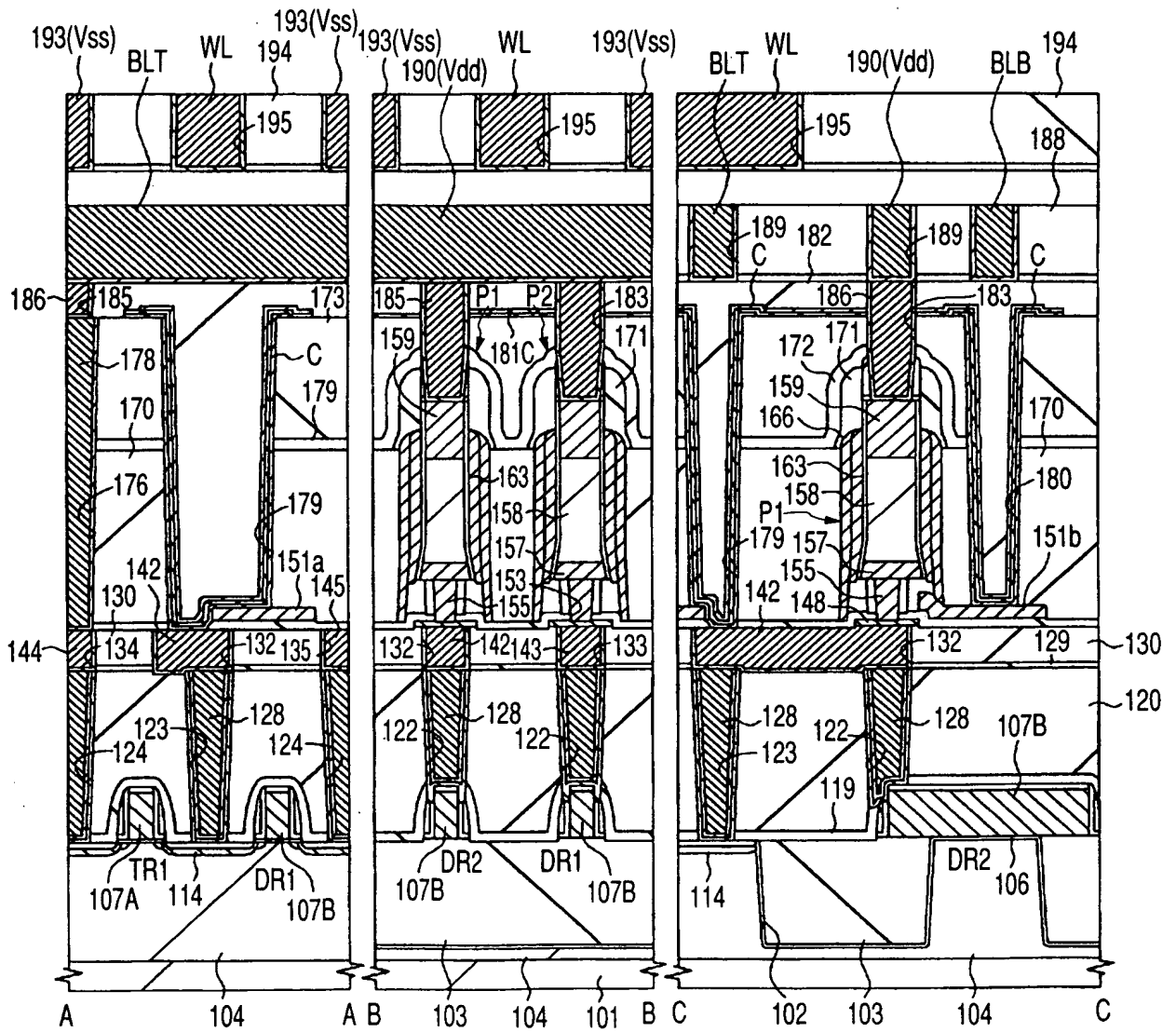
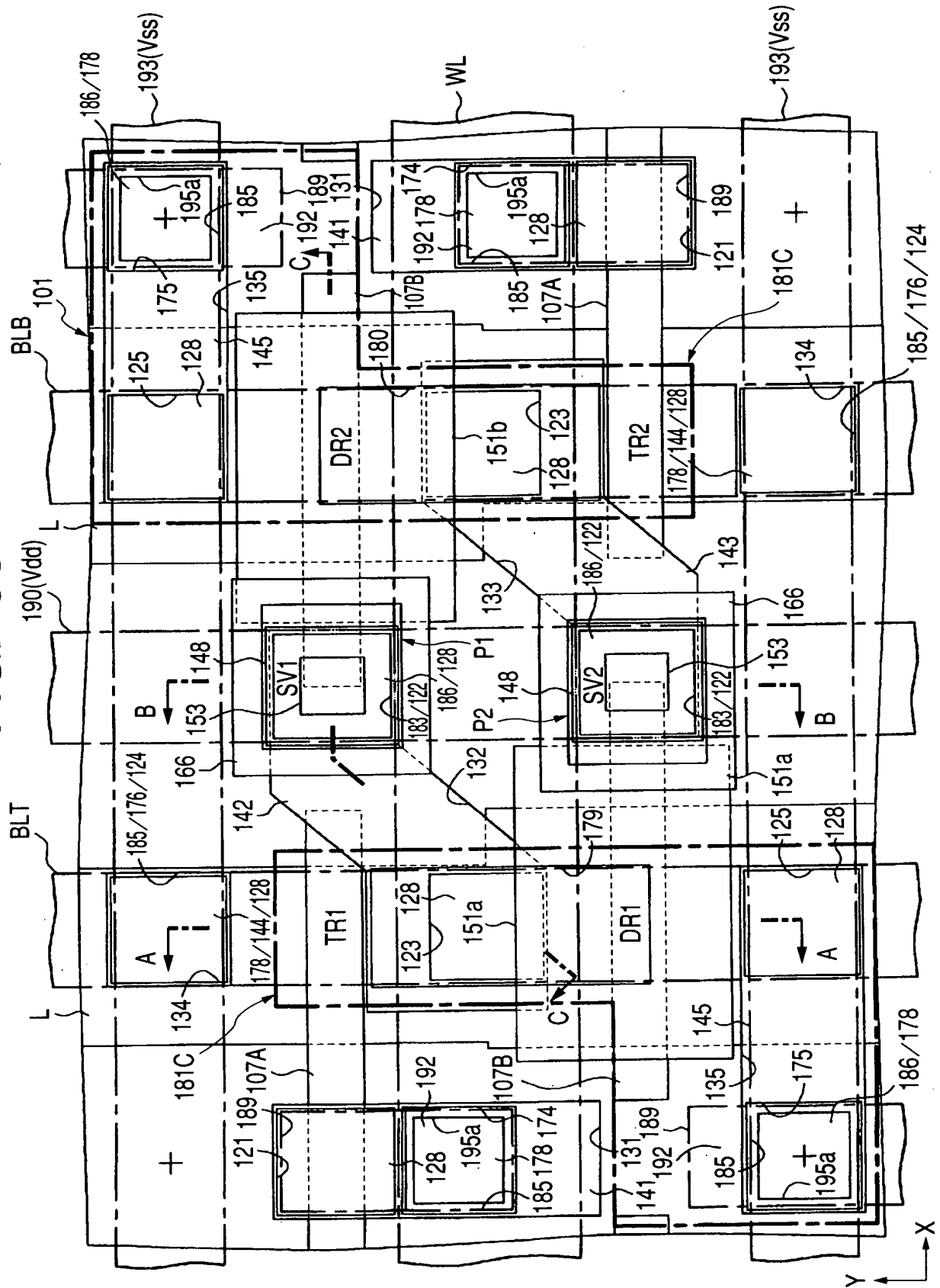


FIG. 96



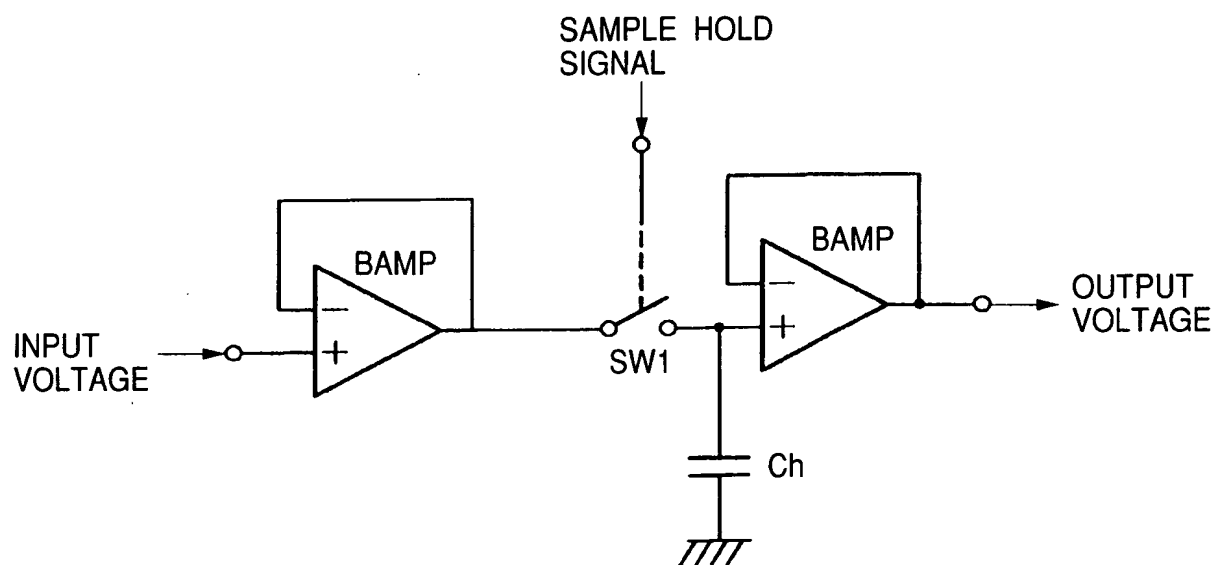
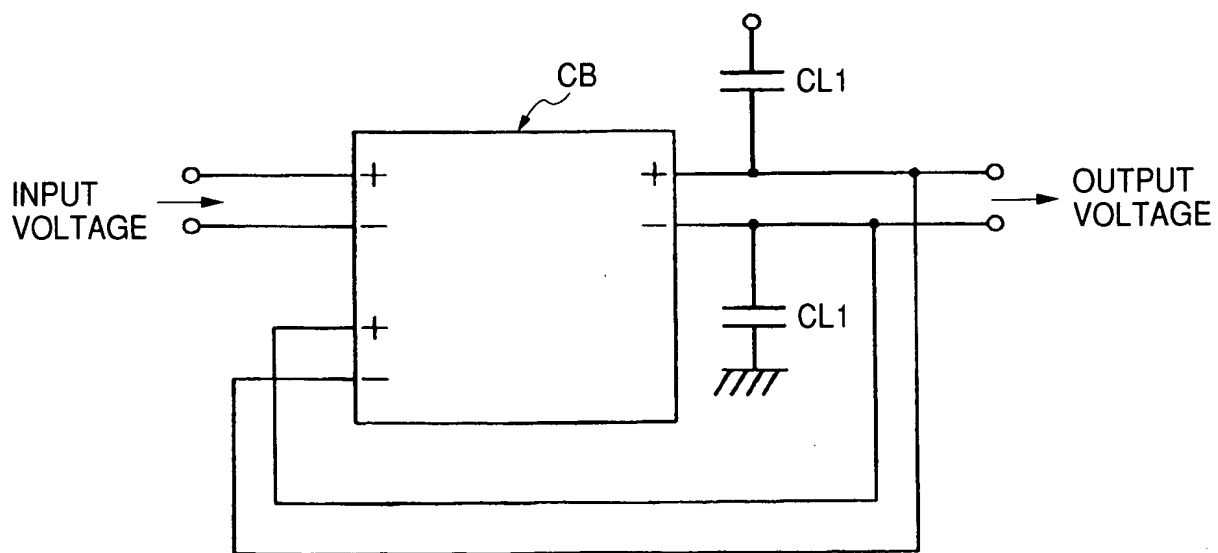
**FIG. 97****FIG. 98**

FIG. 99

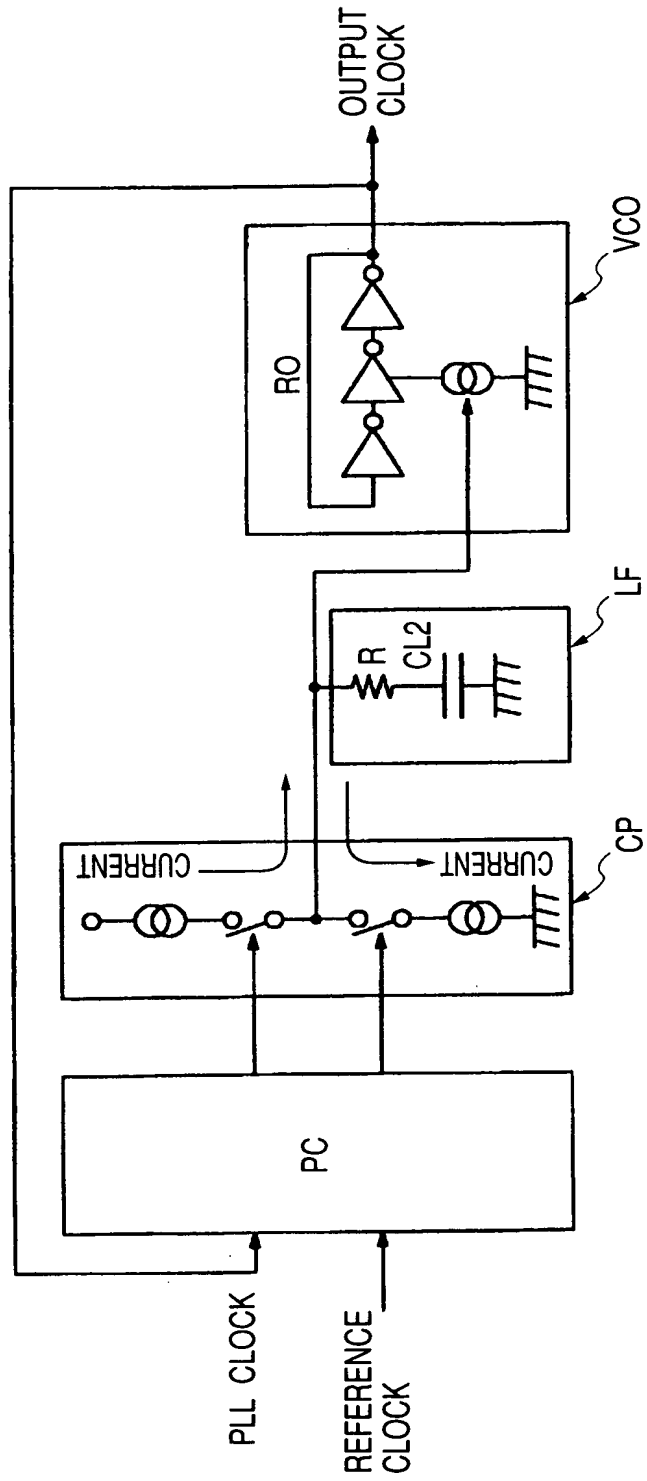


FIG. 100

